

## Summary

The Xilinx® Versal® AI Core series devices are available in -3 (highest performance), -2, -1 speed grades. The -3 devices can operate at a  $V_{CCINT}$  voltage of 0.88V (H), the -2 devices can operate at a  $V_{CCINT}$  voltage of 0.88V (H), 0.80V (M), or 0.70V (L), and the -1 devices can operate at a  $V_{CCINT}$  voltage of 0.80V (M) or 0.70V (L). Primary supply operating voltages typically scale with  $V_{CCINT}$ , except for supported overdrive of the  $V_{CC\_PMC}$ ,  $V_{CC\_PSFP}$ ,  $V_{CC\_PSLP}$ , and  $V_{CC\_CPM5}$  at 0.88V (H) when  $V_{CCINT}$  and other primary supplies operate at 0.70V (L). Similar to speed grades, a higher operating voltage typically has higher performance specifications. All devices are screened for standard (S) or low (L) maximum static power. See *Versal Architecture and Product Data Sheet: Overview* (DS950) for available device ordering options.

DC and AC characteristics are specified in extended (E) and industrial (I) temperature ranges. Except the operating temperature range or unless otherwise noted, all the DC and AC electrical parameters are the same for a particular speed grade and operating voltage (that is, the timing characteristics of a -1 speed grade extended (E) temperature range device operating at a  $V_{CCINT}$  voltage of 0.80V (M) are the same as for a -1 speed grade industrial (I) temperature range device operating at a  $V_{CCINT}$  voltage of 0.80V (M)). However, only selected speed grades, operating voltages, maximum static power screens, and/or devices are available in each temperature range.

All supply voltage and junction temperature specifications are representative of worst-case conditions. The parameters included are common to popular designs and typical applications.

This data sheet, part of an overall set of documentation on the Versal ACAPs, is available on the Xilinx website at <https://www.xilinx.com/versal>.

## DC Characteristics

### Absolute Maximum Ratings

Table 1: Absolute Maximum Ratings—Power, Voltages, and Current

| Symbol                         | Description <sup>1</sup>  | Min    | Max   | Units |
|--------------------------------|---|--------|-------|-------|
| $V_{CCAUX}$                    | Programmable logic auxiliary power supply                           | -0.500 | 1.650 | V     |
| $V_{CCAUX\_PMC}$               | Platform management controller (PMC) auxiliary power supply voltage | -0.500 | 1.650 | V     |
| $V_{CCAUX\_SMON}$ <sup>2</sup> | PMC system monitor power supply relative to GND_SMON                | -0.500 | 1.650 | V     |

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Table 1: Absolute Maximum Ratings—Power, Voltages, and Current (cont'd)

| Symbol                            | Description <sup>1</sup>  | Min       | Max                      | Units |   |
|-----------------------------------|---|-----------|--------------------------|-------|---|
| V <sub>CC_BATT</sub>              | Battery power supply  | -0.500    | 1.650                    | V     |   |
| V <sub>CC_FUSE</sub>              | eFUSE programming power supply  | -0.500    | 2.000                    | V     |   |
| V <sub>CC_INT</sub>               | Programmable logic primary power supply   | -0.500    | 0.970                    | V     |   |
| V <sub>CC_CPM5</sub>              | CPM5 primary power supply   | -0.500    | 0.970                    | V     |   |
| V <sub>CC_IO</sub> <sup>3</sup>   | XPIO power supply   | -0.500    | 0.970                    | V     |   |
| V <sub>CCO</sub> <sup>4</sup>     | XPIO bank 7## output driver power supply<br>Where the bank number is the three-digit bank number beginning with 7                   | -0.500    | 1.650                    | V     |   |
|                                   | HDIO bank 3## and bank 4## output driver power supply<br>Where the bank number is the three-digit bank number beginning with 3 or 4 | -0.500    | 3.63                     | V     |   |
|                                   | PSIO bank 5## power supplies<br>Where the bank number is the three-digit bank number beginning with 5                               | -0.500    | 3.63                     | V     |   |
| V <sub>CC_PMC</sub>               | PMC primary power supply  | -0.500    | 0.970                    | V     |   |
| V <sub>CC_PSFP</sub>              | PS full-power domain power supply   | -0.500    | 0.970                    | V     |   |
| V <sub>CC_PSLP</sub>              | PS low-power domain power supply  | -0.500    | 0.970                    | V     |   |
| V <sub>CC_RAM</sub>               | PL RAM and clocking network power supply  | -0.500    | 0.970                    | V     |   |
| V <sub>CC_SOC</sub> <sup>3</sup>  | Network on Chip (NoC) and DDR memory controller power supply  | -0.500    | 0.970                    | V     |   |
| V <sub>IN</sub> <sup>4,5</sup>    | I/O input voltage for PSIO, HDIO, and XPIO banks  | -0.550    | V <sub>CCO</sub> + 0.550 | V     |   |
| V <sub>REF</sub>                  | PMC system monitor reference input (V <sub>REFP</sub> /V <sub>REFN</sub> ) relative to GND_SMON                                     | -0.500    | 1.120                    | V     |   |
| V <sub>CC_VDU</sub>               | Internal supply voltage for the video decoder unit  | -0.500    | 0.970                    | V     |   |
| <b>GTYP and GTYP Transceivers</b> |   |           |                          |       |   |
| V <sub>GTYP_AVCC</sub>            | GTYP and GTYP transceiver primary analog power supply <sup>6</sup>  | -0.500    | 0.97                     | V     |   |
| V <sub>GTYP_AVCCAU</sub>          | GTYP and GTYP transceiver auxiliary analog (PLL) power supply <sup>6</sup>  | -0.500    | 1.650                    | V     |   |
| V <sub>GTYP_AVTT</sub>            | GTYP and GTYP transceiver termination power supply <sup>6</sup>   | -0.500    | 1.320                    | V     |   |
| V <sub>GTYP_AVTTTRCAL</sub>       | GTYP and GTYP transceiver analog resistor calibration power supply <sup>6</sup>   | -0.500    | 1.320                    | V     |   |
| V <sub>GTYP_REFCLK_DC</sub>       | Transceiver reference clock absolute input DC voltage   | -0.500    | 1.000                    | V     |   |
| V <sub>GTYP_REFCLK_AC</sub>       | Transceiver reference clock absolute input AC voltage <sup>7</sup>  | -0.500    | 1.200                    | V     |   |
| V <sub>IN_DC</sub>                | Receiver (RXP/RXN) and transmitter (TXP/TXN) absolute DC voltage  | Unpowered | -0.800                   | 0.800 | V |
|                                   |   | Powered   | -0.300                   | 1.000 | V |
| V <sub>IN_AC+DC</sub>             | Receiver (RXP/RXN) and transmitter (TXP/TXN) absolute AC plus DC voltage  | Unpowered | -0.800                   | 0.800 | V |
|                                   |   | Powered   | -0.500                   | 1.250 | V |
| I <sub>DCIN_FLOAT</sub>           | DC input current for receiver input pins DC coupled RX termination = floating <sup>8</sup>  | -         | 10                       | mA    |   |
| I <sub>DCIN_GTYP_AVTT</sub>       | DC input current for GTYP and GTYP receiver input pins DC coupled RX termination = V <sub>GTYP_AVTT</sub>                           | -         | 16                       | mA    |   |
| I <sub>DCIN_GTYP_GND</sub>        | DC input current for GTYP and GTYP receiver input pins DC coupled RX termination = GND  | -         | 16                       | mA    |   |
| I <sub>DCIN_PROG</sub>            | DC input current for receiver input pins DC coupled RX termination = programmable <sup>9</sup>                                      | -         | 0                        | mA    |   |
| I <sub>DCOUT_FLOAT</sub>          | DC output current for transmitter pins DC coupled RX termination = floating   | -         | 6                        | mA    |   |
| I <sub>DCOUT_GTYP_AVTT</sub>      | DC output current for transmitter pins DC coupled RX termination = V <sub>GTYP_AVTT</sub>   | -         | 6                        | mA    |   |
| <b>Other Ratings</b>              |   |           |                          |       |   |
| I <sub>DC</sub>                   | Available output current at the pad   | -20       | 20                       | mA    |   |

**Table 1: Absolute Maximum Ratings—Power, Voltages, and Current (cont'd)**

| Symbol           | Description <sup>1</sup>                | Min | Max | Units |
|------------------|---|-----|-----|-------|
| I <sub>RMS</sub> | Available RMS output current at the pad | -20 | 20  | mA    |

**Notes:**

- Stresses beyond those listed under Absolute Maximum Ratings might cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time might affect device reliability.
- V<sub>CCAUX\_SMON</sub> must be connected to V<sub>CCAUX\_PMC</sub>. See *Versal ACAP System Monitor Architecture Manual (AM006)* for V<sub>CCAUX\_SMON</sub> information and filter considerations.
- V<sub>CC\_IO</sub> must be connected to V<sub>CC\_SOC</sub>.
- When operating outside of the recommended operating conditions, refer to [Table 6](#) and [Table 7](#) for maximum overshoot and undershoot specifications.
- The lower absolute voltage specification always applies.
- For more information on supported GTY and GTYP transceiver terminations see the *Versal ACAP GTY and GTYP Transceivers Architecture Manual (AM002)*.
- GTY\_REFCLK AC signal operates in the reference clock frequency range. See [GTY and GTYP Transceiver Reference Clock Switching Characteristics](#).
- AC coupled operation is not supported for RX termination = floating.
- DC coupled operation is not supported for RX termination = programmable.

**Table 2: Absolute Maximum Ratings—Temperature**

| Symbol                        | Description <sup>1</sup>                 | Min | Max | Units |
|-------------------------------|--|-----|-----|-------|
| T <sub>STG</sub>              | Storage temperature (ambient, unpowered) | -55 | 125 | °C    |
| T <sub>SOL</sub> <sup>2</sup> | Maximum dry rework soldering temperature | -   | 260 | °C    |
| T <sub>j</sub>                | Maximum junction temperature             | -   | 125 | °C    |

**Notes:**

- Stresses beyond those listed under Absolute Maximum Ratings might cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time might affect device reliability.
- For soldering guidelines and thermal considerations, see the *Versal ACAP Packaging and Pinouts Architecture Manual (AM013)*.

## Recommended Operating Conditions

**Table 3: Recommended Operating Conditions**

| Symbol                               | Description <sup>1, 2, 3</sup>  | Min   | Typ   | Max   | Units |
|--------------------------------------|---|-------|-------|-------|-------|
| V <sub>CCAUX</sub>                   | Auxiliary power supply  | 1.455 | 1.500 | 1.545 | V     |
| V <sub>CCAUX_PMC</sub>               | PMC auxiliary power supply voltage  | 1.455 | 1.500 | 1.545 | V     |
| V <sub>CCAUX_SMON</sub> <sup>4</sup> | PMC system monitor power supply relative to GND_SMON                                    | 1.455 | 1.500 | 1.545 | V     |
| V <sub>CC_BATT</sub> <sup>5</sup>    | Battery power supply to the battery-backed RAM and battery-backed real-time clock (RTC) | 1.200 | -     | 1.500 | V     |
| V <sub>CC_FUSE</sub> <sup>6</sup>    | eFUSE programming power supply  | 1.745 | 1.800 | 1.854 | V     |
| V <sub>CCINT</sub>                   | PL primary power supply, low (L) voltage  | 0.676 | 0.700 | 0.724 | V     |
|                                      | PL primary power supply, mid (M) voltage  | 0.775 | 0.800 | 0.825 | V     |
|                                      | PL primary power supply, high (H) voltage   | 0.854 | 0.880 | 0.906 | V     |

Table 3: Recommended Operating Conditions (cont'd)

| Symbol                                 | Description <sup>1, 2, 3</sup>  | Min    | Typ   | Max                      | Units |
|--|---|--------|-------|--------------------------|-------|
| V <sub>CC_CPM5</sub>                   | CPM5 primary power supply, low (L) voltage  | 0.676  | 0.700 | 0.724                    | V     |
|  | CPM5 primary power supply, mid (M) voltage  | 0.775  | 0.800 | 0.825                    | V     |
|  | CPM5 primary power supply, high (H) voltage   | 0.854  | 0.880 | 0.906                    | V     |
|  | CPM5 primary power supply, overdrive voltage for higher CPM5 performance in -1LSI, -1LLI, -2LSE, 2LLE, -2MSE, -2MLE, -2MSI, and -2MLI devices | 0.854  | 0.880 | 0.906                    | V     |
| V <sub>CC_IO</sub> <sup>7</sup>        | XPIO power supply, low (L) and mid (M) voltage  | 0.775  | 0.800 | 0.825                    | V     |
|  | XPIO power supply, high (H) voltage   | 0.854  | 0.880 | 0.906                    | V     |
| V <sub>CCO</sub> <sup>8</sup>          | XPIO bank 7## output driver power supply<br>Includes V <sub>CCO</sub> of 1.0V, 1.1V, 1.2V, 1.35V, 1.5V at ±5%                                 | 0.950  | -     | 1.575                    | V     |
|  | HDIO bank 3## and bank 4## output driver power supply<br>Includes V <sub>CCO</sub> of 1.8V, 2.5V at ±5%, and 3.3V at +3/-5%                   | 1.710  | -     | 3.400                    | V     |
|  | PSIO bank 5## power supplies<br>Includes V <sub>CCO</sub> of 1.8V, 2.5V at ±5%, and 3.3V at +3/-5%  | 1.710  | -     | 3.400                    | V     |
| V <sub>CC_PMC</sub> <sup>9</sup>       | PMC primary power supply, low (L) voltage   | 0.676  | 0.700 | 0.724                    | V     |
|  | PMC primary power supply, mid (M) voltage   | 0.775  | 0.800 | 0.825                    | V     |
|  | PMC primary power supply, high (H) voltage  | 0.854  | 0.880 | 0.906                    | V     |
|  | PMC primary power supply, overdrive voltage for higher PMC performance in -1LSI and -1LLI devices   | 0.854  | 0.880 | 0.906                    | V     |
| V <sub>CC_PSPF</sub>                   | PS full-power domain power supply, low (L) voltage  | 0.676  | 0.700 | 0.724                    | V     |
|  | PS full-power domain power supply, mid (M) voltage  | 0.775  | 0.800 | 0.825                    | V     |
|  | PS full-power domain power supply, high (H) voltage   | 0.854  | 0.880 | 0.906                    | V     |
|  | PS full-power domain power supply, overdrive voltage for higher PS performance in -1LSI and -1LLI devices                                     | 0.854  | 0.880 | 0.906                    | V     |
| V <sub>CC_PSLP</sub>                   | PS low-power domain power supply, low (L) voltage   | 0.676  | 0.700 | 0.724                    | V     |
|  | PS low-power domain power supply, mid (M) voltage   | 0.775  | 0.800 | 0.825                    | V     |
|  | PS low-power domain power supply, high (H) voltage  | 0.854  | 0.880 | 0.906                    | V     |
|  | PS low-power domain power supply, overdrive voltage for higher PS performance in -1LSI and -1LLI devices                                      | 0.854  | 0.880 | 0.906                    | V     |
| V <sub>CC_RAM</sub>                    | PL RAM and clocking network power supply, low (L) and mid (M) voltage   | 0.775  | 0.800 | 0.825                    | V     |
|  | PL RAM and clocking network power supply, high (H) voltage  | 0.854  | 0.880 | 0.906                    | V     |
| V <sub>CC_SOC</sub> <sup>7</sup>       | Network on Chip (NoC) and DDR memory controller power supply, low (L) and mid (M) voltage   | 0.775  | 0.800 | 0.825                    | V     |
|  | NoC and DDR memory controller power supply, high (H) voltage  | 0.854  | 0.880 | 0.906                    | V     |
| V <sub>GTY_AVCC</sub> <sup>10</sup>    | GTY transceiver primary analog power supply   | 0.854  | 0.880 | 0.906                    | V     |
| V <sub>GTY_AVCC</sub> <sup>10</sup>    | GTYP transceiver primary analog power supply  | 0.892  | 0.920 | 0.948                    | V     |
| V <sub>GTY_AVCCAUX</sub> <sup>10</sup> | GTY and GTYP transceiver auxiliary analog (PLL) power supply  | 1.455  | 1.500 | 1.545                    | V     |
| V <sub>GTY_AVTT</sub> <sup>10</sup>    | GTY and GTYP transceiver termination power supply   | 1.164  | 1.200 | 1.236                    | V     |
| V <sub>GTY_AVTRCAL</sub> <sup>10</sup> | GTY and GTYP transceiver analog resistor calibration power supply   | 1.164  | 1.200 | 1.236                    | V     |
| V <sub>IN</sub> <sup>11,12</sup>       | I/O input voltage for PSIO, HDIO, and XPIO banks  | -0.200 | -     | V <sub>CCO</sub> + 0.200 | V     |
| I <sub>IN</sub> <sup>13</sup>          | Maximum current through any PL, PMC, or PS pin in a powered or unpowered bank when forward biasing the clamp diode                            | -      | -     | 10                       | mA    |

Table 3: Recommended Operating Conditions (cont'd)

| Symbol                       | Description <sup>1, 2, 3</sup>  | Min | Typ | Max | Units |
|------------------------------|---|-----|-----|-----|-------|
| T <sub>j</sub> <sup>14</sup> | Junction temperature operating range for extended (E) temperature devices <sup>15</sup>   | 0   | –   | 100 | °C    |
|                              | Junction temperature operating range for industrial (I) temperature devices <sup>15</sup> | –40 | –   | 100 | °C    |
|                              | Junction temperature operating range for eFUSE programming                                | –40 | –   | 125 | °C    |

**Notes:**

- All voltages are relative to GND and in relation to the BGA package ball.
- For the design of the power distribution system consult the *Versal ACAP PCB Design User Guide (UG863)* and Xilinx Power Estimator (XPE) spreadsheet tool (download at [www.xilinx.com/power](http://www.xilinx.com/power)).
- Each voltage listed requires decoupling as described in the *Versal ACAP PCB Design User Guide (UG863)*. Refer to the Xilinx Power Estimator (XPE) spreadsheet tool (download at [www.xilinx.com/power](http://www.xilinx.com/power)) for design specific decoupling recommendations.
- V<sub>CCAUX\_SMON</sub> must be connected to V<sub>CCAUX\_PMC</sub>. See *Versal ACAP System Monitor Architecture Manual (AM006)* for V<sub>CCAUX\_SMON</sub> information and filter considerations.
- When the battery-backed RAM and the real-time clock are not used, connect to GND.
- V<sub>CC\_FUSE</sub> must be within the recommended operating conditions during eFUSE programming. When V<sub>CC\_FUSE</sub> is not used, connect to GND.
- V<sub>CC\_IO</sub> must be connected to V<sub>CC\_SOC</sub>.
- For XPIO and HDIO operation, see the *Versal ACAP SelectIO Resources Architecture Manual (AM010)*. For PSIO operation, see the *Versal ACAP Technical Reference Manual (AM011)*.
- The physical unclonable function (PUF) is only supported when using a nominal V<sub>CC\_PMC</sub> of 0.70V. Refer to the *Versal ACAP Security Manual (UG1508)* in the [Design Security Lounge](#) for detailed information on PUF usage.
- Each voltage listed requires filtering as described in the *Versal ACAP GTY and GTYP Transceivers Architecture Manual (AM002)*. The noise beyond the recommended operating conditions at the power pins must not exceed 10 mVpp over the band from 10 kHz to 80 MHz.
- The lower absolute voltage specification always applies.
- In XPIO banks, V<sub>IN</sub> overshoot above V<sub>CC0</sub> and undershoot below GND can reduce the performance of V<sub>REF</sub>-based receivers within the same nibble.
- A total of 200 mA per bank should not be exceeded.
- Junction temperature specification is in relation to the absolute value reported by SYSMON.
- Devices labeled with the -2E speed/temperature grade and all industrial (I) temperature grade devices can operate for a limited time at a junction temperature between 100°C and 110°C based on the temperature read from the SYSMON. Timing parameters adhere to the same speed file at up to 110°C as they do at up to 100°C. Operation up to T<sub>j</sub> = 110°C is limited to 3% of the device lifetime and can occur sequentially or at regular intervals as long as the total time does not exceed 3% of the device lifetime. For more information on excursion temperature see *Extending the Thermal Solution by Utilizing Excursion Temperatures (WP517)*.

## Available Speed Grades and Operating Voltages

The following table describes the speed grades per device and operating supply voltages for the PMC, PS low power, PS full power, and PL domains. For more information on selecting devices and speed grades, see the *Versal Architecture and Product Data Sheet: Overview (DS950)*.

Table 4: Available Speed Grades and Operating Voltages

| Speed Grade | Mode <sup>1,2</sup> | Vivado Design Tools Device Code <sup>3</sup> | V <sub>CCINT</sub> | V <sub>CC_PSLP</sub> | V <sub>CC_PSPF</sub> | V <sub>CC_CPM5</sub> | V <sub>CC_PMC</sub> <sup>4</sup> | V <sub>CC_SOC</sub> and V <sub>CC_IO</sub> | V <sub>CC_RAM</sub> | Units |
|-------------|---------------------|--|--------------------|----------------------|----------------------|----------------------|----------------------------------|--|---------------------|-------|
| -3HSE       | Standard            | -3HP-e-S                                     | 0.88               | 0.88                 | 0.88                 | 0.88                 | 0.88                             | 0.88                                       | 0.88                | V     |
| -2HSI       | Standard            | -2HP-i-S                                     | 0.88               | 0.88                 | 0.88                 | 0.88                 | 0.88                             | 0.88                                       | 0.88                | V     |
| -2MSE       | Standard            | -2MP-e-S                                     | 0.80               | 0.80                 | 0.80                 | 0.80                 | 0.80                             | 0.80                                       | 0.80                | V     |
|             | Overdrive           | -2MHP-e-S                                    | 0.80               | 0.88                 | 0.88                 | 0.88                 | 0.88                             | 0.80                                       | 0.80                | V     |
| -2MSI       | Standard            | -2MP-i-S                                     | 0.80               | 0.80                 | 0.80                 | 0.80                 | 0.80                             | 0.80                                       | 0.80                | V     |
|             | Overdrive           | -2MHP-i-S                                    | 0.80               | 0.88                 | 0.88                 | 0.88                 | 0.88                             | 0.80                                       | 0.80                | V     |
| -2MLE       | Standard            | -2MP-e-L                                     | 0.80               | 0.80                 | 0.80                 | 0.80                 | 0.80                             | 0.80                                       | 0.80                | V     |
|             | Overdrive           | -2MHP-e-L                                    | 0.80               | 0.88                 | 0.88                 | 0.88                 | 0.88                             | 0.80                                       | 0.80                | V     |
| -2MLI       | Standard            | -2MP-i-L                                     | 0.80               | 0.80                 | 0.80                 | 0.80                 | 0.80                             | 0.80                                       | 0.80                | V     |
|             | Overdrive           | -2MHP-i-L                                    | 0.80               | 0.88                 | 0.88                 | 0.88                 | 0.88                             | 0.80                                       | 0.80                | V     |
| -2LSE       | Standard            | -2LP-e-S                                     | 0.70               | 0.70                 | 0.70                 | 0.70                 | 0.70                             | 0.80                                       | 0.80                | V     |
|             | Overdrive           | -2LHP-e-S                                    | 0.70               | 0.88                 | 0.88                 | 0.88                 | 0.88                             | 0.80                                       | 0.80                | V     |
| -2LLE       | Standard            | -2LP-e-L                                     | 0.70               | 0.70                 | 0.70                 | 0.70                 | 0.70                             | 0.80                                       | 0.80                | V     |
|             | Overdrive           | -2LHP-e-L                                    | 0.70               | 0.88                 | 0.88                 | 0.88                 | 0.88                             | 0.80                                       | 0.80                | V     |
| -2LLI       | Standard            | -2LP-i-L                                     | 0.70               | 0.70                 | 0.70                 | 0.70                 | 0.70                             | 0.80                                       | 0.80                | V     |
| -1MSM       | Standard            | -1MM-m-S                                     | 0.80               | 0.80                 | 0.80                 | 0.80                 | 0.80                             | 0.80                                       | 0.80                | V     |
| -1MSB       | Standard            | -1MM-b-S                                     | 0.80               | 0.80                 | 0.80                 | 0.80                 | 0.80                             | 0.80                                       | 0.80                | V     |
| -1MSI       | Standard            | -1MP-i-S                                     | 0.80               | 0.80                 | 0.80                 | 0.80                 | 0.80                             | 0.80                                       | 0.80                | V     |
| -1MLI       | Standard            | -1MP-i-L                                     | 0.80               | 0.80                 | 0.80                 | 0.80                 | 0.80                             | 0.80                                       | 0.80                | V     |
| -1MSE       | Standard            | -1MP-e-S                                     | 0.80               | 0.80                 | 0.80                 | 0.80                 | 0.80                             | 0.80                                       | 0.80                | V     |
| -1LSI       | Standard            | -1LP-i-S                                     | 0.70               | 0.70                 | 0.70                 | 0.70                 | 0.70                             | 0.80                                       | 0.80                | V     |
|             | Overdrive           | -1LHP-i-S                                    | 0.70               | 0.88                 | 0.88                 | 0.88                 | 0.88                             | 0.80                                       | 0.80                | V     |
| -1LLI       | Standard            | -1LP-i-L                                     | 0.70               | 0.70                 | 0.70                 | 0.70                 | 0.70                             | 0.80                                       | 0.80                | V     |
|             | Overdrive           | -1LHP-i-L                                    | 0.70               | 0.88                 | 0.88                 | 0.88                 | 0.88                             | 0.80                                       | 0.80                | V     |

*Table 4: Available Speed Grades and Operating Voltages (cont'd)*

| Speed Grade | Mode <sup>1, 2</sup> | Vivado Design Tools Device Code <sup>3</sup> | V <sub>CCINT</sub> | V <sub>CC_PSLP</sub> | V <sub>CC_PSF</sub> | V <sub>CC_CPM5</sub> | V <sub>CC_PMC</sub> <sup>4</sup> | V <sub>CC_SOC</sub> and V <sub>CC_IO</sub> | V <sub>CC_RAM</sub> | Units |
|-------------|----------------------|--|--------------------|----------------------|---------------------|----------------------|----------------------------------|--|---------------------|-------|
| -1LSE       | Standard             | -1LP-e-S                                     | 0.70               | 0.70                 | 0.70                | 0.70                 | 0.70                             | 0.80                                       | 0.80                | V     |

**Notes:**

1. The -2LLE, -2LSE, -2MLE, -2MSE, -2MLI, and -2MSI devices allow dual-voltage operation of the PMC, PS, and CPM5 supplies in overdrive mode (0.88V) or standard drive mode (0.70V/0.80V).
2. -1LSI and -1LLI devices allow dual-voltage operation of the PMC and PS supplies in overdrive mode (0.88V) or standard drive mode (0.70V).
3. The specified portion of the Vivado design tools device selection code includes speed grade (-3, -2, -1), operating voltages (HP, MP, LP, LHP), temperature grade, (-i, -e, -m), and maximum static power screen (-S, -L).
4. The physical unclonable function (PUF) is only supported when using a nominal V<sub>CC\_PMC</sub> of 0.70V. Refer to the *Versal ACAP Security Manual* (UG1508) in the [Design Security Lounge](#) for detailed information on PUF usage.

## DC Characteristics Over Recommended Operating Conditions

Table 5: DC Characteristics Over Recommended Operating Conditions

| Symbol   | Description  | Min               | Typ <sup>1</sup> | Max               | Units |
|--|--|-------------------|------------------|-------------------|-------|
| C <sub>IN</sub> <sup>2</sup>   | HDIO and PSIO die input capacitance at the pad   | -                 | -                | 3.50              | pF    |
|  | XPIO die input capacitance at the pad  | -                 | -                | 1.75              | pF    |
| I <sub>RPD</sub>   | Pad pull-up (when selected) at V <sub>IN</sub> = 0V, V <sub>CCO</sub> = 3.3V                                       | 60                | -                | 200               | μA    |
|  | Pad pull-up (when selected) at V <sub>IN</sub> = 0V, V <sub>CCO</sub> = 2.5V                                       | 50                | -                | 169               | μA    |
|  | Pad pull-up (when selected) at V <sub>IN</sub> = 0V, V <sub>CCO</sub> = 1.8V                                       | 29                | -                | 120               | μA    |
|  | Pad pull-up (when selected) at V <sub>IN</sub> = 0V, V <sub>CCO</sub> = 1.5V                                       | 30                | -                | 120               | μA    |
|  | Pad pull-up (when selected) at V <sub>IN</sub> = 0V, V <sub>CCO</sub> = 1.2V                                       | 10                | -                | 100               | μA    |
| I <sub>RPD</sub>   | Pad pull-down (when selected) at V <sub>IN</sub> = 3.3V  | 60                | -                | 200               | μA    |
|  | Pad pull-down (when selected) at V <sub>IN</sub> = 1.8V  | 29                | -                | 120               | μA    |
| I <sub>CC_BATT</sub> <sup>3,4</sup>  | Battery supply current at V <sub>CC_BATT</sub> = 1.50V, RTC enabled  | -                 | -                | 3500              | nA    |
|  | Battery supply current at V <sub>CC_BATT</sub> = 1.50V, RTC disabled   | -                 | -                | 300               | nA    |
|  | Battery supply current at V <sub>CC_BATT</sub> = 1.20V, RTC disabled   | -                 | -                | 150               | nA    |
| I <sub>CC_FUSE</sub>   | V <sub>CC_FUSE</sub> supply current during eFUSE programming   | -                 | -                | 165               | mA    |
| <b>Calibrated programmable on-die termination (DCI) in XPIO banks<sup>5</sup> (measured per JEDEC specification)</b> |  |                   |                  |                   |       |
| R <sup>7</sup>   | Thevenin equivalent resistance of programmable input termination where x = target impedance of 48, 60, 120, or 240 | -20% <sup>6</sup> | ODT = RTT_x      | +20% <sup>6</sup> | Ω     |
| <b>Uncalibrated programmable on-die termination in HDIO banks (measured per JEDEC specification)</b>                 |  |                   |                  |                   |       |
| R <sup>7</sup>   | Thevenin equivalent resistance of programmable input termination to V <sub>CCO</sub> /2 where ODT = RTT_48         | -50%              | 48               | +50%              | Ω     |
| Differential termination   | Programmable differential termination (TERM_100) for XPIO banks  | -35%              | 100              | +35%              | Ω     |

**Notes:**

- Typical values are specified at nominal voltage, 25°C.
- This measurement represents the die capacitance at the pad, not including the package.
- Maximum value specified for worst case process at 25°C.
- Battery-backed RAM (BBRAM) is always enabled and included in I<sub>CC\_BATT</sub>.
- VR resistor tolerance is (240Ω ±1%).
- The tolerance limits are specified after calibration with stable voltage and temperature.
- On-die input termination resistance, for more information see the *Versal ACAP SelectIO Resources Architecture Manual (AM010)*.



## $V_{IN}$ Maximum Allowed AC Voltage Overshoot and Undershoot

Table 6:  $V_{IN}$  Maximum Allowed AC Voltage Overshoot and Undershoot for HDIO and PSIO Banks

| AC Voltage Overshoot <sup>1</sup> | % of UI <sup>2</sup> at -40°C to 100°C | AC Voltage Undershoot <sup>1</sup> | % of UI <sup>2</sup> at -40°C to 100°C |
|-----------------------------------|--|------------------------------------|--|
| $V_{CCO} + 0.20$                  | 100%                                   | -0.20                              | 100%                                   |
| $V_{CCO} + 0.25$                  | 100%                                   | -0.25                              | 75%                                    |
| $V_{CCO} + 0.30$                  | 75%                                    | -0.30                              | 75%                                    |
| $V_{CCO} + 0.35$                  | 75%                                    | -0.35                              | 75%                                    |
| $V_{CCO} + 0.40$                  | 75%                                    | -0.40                              | 60%                                    |
| $V_{CCO} + 0.45$                  | 50%                                    | -0.45                              | 30%                                    |
| $V_{CCO} + 0.50$                  | 30%                                    | -0.50                              | 0%                                     |
| $V_{CCO} + 0.55$                  | 20%                                    | -0.55                              | 0%                                     |
| $V_{CCO} + 0.60$                  | 20%                                    | -0.60                              | 0%                                     |
| $V_{CCO} + 0.65$                  | 10%                                    | -0.65                              | 0%                                     |
| $V_{CCO} + 0.70$                  | 10%                                    | -0.70                              | 0%                                     |
| $V_{CCO} + 0.75$                  | 10%                                    | -0.75                              | 0%                                     |
| $V_{CCO} + 0.80$                  | 10%                                    | -0.80                              | 0%                                     |
| $V_{CCO} + 0.85$                  | 8%                                     | -0.85                              | 0%                                     |
| $V_{CCO} + 0.90$                  | 6%                                     | -0.90                              | 0%                                     |
| $V_{CCO} + 0.95$                  | 2%                                     | -0.95                              | 0%                                     |

**Notes:**

1. A total of 200 mA per bank should not be exceeded.
2. For UI smaller than 20  $\mu$ s.

Table 7:  $V_{IN}$  Maximum Allowed AC Voltage Overshoot and Undershoot for XPIO Banks

| AC Voltage Overshoot <sup>1</sup> | % of UI <sup>2</sup> at -40°C to 100°C | AC Voltage Undershoot <sup>1</sup> | % of UI <sup>2</sup> at -40°C to 100°C |
|-----------------------------------|--|------------------------------------|--|
| $V_{CCO} + 0.20$                  | 100%                                   | -0.20                              | 100%                                   |
| $V_{CCO} + 0.25$                  | 100%                                   | -0.25                              | 100%                                   |
| $V_{CCO} + 0.30$                  | 100%                                   | -0.30                              | 10%                                    |
| $V_{CCO} + 0.35$                  | 100%                                   | -0.35                              | 0%                                     |
| $V_{CCO} + 0.40$                  | 96%                                    | -0.40                              | 0%                                     |
| $V_{CCO} + 0.45$                  | 2%                                     | -0.45                              | 0%                                     |

**Notes:**

1. A total of 200 mA per bank should not be exceeded.
2. For UI smaller than 20  $\mu$ s.
3. In XPIO banks,  $V_{IN}$  overshoot above  $V_{CCO}$  and undershoot below GND can reduce the performance of  $V_{REF}$ -based receivers within the same nibble.

## DC Input and Output Levels

Values for  $V_{IL}$  and  $V_{IH}$  are recommended input voltages. Values for  $I_{OL}$  and  $I_{OH}$  are guaranteed over the recommended operating conditions at the  $V_{OL}$  and  $V_{OH}$  test points. Only selected standards are tested. These are chosen to ensure that all standards meet their specifications. The selected standards are tested at a minimum  $V_{CCO}$  with the respective  $V_{OL}$  and  $V_{OH}$  voltage levels shown. Other standards are sample tested.

## PSIO Levels

Table 8: PSIO DC Input and Output Levels

| I/O Standard <sup>1, 2</sup> | $V_{IL}$ |               | $V_{IH}$      |                   | $V_{OL}$ | $V_{OH}$          | $I_{OL}$ | $I_{OH}$ |
|------------------------------|----------|---------------|---------------|-------------------|----------|-------------------|----------|----------|
|                              | V, Min   | V, Max        | V, Min        | V, Max            | V, Max   | V, Min            | mA       | mA       |
| LVC MOS18                    | -0.300   | 35% $V_{CCO}$ | 65% $V_{CCO}$ | $V_{CCO} + 0.300$ | 0.450    | $V_{CCO} - 0.450$ | Note 3   | Note 3   |
| LVC MOS25                    | -0.300   | 0.700         | 1.700         | $V_{CCO} + 0.300$ | 0.400    | $V_{CCO} - 0.400$ | Note 3   | Note 3   |
| LVC MOS33                    | -0.300   | 0.800         | 2.000         | 3.400             | 0.400    | $V_{CCO} - 0.400$ | Note 3   | Note 3   |

**Notes:**

1. Tested according to relevant specifications.
2. Standards specified using the default I/O standard configuration. For details, see the *Versal ACAP Technical Reference Manual (AM011)*.
3. Supported drive strengths of 4, 8, or 12 mA.

## SelectIO Levels

Table 9: SelectIO DC Input and Output Levels For HDIO Banks

| I/O Standard <sup>1, 2</sup> | $V_{IL}$ |                       | $V_{IH}$              |                   | $V_{OL}$            | $V_{OH}$            | $I_{OL}$ | $I_{OH}$ |
|------------------------------|----------|-----------------------|-----------------------|-------------------|---------------------|---------------------|----------|----------|
|                              | V, Min   | V, Max                | V, Min                | V, Max            | V, Max              | V, Min              | mA       | mA       |
| HSTL_I_18                    | -0.300   | 50% $V_{CCO} - 0.100$ | 50% $V_{CCO} + 0.100$ | $V_{CCO} + 0.300$ | 0.400               | $V_{CCO} - 0.400$   | 8.0      | -8.0     |
| LVC MOS18                    | -0.300   | 35% $V_{CCO}$         | 65% $V_{CCO}$         | $V_{CCO} + 0.300$ | 0.450               | $V_{CCO} - 0.450$   | Note 3   | Note 3   |
| LVC MOS25                    | -0.300   | 0.700                 | 1.700                 | $V_{CCO} + 0.300$ | 0.400               | $V_{CCO} - 0.400$   | Note 3   | Note 3   |
| LVC MOS33                    | -0.300   | 0.800                 | 2.000                 | 3.400             | 0.400               | $V_{CCO} - 0.400$   | Note 3   | Note 3   |
| LVTTL                        | -0.300   | 0.800                 | 2.000                 | 3.400             | 0.400               | 2.400               | Note 3   | Note 3   |
| SSTL18_I                     | -0.300   | 50% $V_{CCO} - 0.125$ | 50% $V_{CCO} + 0.125$ | $V_{CCO} + 0.300$ | $V_{CCO}/2 - 0.470$ | $V_{CCO}/2 + 0.470$ | 8.0      | -8.0     |

**Notes:**

1. Tested according to relevant specifications.
2. Standards specified using the default I/O standard configuration. For details, see the *Versal ACAP SelectIO Resources Architecture Manual (AM010)*.
3. Supported drive strengths of 4, 8, or 12 mA in HDIO banks.

**Table 10: SelectIO DC Input and Output Levels for XPIO Banks**

| I/O Standard <sup>1, 2, 3</sup> | V <sub>IL</sub> |                              | V <sub>IH</sub>              |                          | V <sub>OL</sub>             | V <sub>OH</sub>             | I <sub>OL</sub> | I <sub>OH</sub> |
|---------------------------------|-----------------|------------------------------|------------------------------|--------------------------|-----------------------------|-----------------------------|-----------------|-----------------|
|                                 | V, Min          | V, Max                       | V, Min                       | V, Max                   | V, Max                      | V, Min                      | mA              | mA              |
| HSTL_I                          | -0.300          | 50% V <sub>CCO</sub> - 0.100 | 50% V <sub>CCO</sub> + 0.100 | V <sub>CCO</sub> + 0.300 | 0.400                       | V <sub>CCO</sub> - 0.400    | 5.8             | -5.8            |
| HSTL_I_12                       | -0.300          | 50% V <sub>CCO</sub> - 0.080 | 50% V <sub>CCO</sub> + 0.080 | V <sub>CCO</sub> + 0.300 | 25% V <sub>CCO</sub>        | 75% V <sub>CCO</sub>        | 4.1             | -4.1            |
| HSUL_12                         | -0.300          | 50% V <sub>CCO</sub> - 0.130 | 50% V <sub>CCO</sub> + 0.130 | V <sub>CCO</sub> + 0.300 | 20% V <sub>CCO</sub>        | 80% V <sub>CCO</sub>        | 0.1             | -0.1            |
| LVC MOS12                       | -0.300          | 35% V <sub>CCO</sub>         | 65% V <sub>CCO</sub>         | V <sub>CCO</sub> + 0.300 | 0.400                       | V <sub>CCO</sub> - 0.400    | Note 4          | Note 4          |
| LVC MOS15                       | -0.300          | 35% V <sub>CCO</sub>         | 65% V <sub>CCO</sub>         | V <sub>CCO</sub> + 0.300 | 0.450                       | V <sub>CCO</sub> - 0.450    | Note 5          | Note 5          |
| LVDCI_15                        | -0.300          | 35% V <sub>CCO</sub>         | 65% V <sub>CCO</sub>         | V <sub>CCO</sub> + 0.300 | 0.450                       | V <sub>CCO</sub> - 0.450    | 7.0             | -7.0            |
| SSTL12                          | -0.300          | 50% V <sub>CCO</sub> - 0.100 | 50% V <sub>CCO</sub> + 0.100 | V <sub>CCO</sub> + 0.300 | V <sub>CCO</sub> /2 - 0.150 | V <sub>CCO</sub> /2 + 0.150 | 8.0             | -8.0            |
| SSTL135                         | -0.300          | 50% V <sub>CCO</sub> - 0.090 | 50% V <sub>CCO</sub> + 0.090 | V <sub>CCO</sub> + 0.300 | V <sub>CCO</sub> /2 - 0.150 | V <sub>CCO</sub> /2 + 0.150 | 9.0             | -9.0            |
| SSTL15                          | -0.300          | 50% V <sub>CCO</sub> - 0.100 | 50% V <sub>CCO</sub> + 0.100 | V <sub>CCO</sub> + 0.300 | V <sub>CCO</sub> /2 - 0.175 | V <sub>CCO</sub> /2 + 0.175 | 10.0            | -10.0           |

**Notes:**

1. Tested according to relevant specifications.
2. Standards specified using the default I/O standard configuration. For details, see the *Versal ACAP SelectIO Resources Architecture Manual (AM010)*.
3. POD10 and POD12 DC input and output levels are shown in [Table 11](#), [Table 16](#), and [Table 17](#).
4. Supported drive strengths of 2, 4, 6, or 8 mA in XPIO banks.
5. Supported drive strengths of 2, 4, 6, 8, or 12 mA in XPIO banks.

**Table 11: DC Input Levels for Single-ended POD10, POD12, LVSTL06\_12, and LVSTL\_11 I/O Standards**

| I/O Standard <sup>1, 3</sup> | V <sub>IL</sub> |                              | V <sub>IH</sub>              |                          |
|------------------------------|-----------------|------------------------------|------------------------------|--------------------------|
|                              | V, Min          | V, Max                       | V, Min                       | V, Max                   |
| POD10                        | -0.300          | 70% V <sub>CCO</sub> - 0.068 | 70% V <sub>CCO</sub> + 0.068 | V <sub>CCO</sub> + 0.300 |
| POD12                        | -0.300          | 70% V <sub>CCO</sub> - 0.068 | 70% V <sub>CCO</sub> + 0.068 | V <sub>CCO</sub> + 0.300 |
| LVSTL06_12                   | -0.300          | V <sub>CCO</sub> /8 - 0.100  | V <sub>CCO</sub> /8 + 0.100  | V <sub>CCO</sub> + 0.300 |
| LVSTL_11                     | -0.300          | V <sub>CCO</sub> /6 - 0.100  | V <sub>CCO</sub> /6 + 0.100  | V <sub>CCO</sub> + 0.300 |

**Notes:**

1. Tested according to relevant specifications.
2. Standards specified using the default I/O standard configuration. For details, see the *Versal ACAP SelectIO Resources Architecture Manual (AM010)*.

**Table 12: Differential SelectIO DC Input and Output Levels for MIPI\_DPHY**

| I/O Standard                                       | V <sub>ICM</sub> (V) <sup>1</sup> |     |       | V <sub>ID</sub> (V) <sup>2</sup> |     |     | V <sub>ILHS</sub> <sup>3</sup> | V <sub>IHHS</sub> <sup>3</sup> | V <sub>OCM</sub> (V) <sup>4</sup> |       |       | V <sub>OD</sub> (V) <sup>5</sup> |       |       |
|--|-----------------------------------|-----|-------|----------------------------------|-----|-----|--------------------------------|--------------------------------|-----------------------------------|-------|-------|----------------------------------|-------|-------|
|  | Min                               | Typ | Max   | Min                              | Typ | Max | Min                            | Max                            | Min                               | Typ   | Max   | Min                              | Typ   | Max   |
| MIPI_DPHY for operation <1.5 GB/s <sup>7</sup>     | 0.070                             | -   | 0.330 | 0.070                            | -   | -   | -0.040                         | 0.460                          | 0.150                             | 0.200 | 0.250 | 0.140                            | 0.200 | 0.270 |
| MIPI_DPHY for operation at >1.5G GB/s <sup>7</sup> | 0.070                             | -   | 0.330 | 0.040                            | -   | -   | -0.040                         | 0.460                          | 0.150                             | 0.200 | 0.250 | 0.140                            | 0.200 | 0.270 |

**Notes:**

1. V<sub>ICM</sub> is the input common mode voltage.
2. V<sub>ID</sub> is the input differential voltage (Q -  $\bar{Q}$ ).
3. V<sub>IHHS</sub> and V<sub>ILHS</sub> are the single-ended input high and low voltages, respectively.
4. V<sub>OCM</sub> is the output common mode voltage.
5. V<sub>OD</sub> is the output differential voltage (Q -  $\bar{Q}$ ).
6. LVDS15 is specified in Table 18.
7. High-speed option for MIPI\_DPHY. The V<sub>ID</sub> maximum is aligned with the standard's specification. A higher V<sub>ID</sub> is acceptable as long as the V<sub>IN</sub> specification is also met.

**Table 13: Complementary Differential SelectIO DC Input and Output Levels for HDIO Banks**

| I/O Standard   | V <sub>ICM</sub> (V) <sup>1</sup> |       |       | V <sub>ID</sub> (V) <sup>2</sup> |       | V <sub>OL</sub> (V) <sup>3</sup> | V <sub>OH</sub> (V) <sup>4</sup> | I <sub>OL</sub> | I <sub>OH</sub> |
|----------------|-----------------------------------|-------|-------|----------------------------------|-------|----------------------------------|----------------------------------|-----------------|-----------------|
|                | Min                               | Typ   | Max   | Min                              | Max   | Max                              | Min                              | mA              | mA              |
| DIFF_HSTL_I_18 | 0.300                             | 0.900 | 1.425 | 0.100                            | -     | 0.400                            | V <sub>CCO</sub> - 0.400         | 8.0             | -8.0            |
| DIFF_SSTL18_I  | 0.300                             | 0.900 | 1.425 | 0.100                            | -     | (V <sub>CCO</sub> /2) - 0.47     | (V <sub>CCO</sub> /2) + 0.47     | 8.0             | -8.0            |
| LVDS_25        | 0.300                             | 1.200 | 1.425 | 0.100                            | 0.600 | -                                | -                                | -               | -               |
| SUB_LVDS       | 0.500                             | 0.900 | 1.300 | 0.070                            | -     | -                                | -                                | -               | -               |
| LVPECL         | 0.300                             | 1.200 | 1.425 | 0.100                            | 0.600 | -                                | -                                | -               | -               |
| SLVS_400_25    | 0.070                             | 0.200 | 0.330 | 0.140                            | 0.450 | -                                | -                                | -               | -               |

**Notes:**

1. V<sub>ICM</sub> is the input common mode voltage.
2. V<sub>ID</sub> is the input differential voltage (Q -  $\bar{Q}$ ).
3. V<sub>OL</sub> is the single-ended low-output voltage.
4. V<sub>OH</sub> is the single-ended high-output voltage.

**Table 14: Complementary Differential SelectIO DC Input and Output Levels for XPIO Banks**

| I/O Standard <sup>1</sup> | V <sub>ICM</sub> (V) <sup>2</sup> |                     |                               | V <sub>ID</sub> (V) <sup>3</sup> |     | V <sub>OL</sub> (V) <sup>4</sup> | V <sub>OH</sub> (V) <sup>5</sup> | I <sub>OL</sub> | I <sub>OH</sub> |
|---------------------------|-----------------------------------|---------------------|-------------------------------|----------------------------------|-----|----------------------------------|----------------------------------|-----------------|-----------------|
|                           | Min                               | Typ                 | Max                           | Min                              | Max | Max                              | Min                              | mA              | mA              |
| DIFF_HSTL_I               | 0.680                             | V <sub>CC0</sub> /2 | (V <sub>CC0</sub> /2) + 0.150 | 0.100                            | -   | 0.400                            | V <sub>CC0</sub> - 0.400         | 5.8             | -5.8            |
| DIFF_HSTL_I_12            | 0.400 x V <sub>CC0</sub>          | V <sub>CC0</sub> /2 | 0.600 x V <sub>CC0</sub>      | 0.100                            | -   | 0.250 x V <sub>CC0</sub>         | 0.750 x V <sub>CC0</sub>         | 4.1             | -4.1            |
| DIFF_HSUL_12              | (V <sub>CC0</sub> /2) - 0.120     | V <sub>CC0</sub> /2 | (V <sub>CC0</sub> /2) + 0.120 | 0.100                            | -   | 20% V <sub>CC0</sub>             | 80% V <sub>CC0</sub>             | 0.1             | -0.1            |
| DIFF_SSTL12               | (V <sub>CC0</sub> /2) - 0.150     | V <sub>CC0</sub> /2 | (V <sub>CC0</sub> /2) + 0.150 | 0.100                            | -   | (V <sub>CC0</sub> /2) - 0.150    | (V <sub>CC0</sub> /2) + 0.150    | 8.0             | -8.0            |
| DIFF_SSTL135              | (V <sub>CC0</sub> /2) - 0.150     | V <sub>CC0</sub> /2 | (V <sub>CC0</sub> /2) + 0.150 | 0.100                            | -   | (V <sub>CC0</sub> /2) - 0.150    | (V <sub>CC0</sub> /2) + 0.150    | 9.0             | -9.0            |
| DIFF_SSTL15               | (V <sub>CC0</sub> /2) - 0.175     | V <sub>CC0</sub> /2 | (V <sub>CC0</sub> /2) + 0.175 | 0.100                            | -   | (V <sub>CC0</sub> /2) - 0.175    | (V <sub>CC0</sub> /2) + 0.175    | 10.0            | -10.0           |

**Notes:**

1. DIFF\_POD10 and DIFF\_POD12 XPIO bank specifications are shown in [Table 15](#), [Table 16](#), and [Table 17](#).
2. V<sub>ICM</sub> is the input common mode voltage.
3. V<sub>ID</sub> is the input differential voltage.
4. V<sub>OL</sub> is the single-ended low-output voltage.
5. V<sub>OH</sub> is the single-ended high-output voltage.

**Table 15: DC Input Levels for Differential POD10, POD12, LVSTL06\_12, and LVSTL\_11 I/O Standards**

| I/O Standard <sup>1,2</sup> | V <sub>ICM</sub> (V) |       |       | V <sub>ID</sub> (V) |     |
|-----------------------------|----------------------|-------|-------|---------------------|-----|
|                             | Min                  | Typ   | Max   | Min                 | Max |
| DIFF_POD10                  | 0.630                | 0.700 | 0.770 | 0.140               | -   |
| DIFF_POD12                  | 0.756                | 0.840 | 0.924 | 0.160               | -   |
| DIFF_LVSTL06_12             | 0.143                | 0.150 | 0.157 | 0.140               | -   |
| DIFF_LVSTL_11               | 0.174                | 0.183 | 0.193 | 0.140               | -   |

**Notes:**

1. Tested according to relevant specifications.
2. Standards specified using the default I/O standard configuration. For details, see the *Versal ACAP SelectIO Resources Architecture Manual (AM010)*.

**Table 16: DC Output Levels for Single-ended and Differential POD10, POD12, LVSTL06\_12, and LVSTL\_11 I/O Standards**

| I/O Standard                    | Symbol          | Description <sup>1,2,3</sup> | V <sub>OUT</sub>   | Min | Typ | Max | Units |
|---------------------------------|-----------------|------------------------------|--|-----|-----|-----|-------|
| POD10 and POD12                 | R <sub>OL</sub> | Pull-down resistance         | V <sub>OM_DC</sub> (as described in <a href="#">Table 17</a> ) | 32  | 40  | 48  | Ω     |
|                                 | R <sub>OH</sub> | Pull-up resistance           | V <sub>OM_DC</sub> (as described in <a href="#">Table 17</a> ) | 32  | 40  | 48  | Ω     |
| LVSTL06_12                      | R <sub>OL</sub> | Pull-down resistance         | V <sub>OCM_DC_LOW</sub>  | 32  | 40  | 48  | Ω     |
|                                 | R <sub>OH</sub> | Pull-up resistance           | V <sub>OCM_DC_HIGH</sub>                                       | 32  | 40  | 48  | Ω     |
| LVSTL_11 (V <sub>OH</sub> = 50) | R <sub>OL</sub> | Pull-down resistance         | V <sub>OM_DC</sub> (as described in <a href="#">Table 17</a> ) | 32  | 40  | 48  | Ω     |
|                                 | R <sub>OH</sub> | Pull-up resistance           | V <sub>OM_DC</sub> (as described in <a href="#">Table 17</a> ) | 32  | 40  | 48  | Ω     |

**Notes:**

1. Tested according to relevant specifications.
2. The tolerance limits are specified after calibration with stable voltage and temperature.
3. Standards specified using the default I/O standard configuration. For details, see the *Versal ACAP SelectIO Resources Architecture Manual (AM010)*.

**Table 17: Definitions for DC Output Levels for Single-ended and Differential POD10, POD12, LVSTL06\_12, and LVSTL\_11 I/O Standards**

| I/O Standard                    | Symbol                   | Description   | All Speed Grades                           | Units |
|---------------------------------|--------------------------|---|--|-------|
| POD10 and POD12                 | V <sub>OM_DC</sub>       | DC output mid measurement level (for IV curve linearity)                  | 0.8 x V <sub>CCO</sub>                     | V     |
| LVSTL_11 (V <sub>OH</sub> = 50) | V <sub>OM_DC</sub>       | DC output mid measurement level (for IV curve linearity)                  | V <sub>CCO</sub> /2                        | V     |
| LVSTL06_12                      | V <sub>OCM_DC_LOW</sub>  | DC output mid measurement level (for IV curve linearity), drive logic Low | V <sub>CCO</sub> /2                        | V     |
|                                 | V <sub>OCM_DC_HIGH</sub> | DC output measurement level (for IV curve linearity), drive logic High    | V <sub>CCO</sub> /2 to V <sub>CCO</sub> /4 | V     |

## LVDS DC Specifications (LVDS15)

The LVDS15 standard is available in the XPIO banks. See the *Versal ACAP SelectIO Resources Architecture Manual (AM010)* for more information.

**Table 18: LVDS15 DC Specifications**

| Symbol                           | DC Parameter   | Conditions   | Min   | Typ   | Max              | Units |
|----------------------------------|--|--|-------|-------|------------------|-------|
| V <sub>CCO</sub> <sup>1</sup>    | Supply voltage   |  | 1.425 | 1.500 | 1.575            | V     |
| V <sub>ODIFF</sub> <sup>2</sup>  | Differential output voltage:<br>(Q - $\bar{Q}$ ), Q = High<br>( $\bar{Q}$ - Q), $\bar{Q}$ = High | R <sub>T</sub> = 100Ω across Q and $\bar{Q}$ signals | 247   | 350   | 454              | mV    |
| V <sub>OCM</sub> <sup>2</sup>    | Output common-mode voltage   | R <sub>T</sub> = 100Ω across Q and $\bar{Q}$ signals | 1.000 | 1.20  | 1.320            | V     |
| V <sub>IDIFF</sub> <sup>3</sup>  | Differential input voltage:<br>(Q - $\bar{Q}$ ), Q = High<br>( $\bar{Q}$ - Q), $\bar{Q}$ = High  |  | 100   | 350   | 600 <sup>3</sup> | mV    |
| V <sub>ICM_DC</sub> <sup>4</sup> | Input common-mode voltage (DC coupling)  |  | 0.300 | 1.200 | 1.320            | V     |
| V <sub>ICM_AC</sub> <sup>5</sup> | Input common-mode voltage (AC coupling)  |  | 200   | -     | 330              | mV    |

**Notes:**

- In XPIO banks, when LVDS15 is used with input-only functionality, it can be placed in a bank where the V<sub>CCO</sub> levels are different from the specified level only if internal differential termination is not used. In this scenario, V<sub>CCO</sub> must be chosen to ensure the input pin voltage levels do not violate the Recommended Operating Condition (Table 3) specification for the V<sub>IN</sub> I/O pin voltage.
- V<sub>OCM</sub> and V<sub>ODIFF</sub> values are for LVDS\_PRE\_EMPHASIS = FALSE.
- Maximum V<sub>IDIFF</sub> value is specified for the maximum V<sub>ICM</sub> specification. With a lower V<sub>ICM</sub>, a higher V<sub>IDIFF</sub> is tolerated only when the recommended operating conditions and overshoot/undershoot V<sub>IN</sub> specifications are maintained.
- Input common mode voltage for DC coupled configurations. EQUALIZATION = EQ\_NONE (Default).
- AC coupling with external bias and external differential termination with EQUALIZATION settings enabled. EQUALIZATION = EQ\_LEVEL0, EQ\_LEVEL1, EQ\_LEVEL2, EQ\_LEVEL3, or EQ\_LEVEL4, any setting except EQ\_NONE.

## Power Supply Requirements

Versal AI Core devices are powered by multiple power supply pins that must use specific rail combinations and power sequences. Only some combinations and sequences are supported. The combinations depend upon the selected device, speed specification, and power management options. The required sequencing and power delivery options are shown in the power design tab in the Xilinx® Power Estimator (XPE). For more information, see <https://www.xilinx.com/power>.

**Table 19: Power Supply Ramp Time**

| Symbol                  | Description   | Min | Max | Units |
|-------------------------|---|-----|-----|-------|
| $T_{VCCAUX}$            | Ramp time from GND to 95% of $V_{CCAUX}$                    | 0.2 | 40  | ms    |
| $T_{VCCAUX\_PMC}$       | Ramp time from GND to 95% of $V_{CCAUX\_PMC}$               | 0.2 | 40  | ms    |
| $T_{VCCAUX\_SMON}$      | Ramp time from GND to 95% of $V_{CCAUX\_SMON}$              | 0.2 | 40  | ms    |
| $T_{VCC\_CPM5}$         | Ramp time from GND to 95% of $V_{CC\_CPM5}$                 | 0.2 | 40  | ms    |
| $T_{VCC\_FUZE}$         | Ramp time from GND to 95% of $V_{CC\_FUZE}$                 | 0.2 | 40  | ms    |
| $T_{VCCINT}$            | Ramp time from GND to 95% of $V_{CCINT}$                    | 0.2 | 40  | ms    |
| $T_{VCC\_IO\_VCC\_SOC}$ | Ramp time from GND to 95% of $V_{CC\_IO}$ and $V_{CC\_SOC}$ | 0.2 | 40  | ms    |
| $T_{VCCO}$              | Ramp time from GND to 95% of $V_{CCO}$                      | 0.2 | 40  | ms    |
| $T_{VCC\_PMC}$          | Ramp time from GND to 95% of $V_{CC\_PMC}$                  | 0.2 | 40  | ms    |
| $T_{VCC\_PSFP}$         | Ramp time from GND to 95% of $V_{CC\_PSFP}$                 | 0.2 | 40  | ms    |
| $T_{VCC\_PSLP}$         | Ramp time from GND to 95% of $V_{CC\_PSLP}$                 | 0.2 | 40  | ms    |
| $T_{VCC\_RAM}$          | Ramp time from GND to 95% of $V_{CC\_RAM}$                  | 0.2 | 40  | ms    |
| $T_{GT\_AVCC}$          | Ramp time from GND to 95% of $V_{GT\_AVCC}$                 | 0.2 | 40  | ms    |
| $T_{GT\_AVCCAUX}$       | Ramp time from GND to 95% of $V_{GT\_AVCCAUX}$              | 0.2 | 40  | ms    |
| $T_{GT\_AVTT}$          | Ramp time from GND to 95% of $V_{GT\_AVTT}$                 | 0.2 | 40  | ms    |

## AC Switching Characteristics

All values represented in this data sheet are based on the speed specifications in the Vivado® Design Suite as outlined in the following table.

Table 20: Speed Specification Version by Device

| 2022.1 | Device                                  |
|--------|---|
| 2.08   | XCVC1802, XCVC1902, XQVC1902, XQRVC1902 |
| 1.02   | XCVC1502, XCVC1702                      |

Switching characteristics are specified on a per-speed-grade basis and can be designated as evaluation, engineering sample, pre-production, or production. Each designation is defined as follows:

- **Evaluation Product Specification:** These specifications are used for architecture evaluation only. They cannot be used for timing closure.
- **Engineering Sample Product Specification:** These specifications are based on simulations only and are typically available soon after dice design specifications are frozen. Although speed grades with this designation are considered relatively stable and conservative, some under-reporting might still occur.
- **Pre-production Product Specification:** These specifications are based on almost complete silicon characterization. Dice and speed grades with this designation are intended to give a better indication of the expected performance of production silicon. The probability of under-reporting delays is greatly reduced as compared to engineering sample (ES) data.
- **Production Product Specification:** These specifications are released once enough production silicon of a particular dice family member has been characterized to provide full correlation between specifications and dices over numerous production lots. There is no under-reporting of delays, and customers receive formal notification of any subsequent changes. Typically, the slowest speed grades transition to production before faster speed grades.

## Testing of AC Switching Characteristics

Internal timing parameters are derived from measuring internal test patterns. All AC switching characteristics are representative of worst-case supply voltage and junction temperature conditions.

For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer and back-annotate to the simulation net list. Unless otherwise noted, values apply to all Versal AI Core devices.

## Speed Grade Designations

Because individual family members are produced at different times, the migration from one category to another depends completely on the status of the fabrication process for each device. [Table 21](#) correlates the current status of the Versal AI Core device on a per speed grade basis. See [Table 4](#) for operating voltages listed by speed grade.



Table 21: Speed Grade Designations by Device

| Device    | Speed Grade, Temperature Ranges, Static Screen, and V <sub>CCINT</sub> Operating Voltages   |   |                |   |
|-----------|---|---|----------------|---|
|           | Evaluation  | Engineering Sample  | Pre-production | Production  |
| XCVC1352  | -2HSI (V <sub>CCINT</sub> = 0.88V)<br>-2MSE, -2MLE, -2MSI, -2MLI (V <sub>CCINT</sub> = 0.80V)<br>-2LSE, -2LLE, -2LLI (V <sub>CCINT</sub> = 0.70V)<br>-1MSE, -1MSI, -1MLI (V <sub>CCINT</sub> = 0.80V)<br>-1LSE, -1LSI, -1LLI (V <sub>CCINT</sub> = 0.70V) |   |                |   |
| XQVC1352  | -2HSI (V <sub>CCINT</sub> = 0.88V)<br>-2MSI, -2MLI (V <sub>CCINT</sub> = 0.80V)<br>-2LLI (V <sub>CCINT</sub> = 0.70V)<br>-1MSM (V <sub>CCINT</sub> = 0.80V)<br>-1MSI, -1MLI (V <sub>CCINT</sub> = 0.80V)<br>-1LSI, -1LLI (V <sub>CCINT</sub> = 0.70V)     |   |                |   |
| XCVC1502  |   | -2HSI (V <sub>CCINT</sub> = 0.88V)<br>-2MSE, -2MLE, -2MSI, -2MLI (V <sub>CCINT</sub> = 0.80V)<br>-2LSE, -2LLE, -2LLI (V <sub>CCINT</sub> = 0.70V)<br>-1MSE, -1MSI, -1MLI (V <sub>CCINT</sub> = 0.80V)<br>-1LSE, -1LSI, -1LLI (V <sub>CCINT</sub> = 0.70V) |                |   |
| XCVC1702  |   | -2HSI (V <sub>CCINT</sub> = 0.88V)<br>-2MSE, -2MLE, -2MSI, -2MLI (V <sub>CCINT</sub> = 0.80V)<br>-2LSE, -2LLE, -2LLI (V <sub>CCINT</sub> = 0.70V)<br>-1MSE, -1MSI, -1MLI (V <sub>CCINT</sub> = 0.80V)<br>-1LSE, -1LSI, -1LLI (V <sub>CCINT</sub> = 0.70V) |                |   |
| XQVC1702  | -2HSI (V <sub>CCINT</sub> = 0.88V)<br>-2MSI, -2MLI (V <sub>CCINT</sub> = 0.80V)<br>-2LLI (V <sub>CCINT</sub> = 0.70V)<br>-1MSM (V <sub>CCINT</sub> = 0.80V)<br>-1MSI, -1MLI (V <sub>CCINT</sub> = 0.80V)<br>-1LSI, -1LLI (V <sub>CCINT</sub> = 0.70V)     |   |                |   |
| XCVC1802  |   | -2HSI (V <sub>CCINT</sub> = 0.88V)  |                | -2MSE, -2MLE, -2MSI, -2MLI (V <sub>CCINT</sub> = 0.80V)<br>-2LSE, -2LLE, -2LLI (V <sub>CCINT</sub> = 0.70V)<br>-1MSE, -1MSI, -1MLI (V <sub>CCINT</sub> = 0.80V)<br>-1LSE, -1LSI, -1LLI (V <sub>CCINT</sub> = 0.70V) |
| XCVC1902  |   | -2HSI (V <sub>CCINT</sub> = 0.88V)  |                | -2MSE, -2MLE, -2MSI, -2MLI (V <sub>CCINT</sub> = 0.80V)<br>-2LSE, -2LLE, -2LLI (V <sub>CCINT</sub> = 0.70V)<br>-1MSE, -1MSI, -1MLI (V <sub>CCINT</sub> = 0.80V)<br>-1LSE, -1LSI, -1LLI (V <sub>CCINT</sub> = 0.70V) |
| XQVC1902  | -2HSI (V <sub>CCINT</sub> = 0.88V)  |   |                | -2MSI (V <sub>CCINT</sub> = 0.80V)<br>-1MSI (V <sub>CCINT</sub> = 0.80V)<br>-1LSI (V <sub>CCINT</sub> = 0.70V)<br>-1MSM (V <sub>CCINT</sub> = 0.80V)  |
| XQRVC1902 |   |   |                | -1MSB (V <sub>CCINT</sub> = 0.80V)  |

Table 21: Speed Grade Designations by Device (cont'd)

| Device   | Speed Grade, Temperature Ranges, Static Screen, and V <sub>CCINT</sub> Operating Voltages  |                    |                |            |
|----------|--|--------------------|----------------|------------|
|          | Evaluation   | Engineering Sample | Pre-production | Production |
| XCVC2602 | -3HSE (V <sub>CCINT</sub> = 0.88V)<br>-2MSE, -2MLE, -2MSI, -2MLI (V <sub>CCINT</sub> = 0.80V)<br>-2LSE, -2LLE (V <sub>CCINT</sub> = 0.70V)<br>-1MSE, -1MSI, -1MLI (V <sub>CCINT</sub> = 0.80V)<br>-1LSE, -1LSI, -1LLI (V <sub>CCINT</sub> = 0.70V) |                    |                |            |
| XCVC2802 | -3HSE (V <sub>CCINT</sub> = 0.88V)<br>-2MSE, -2MLE, -2MSI, -2MLI (V <sub>CCINT</sub> = 0.80V)<br>-2LSE, -2LLE (V <sub>CCINT</sub> = 0.70V)<br>-1MSE, -1MSI, -1MLI (V <sub>CCINT</sub> = 0.80V)<br>-1LSE, -1LSI, -1LLI (V <sub>CCINT</sub> = 0.70V) |                    |                |            |

## Production Silicon and Software Status

In some cases, a particular family member (and speed grade) is released to production before a speed specification is released with the correct label (engineering sample, pre-production, production). Any labeling discrepancies are corrected in subsequent speed specification releases.

The following table lists the production released Versal AI Core device, speed grade, and the minimum corresponding supported speed specification version and Vivado® software versions. The Vivado software and speed specifications listed are the minimum releases required for production. All subsequent releases of software and speed specifications are valid.

Table 22: Production Software and Speed Specification Release

| Device    | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CCINT}$ ) <sup>1,2</sup> |     |  |                           |  |     |
|-----------|---|-----|--|---------------------------|--|-----|
|           | 0.88V (H)   |     | 0.80V (M)                                |                           | 0.70V (L)                                |     |
|           | -3  | -2  | -2                                       | -1                        | -2                                       | -1  |
| XCVC1352  | N/A   |     |  |                           |  |     |
| XQVC1352  | N/A   |     |  |                           |  |     |
| XCVC1502  | N/A   |     |  |                           |  |     |
| XCVC1702  | N/A   |     |  |                           |  |     |
| XQVC1702  | N/A   |     |  |                           |  |     |
| XCVC1802  | N/A   |     | Vivado tools 2021.2.1 v2.05 <sup>3</sup> |                           | Vivado tools 2021.2.1 v2.05 <sup>3</sup> |     |
| XCVC1902  | N/A   |     | Vivado tools 2021.2.1 v2.05 <sup>3</sup> |                           | Vivado tools 2021.2.1 v2.05 <sup>3</sup> |     |
| XQVC1902  | N/A   |     | Vivado tools 2022.1 v2.08                |                           | Vivado tools 2022.1 v2.08                |     |
| XQRVC1902 | N/A   | N/A | N/A                                      | Vivado tools 2022.1 v2.08 | N/A                                      | N/A |
| XCVC2602  |   | N/A |  |                           |  |     |
| XCVC2802  |   | N/A |  |                           |  |     |

**Notes:**

1. See [Table 4](#) for the complete list of operating voltages by speed grade.
2. Blank entries indicate a device and/or speed grade in engineering sample or pre-production status.
3. The minimum production version of the Vivado tools is 2021.2.1 for designs using XPLL deskew (CLKIN\_DESKEW, CLKFB\_DESKEW) while CLKIN\_DESKEW is connected to CLKIN, MMCM deskew (CLKIN\_DESKEW, CLKFB\_DESKEW), or Versal ACAP CPM mode for PCI Express® with CPM4 to PL interfaces enabled. The minimum production version of the Vivado tools remains at 2020.3 v2.00 for 0.70V (L) devices and 2021.1 v2.01 for 0.80V (M) devices when the designs do not use XPLL deskew, MMCM deskew, or Versal ACAP CPM mode for PCI Express with CPM4 to PL interfaces enabled.

## Device Identification

The combined IDCODE and EXTENDED\_IDCODE value provide the Xilinx device type identification as listed in the following table. For more information on the IDCODE and EXTENDED\_IDCODE, see *Versal ACAP Technical Reference Manual* ([AM011](#)).

Table 23: Device Identification (IDCODE + EXTENDED\_IDCODE)

| Device    | IDCODE[31:0] (Hex) <sup>1</sup> | EXTENDED_IDCODE[31:0] (Binary) <sup>2</sup> |
|-----------|---------------------------------|---|
| XCVC1352  | X4C93093                        | XXXX 0000 0000 0000 01XX XXXX XXXX XXXX     |
| XQVC1352  | X4C93093                        | XXXX 0000 0000 0000 01XX XXXX XXXX XXXX     |
| XCVC1502  | X4C9B093                        | XXXX 0000 0000 0000 01XX XXXX XXXX XXXX     |
| XCVC1702  | X4C98093                        | XXXX 0000 0000 0000 01XX XXXX XXXX XXXX     |
| XQVC1702  | X4C98093                        | XXXX 0000 0000 0000 01XX XXXX XXXX XXXX     |
| XCVC1802  | 14CA9093                        | XXXX 0000 0000 0000 01XX XXXX XXXX XXXX     |
| XCVC1902  | 14CA8093                        | XXXX 0000 0000 0000 01XX XXXX XXXX XXXX     |
| XQVC1902  | 14CA8093                        | XXXX 0000 0000 0000 01XX XXXX XXXX XXXX     |
| XQRVC1902 | 14CA8093                        | XXXX 0000 0000 0000 01XX XXXX XXXX XXXX     |
| XCVC2602  | X4CD2093                        | XXXX 0000 0000 0000 01XX XXXX XXXX XXXX     |
| XCVC2802  | X4CD0093                        | XXXX 0000 0000 0000 01XX XXXX XXXX XXXX     |

**Notes:**

1. An x at the location of the IDCODE[31:28] revision field is a placeholder until the production revision is defined.
2. Only the EXTENDED\_IDCODE[27:14] bit values are relevant to device identification. The x in other bit positions indicate that they can be any value and must be ignored during device identification.

## Processing System Performance Characteristics

Table 24: Processor Performance

| Symbol              | Description  | Performance as a Function of Speed Grade and Operating Voltage |      |           |      |           |                   | Units |
|---------------------|--|--|------|-----------|------|-----------|-------------------|-------|
|                     |  | 0.88V (H)  |      | 0.80V (M) |      | 0.70V (L) |                   |       |
|                     |  | -3   | -2   | -2        | -1   | -2        | -1                |       |
| F <sub>APUMAX</sub> | Maximum APU clock frequency where the operating voltage = V <sub>CC_PSF</sub>  | 1700   | 1650 | 1400      | 1300 | 1080      | 1000 <sup>1</sup> | MHz   |
| F <sub>RPUMAX</sub> | Maximum RPU clock frequency where the operating voltage = V <sub>CC_PSLP</sub> | 800  | 800  | 600       | 600  | 450       | 400 <sup>2</sup>  | MHz   |

**Notes:**

1. The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum APU reference clock frequency is 1600 MHz when V<sub>CC\_PSF</sub> = 0.88V.
2. The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum RPU reference clock frequency is 800 MHz V<sub>CC\_PSLP</sub> = 0.88V.

Table 25: PS-PL Interface Performance

| Symbol                    | Description  | Performance as a Function of Speed Grade and Operating Voltage |     |           |     |           |                  | Units |
|---------------------------|--|--|-----|-----------|-----|-----------|------------------|-------|
|                           |  | 0.88V (H)  |     | 0.80V (M) |     | 0.70V (L) |                  |       |
|                           |  | -3   | -2  | -2        | -1  | -2        | -1               |       |
| F <sub>AXI_CLK</sub>      | Maximum AXI4 and ACE-LITE interface frequency                | 400  | 400 | 350       | 350 | 300       | 250 <sup>1</sup> | MHz   |
| F <sub>PLAT_CLK</sub>     | Maximum PL address translation (AT) interface frequency      | 400  | 400 | 350       | 350 | 300       | 250 <sup>2</sup> | MHz   |
| F <sub>PLATB_CLK</sub>    | Maximum PL-PS advanced trace bus (ATB) interface frequency   | 400  | 400 | 350       | 350 | 300       | 250 <sup>2</sup> | MHz   |
| F <sub>PSACE_CLK</sub>    | Maximum AXI4 coherency extensions (ACE) interface frequency  | 400  | 400 | 350       | 350 | 300       | 250 <sup>2</sup> | MHz   |
| F <sub>PSACP_CLK</sub>    | Maximum accelerator coherency port (ACP) interface frequency | 400  | 400 | 350       | 350 | 300       | 250 <sup>2</sup> | MHz   |
| F <sub>PSFCIDMA_CLK</sub> | Maximum DMA flow-control interface (FCI) frequency           | 400  | 400 | 350       | 350 | 300       | 250 <sup>3</sup> | MHz   |

**Notes:**

1. The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum clock frequency is 280 MHz for AXI4 (when V<sub>CC\_PSFP</sub> = 0.88V or V<sub>CC\_PSLP</sub> = 0.88V) and ACE-LITE (when V<sub>CC\_PSFP</sub> = 0.88V).
2. The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum clock frequency is 280 MHz when V<sub>CC\_PSFP</sub> = 0.88V.
3. The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum clock frequency is 280 MHz when V<sub>CC\_PSLP</sub> = 0.88V.

## PS and PMC Switching Characteristics

### Clocks and Reset

Table 26: Reference Clock Requirements

| Symbol                   | Description   | Min | Max  | Units |
|--------------------------|---|-----|------|-------|
| F <sub>REFCLK</sub>      | Reference clock (REF_CLK) frequency   | 27  | 60   | MHz   |
| T <sub>RMSJ_REFCLK</sub> | REF_CLK input RMS clock jitter  | -   | 3    | ps    |
| T <sub>INPJ_REFCLK</sub> | REF_CLK input period jitter (peak-to-peak)<br>Number of clock cycles = 10,000 | -   | 50   | ps    |
| T <sub>DC_REFCLK</sub>   | REF_CLK duty cycle  | 45  | 55   | %     |
| T <sub>REFCLK</sub>      | REF_CLK rise time (20%–80%) and fall time (80%–20%) at 3.3V                   | -   | 3    | ns    |
|                          | REF_CLK rise time (20%–80%) and fall time (80%–20%) at 1.8V or 2.5V           | -   | 3.5  | ns    |
|                          | REF_CLK rise time (10%–90%) and fall time (90%–10%) at 3.3V                   | -   | 4    | ns    |
|                          | REF_CLK rise time (10%–90%) and fall time (90%–10%) at 1.8V or 2.5V           | -   | 4.66 | ns    |

**Notes:**

1. The F<sub>REFCLK</sub> clock frequency range and T<sub>DC\_REFCLK</sub> duty cycle specifications also apply to the PL alternative reference clock inputs (PL\_PMC\_ALT\_REF\_CLK, PL\_LPD\_ALT\_REF\_CLK, and PL\_FPD\_ALT\_REF\_CLK).
2. See Table 28: Power-on Reset Assertion Timing Requirements for REF\_CLK operating requirements with respect to the POR\_B input.

Table 27: RTC Crystal Requirements

| Symbol              | Description                                     | Min | Typ    | Max | Units |
|---------------------|---|-----|--------|-----|-------|
| F <sub>XTAL</sub>   | Parallel resonance crystal frequency            | -   | 32.768 | -   | kHz   |
| T <sub>FTXTAL</sub> | Frequency tolerance                             | -20 | -      | 20  | ppm   |
| C <sub>XTAL</sub>   | Load capacitance for crystal parallel resonance | -   | 12.5   | -   | pF    |
| R <sub>ESR</sub>    | Crystal ESR (16.8 and 19.2 MHz)                 | -   | 70     | -   | kΩ    |
| C <sub>SHUNT</sub>  | Crystal shunt capacitance                       | -   | 1.4    | -   | pF    |

Table 28: Power-on Reset Assertion Timing Requirements

| Symbol               | Description                                  | Min | Typ | Max | Units |
|----------------------|--|-----|-----|-----|-------|
| T <sub>POR_B</sub>   | Required POR_B assertion time <sup>1,2</sup> | 10  | -   | -   | μs    |
| T <sub>MODEPOR</sub> | MODE[3:0] setup time to POR_B rising edge    | 74  | -   | -   | ns    |
| T <sub>PORMODE</sub> | POR_B rising edge to MODE[3:0] hold time     | 74  | -   | -   | ns    |

**Notes:**

1. The POR\_B input must be asserted Low during the power-on sequence and continue to be asserted for a duration T<sub>POR\_B</sub> after all the required supplies of the PMC have reached minimum voltage levels. The PS, system, and PL domains can be independently powered on or off with additional power management. If the PS, system, and/or PL domains are expected to be functional at initial power-on without additional power management, then the POR\_B input must be held Low until all required domain power supplies have also reached minimum voltage levels. For additional power-on sequence information, refer to the Xilinx Power Estimator (XPE). For additional power management information, see the *Versal ACAP Technical Reference Manual (AM011)* or the *Versal ACAP System Software Developers Guide (UG1304)*.
2. Before the deassertion of POR\_B, the REF\_CLK must be operating within specification.

Table 29: PS FPD Clocks Switching Characteristics

| Symbol                     | Description                            | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CC_PSFP</sub> ) |     |           |     |           |                  | Units |
|----------------------------|--|--|-----|-----------|-----|-----------|------------------|-------|
|                            |  | 0.88V (H)  |     | 0.80V (M) |     | 0.70V (L) |                  |       |
|                            |  | -3   | -2  | -2        | -1  | -2        | -1               |       |
| F <sub>FPD_LSBUS_CLK</sub> | Maximum FPD LSBUS clock frequency      | 150  | 150 | 150       | 150 | 100       | 100 <sup>1</sup> | MHz   |
| F <sub>FPD_TOPSW_CLK</sub> | Maximum FPD top-switch clock frequency | 1000   | 950 | 825       | 800 | 600       | 550 <sup>2</sup> | MHz   |
| F <sub>DBG_FPD_CLK</sub>   | Maximum debug FPD clock frequency      | 400  | 400 | 400       | 400 | 400       | 333 <sup>3</sup> | MHz   |

**Notes:**

1. The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum FPD LSBUS clock frequency is 150 MHz when V<sub>CC\_PSFP</sub> = 0.88V.
2. The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum FPD top-switch clock frequency is 800 MHz when V<sub>CC\_PSFP</sub> = 0.88V.
3. The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum debug FPD clock frequency is 400 MHz when V<sub>CC\_PSFP</sub> = 0.88V.

**Table 30: PS LPD Clocks Switching Characteristics**

| Symbol                   | Description  | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_PSLP}$ ) |      |           |      |           |                  | Units |
|--------------------------|--|---|------|-----------|------|-----------|------------------|-------|
|                          |  | 0.88V (H)   |      | 0.80V (M) |      | 0.70V (L) |                  |       |
|                          |  | -3  | -2   | -2        | -1   | -2        | -1               |       |
| $F_{RPLL\_TO\_XPD\_CLK}$ | Maximum RPU PLL to XPD clock frequency               | 1200  | 1200 | 1200      | 1200 | 1000      | 1000             | MHz   |
| $F_{LPD\_TOPSW\_CLK}$    | Maximum LPD top-switch clock frequency <sup>1</sup>  | 750   | 700  | 600       | 600  | 450       | 400 <sup>2</sup> | MHz   |
| $F_{LPD\_LSBUS\_CLK}$    | Maximum LPD LSBUS clock frequency <sup>1</sup>       | 150   | 150  | 150       | 150  | 100       | 100 <sup>3</sup> | MHz   |
| $F_{IOP\_SW\_CLK}$       | Maximum I/O peripherals (IOP) switch clock frequency | 250   | 250  | 250       | 250  | 250       | 250              | MHz   |
| $F_{TS\_REFCLK}$         | Maximum time-stamp reference clock frequency         | 100   | 100  | 100       | 100  | 100       | 100              | MHz   |
| $F_{PSM\_REFCLK}$        | Maximum PS manager (PSM) reference clock frequency   | 460   | 460  | 460       | 460  | 368       | 368 <sup>4</sup> | MHz   |
| $F_{DBG\_LPD\_CLK}$      | Maximum debug LPD clock frequency                    | 400   | 400  | 400       | 400  | 400       | 333 <sup>5</sup> | MHz   |
| $F_{DBG\_TS\_CLK}$       | Maximum debug time-stamp clock frequency             | 400   | 400  | 400       | 400  | 400       | 333 <sup>6</sup> | MHz   |
| $F_{USB\_REFCLK}$        | Maximum USB reference clock frequency                | 60  | 60   | 60        | 60   | 60        | 60               | MHz   |
| $F_{CPM4\_TOPSW\_CLK}$   | Maximum CPM4 top-switch clock frequency              | 1000  | 950  | 825       | 800  | 600       | 550              | MHz   |

**Notes:**

- The LPD\_TOPSW\_CLK operating frequency must be greater than the LPD\_LSBUS\_CLK operating frequency.
- The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum LPD top-switch clock frequency is 600 MHz when  $V_{CC\_PSLP} = 0.88V$ .
- The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum LPD LSBUS clock frequency is 150 MHz when  $V_{CC\_PSLP} = 0.88V$ .
- The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum PSM reference clock frequency is 400 MHz when  $V_{CC\_PSLP} = 0.88V$ .
- The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum debug LPD clock frequency is 400 MHz when  $V_{CC\_PSLP} = 0.88V$ .
- The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum debug time-stamp clock frequency is 400 MHz when  $V_{CC\_PSLP} = 0.88V$ .

**Table 31: PMC IRO Clock Switching Characteristics**

| Symbol              | Description                                 | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_PMC}$ ) |         |           |         |           |         | Units |
|---------------------|---|--|---------|-----------|---------|-----------|---------|-------|
|                     |   | 0.88V (H)  |         | 0.80V (M) |         | 0.70V (L) |         |       |
|                     |   | -3   | -2      | -2        | -1      | -2        | -1      |       |
| $F_{PMC\_IRO\_CLK}$ | PMC internal clock source typical frequency | 400  | 400     | 400       | 400     | 320       | 320     | MHz   |
|                     | PMC internal clock source tolerance         | +10/-17  | +10/-17 | +10/-17   | +10/-17 | +10/-17   | +10/-17 | %     |

**Table 32: PMC Clocks Switching Characteristics**

| Symbol              | Description   | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_PMC}$ ) |     |           |     |           |    | Units |
|---------------------|---|--|-----|-----------|-----|-----------|----|-------|
|                     |   | 0.88V (H)  |     | 0.80V (M) |     | 0.70V (L) |    |       |
|                     |   | -3   | -2  | -2        | -1  | -2        | -1 |       |
| $F_{EFUSE\_REFCLK}$ | Maximum eFUSE reference clock frequency for reading     | 115  | 115 | 115       | 115 | 92        | 92 | MHz   |
|                     | Maximum eFUSE reference clock frequency for programming | 60   | 60  | 60        | 60  | 60        | 60 | MHz   |

Table 32: PMC Clocks Switching Characteristics (cont'd)

| Symbol                       | Description  | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_PMC}$ ) |      |           |      |                  |                  | Units |
|------------------------------|--|--|------|-----------|------|------------------|------------------|-------|
|                              |  | 0.88V (H)  |      | 0.80V (M) |      | 0.70V (L)        |                  |       |
|                              |  | -3   | -2   | -2        | -1   | -2               | -1               |       |
| F <sub>SMON_REFCLK</sub>     | Maximum system monitor reference clock frequency   | 300  | 300  | 300       | 300  | 300              | 300              | MHz   |
| F <sub>USB_SREFCLK</sub>     | Maximum USB suspend reference clock frequency  | 115  | 115  | 115       | 115  | 92               | 92               | MHz   |
| F <sub>AXI_TO_REFCLK</sub>   | Maximum AXI4 timeout reference clock frequency   | 115  | 115  | 115       | 115  | 92               | 92               | MHz   |
| F <sub>CFU_REFCLK</sub>      | Maximum configuration frame unit (CFU) reference clock frequency <sup>1</sup>                | 400  | 400  | 400       | 400  | 320              | 320              | MHz   |
|                              | Minimum CFU reference clock frequency  | 20   | 20   | 20        | 20   | 20               | 20               | MHz   |
| F <sub>LSBUS_REFCLK</sub>    | Maximum PMC LSBUS reference clock frequency  | 150  | 150  | 150       | 150  | 100              | 100              | MHz   |
| F <sub>NPI_REFCLK</sub>      | Maximum NoC programming interface (NPI) reference clock frequency                            | 300  | 300  | 300       | 300  | 300 <sup>2</sup> | 300 <sup>2</sup> | MHz   |
| F <sub>HSM0_REFCLK</sub>     | Maximum horizontal super module (HSM0) reference clock frequency used with XPIO <sup>3</sup> | 200  | 200  | 200       | 200  | 200              | 200              | MHz   |
| F <sub>HSM1_REFCLK</sub>     | Maximum horizontal super module (HSM1) reference clock frequency used with XPIO <sup>4</sup> | 200  | 200  | 200       | 200  | 200              | 200              | MHz   |
| F <sub>PL0_REFCLK</sub>      | Maximum PL0 reference clock frequency  | 400  | 400  | 350       | 350  | 300              | 250 <sup>5</sup> | MHz   |
| F <sub>PL1_REFCLK</sub>      | Maximum PL1 reference clock frequency  | 400  | 400  | 350       | 350  | 300              | 250 <sup>5</sup> | MHz   |
| F <sub>PL2_REFCLK</sub>      | Maximum PL2 reference clock frequency  | 400  | 400  | 350       | 350  | 300              | 250 <sup>5</sup> | MHz   |
| F <sub>PL3_REFCLK</sub>      | Maximum PL3 reference clock frequency  | 400  | 400  | 350       | 350  | 300              | 250 <sup>5</sup> | MHz   |
| F <sub>PPLL_TO_XPD_CLK</sub> | Maximum PMC PLL to XPD clock frequency   | 1200   | 1200 | 1200      | 1200 | 1000             | 1000             | MHz   |
| F <sub>NPLL_TO_XPD_CLK</sub> | Maximum NoC PLL to XPD clock frequency   | 1200   | 1200 | 1200      | 1200 | 1000             | 1000             | MHz   |

**Notes:**

1. The maximum configuration frame interface (CFI) clock frequency is the same as the CFU reference clock. When the programmable device image (PDI) is compressed, the compressed data rate through the CFU decompressor is limited to half of the CFI data rate.
2. The maximum frequency is 250 MHz for the XCVC1502, XCVC1702, and XQVC1902 devices in the -1L ( $V_{CCINT} = 0.70V$ ) speed grades and for the XCVC1502 and XCVC1702 devices in the -2LLI ( $V_{CCINT}=0.70V$ ) speed grade.
3. When the HSM0 reference clock is used as the source clock to the AI Engine PLL, the frequency range is limited from 27 MHz to 60 MHz.
4. When the HSM1 reference clock is used as the source clock to the XPLL, the frequency range is limited from 100 MHz to 200 MHz.
5. The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum PL0, PL1, PL2, and PL3 reference clock frequency is 280 MHz when  $V_{CC\_PMC} = 0.88V$ .



**Table 33: PMC PLL Switching Characteristics**

| Symbol           | Description              | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_PMC}$ ) |      |           |      |           |                   | Units        |
|------------------|--------------------------|--|------|-----------|------|-----------|-------------------|--------------|
|                  |                          | 0.88V (H)  |      | 0.80V (M) |      | 0.70V (L) |                   |              |
|                  |                          | -3   | -2   | -2        | -1   | -2        | -1                |              |
| $F_{PMCPLL}$     | PMC PLL output frequency | 2000   | 2000 | 1800      | 1600 | 1300      | 1300 <sup>1</sup> | MHz, Max     |
|                  |                          | 270  | 270  | 270       | 270  | 270       | 270               | MHz, Min     |
| $F_{PMCPLLVCO}$  | PMC PLL VCO frequency    | 4320   | 4320 | 4320      | 4320 | 4320      | 4320              | MHz, Max     |
|                  |                          | 2160   | 2160 | 2160      | 2160 | 2160      | 2160              | MHz, Min     |
| $T_{PMCPLLLOCK}$ | PMC PLL lock time        | 100  | 100  | 100       | 100  | 100       | 100               | $\mu$ s, Max |

**Notes:**

- The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum reference clock frequency is 1600 MHz when  $V_{CC\_PMC} = 0.88V$ .

**Table 34: NoC PLL Switching Characteristics**

| Symbol           | Description              | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_PMC}$ ) |      |           |      |           |      | Units        |
|------------------|--------------------------|--|------|-----------|------|-----------|------|--------------|
|                  |                          | 0.88V (H)  |      | 0.80V (M) |      | 0.70V (L) |      |              |
|                  |                          | -3   | -2   | -2        | -1   | -2        | -1   |              |
| $F_{NOCPLL}$     | NoC PLL output frequency | 2000   | 2000 | 1800      | 1600 | 1300      | 1300 | MHz, Max     |
|                  |                          | 270  | 270  | 270       | 270  | 270       | 270  | MHz, Min     |
| $F_{NOCPLLVCO}$  | NoC PLL VCO frequency    | 4320   | 4320 | 4320      | 4320 | 4320      | 4320 | MHz, Max     |
|                  |                          | 2160   | 2160 | 2160      | 2160 | 2160      | 2160 | MHz, Min     |
| $T_{NOCPLLLOCK}$ | NoC PLL lock time        | 100  | 100  | 100       | 100  | 100       | 100  | $\mu$ s, Max |

**Table 35: PS APU PLL Switching Characteristics**

| Symbol           | Description              | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_PSFP}$ ) |      |           |      |           |                   | Units        |
|------------------|--------------------------|---|------|-----------|------|-----------|-------------------|--------------|
|                  |                          | 0.88V (H)   |      | 0.80V (M) |      | 0.70V (L) |                   |              |
|                  |                          | -3  | -2   | -2        | -1   | -2        | -1                |              |
| $F_{PSAPLL}$     | APU PLL output frequency | 2000  | 2000 | 1800      | 1600 | 1300      | 1300 <sup>1</sup> | MHz, Max     |
|                  |                          | 270   | 270  | 270       | 270  | 270       | 270               | MHz, Min     |
| $F_{PSAPLLVCO}$  | APU PLL VCO frequency    | 4320  | 4320 | 4320      | 4320 | 4320      | 4320              | MHz, Max     |
|                  |                          | 2160  | 2160 | 2160      | 2160 | 2160      | 2160              | MHz, Min     |
| $T_{PSAPLLLOCK}$ | APU PLL lock time        | 100   | 100  | 100       | 100  | 100       | 100               | $\mu$ s, Max |

**Notes:**

- The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum reference clock frequency is 1600 MHz when  $V_{CC\_PSFP} = 0.88V$ .

**Table 36: PS RPU PLL Switching Characteristics**

| Symbol                  | Description              | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_PSLP}$ ) |      |           |      |           |                   | Units    |
|-------------------------|--------------------------|---|------|-----------|------|-----------|-------------------|----------|
|                         |                          | 0.88V (H)   |      | 0.80V (M) |      | 0.70V (L) |                   |          |
|                         |                          | -3  | -2   | -2        | -1   | -2        | -1                |          |
| F <sub>PSRPLL</sub>     | RPU PLL output frequency | 2000  | 2000 | 1800      | 1600 | 1300      | 1300 <sup>1</sup> | MHz, Max |
|                         |                          | 270   | 270  | 270       | 270  | 270       | 270               | MHz, Min |
| F <sub>PSRPLLVCO</sub>  | RPU PLL VCO frequency    | 4320  | 4320 | 4320      | 4320 | 4320      | 4320              | MHz, Max |
|                         |                          | 2160  | 2160 | 2160      | 2160 | 2160      | 2160              | MHz, Min |
| T <sub>PSRPLLLOCK</sub> | RPU PLL lock time        | 100   | 100  | 100       | 100  | 100       | 100               | μs, Max  |

**Notes:**

- The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum reference clock frequency is 1600 MHz when  $V_{CC\_PSLP} = 0.88V$ .

**Table 37: CPM4 PLL Switching Characteristics**

| Symbol                   | Description               | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_INT}$ ) |      |           |      |           |      | Units    |
|--------------------------|---------------------------|--|------|-----------|------|-----------|------|----------|
|                          |                           | 0.88V (H)  |      | 0.80V (M) |      | 0.70V (L) |      |          |
|                          |                           | -3   | -2   | -2        | -1   | -2        | -1   |          |
| F <sub>CPM4PLL</sub>     | CPM4 PLL output frequency | 1200   | 1080 | 900       | 900  | 810       | 720  | MHz, Max |
|                          |                           | 270  | 270  | 270       | 270  | 270       | 270  | MHz, Min |
| F <sub>CPM4PLLVCO</sub>  | CPM4 PLL VCO frequency    | 4320   | 4320 | 4320      | 4320 | 4320      | 4320 | MHz, Max |
|                          |                           | 2160   | 2160 | 2160      | 2160 | 2160      | 2160 | MHz, Min |
| T <sub>CPM4PLLLOCK</sub> | CPM4 PLL lock time        | 100  | 100  | 100       | 100  | 100       | 100  | μs, Max  |

**Table 38: CPM5 PLL Switching Characteristics**

| Symbol                   | Description               | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_CPM5}$ ) |           |      |           |      | Units    |
|--------------------------|---------------------------|---|-----------|------|-----------|------|----------|
|                          |                           | 0.88V (H)   | 0.80V (M) |      | 0.70V (L) |      |          |
|                          |                           | -3  | -2        | -1   | -2        | -1   |          |
| F <sub>CPM5PLL</sub>     | CPM5 PLL output frequency | 1200  | 900       | 900  | 725       | 725  | MHz, Max |
|                          |                           | 270   | 270       | 270  | 270       | 270  | MHz, Min |
| F <sub>CPM5PLLVCO</sub>  | CPM5 PLL VCO frequency    | 4320  | 4320      | 4320 | 4320      | 4320 | MHz, Max |
|                          |                           | 2160  | 2160      | 2160 | 2160      | 2160 | MHz, Min |
| T <sub>CPM5PLLLOCK</sub> | CPM5 PLL lock time        | 100   | 100       | 100  | 100       | 100  | μs, Max  |

## PMC JTAG and SelectMAP

Table 39: JTAG/Boundary-Scan Port Switching Characteristics

| Symbol                  | Description                    | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CCINT}$ ) |         |           |         |           |         | Units    |
|-------------------------|--------------------------------|--|---------|-----------|---------|-----------|---------|----------|
|                         |                                | 0.88V (H)  |         | 0.80V (M) |         | 0.70V (L) |         |          |
|                         |                                | -3   | -2      | -2        | -1      | -2        | -1      |          |
| $F_{TCK}$               | JTAG clock frequency           | 70   | 70      | 70        | 70      | 60        | 60      | MHz, Max |
| $T_{TCKL}$              | TCK Low pulse time             | 5.5  | 5.5     | 5.5       | 5.5     | 6.0       | 6.0     | ns, Min  |
| $T_{TCKH}$              | TCK High pulse time            | 2.0  | 2.0     | 2.0       | 2.0     | 2.0       | 2.0     | ns, Min  |
| $T_{TAPTCK}/T_{TCKTAP}$ | TMS and TDI setup and hold     | 3.0/2.0  | 3.0/2.0 | 3.0/2.0   | 3.0/2.0 | 3.0/2.0   | 3.0/2.0 | ns, Min  |
| $T_{TCKTDO}$            | TCK falling edge to TDO output | 5.5  | 5.5     | 5.5       | 5.5     | 6.0       | 6.0     | ns, Max  |

Table 40: SelectMap Interface Switching Characteristics

| Symbol                    | Description   | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CCINT}$ ) |         |           |         |           |         | Units             |
|---------------------------|---|--|---------|-----------|---------|-----------|---------|-------------------|
|                           |   | 0.88V (H)  |         | 0.80V (M) |         | 0.70V (L) |         |                   |
|                           |   | -3   | -2      | -2        | -1      | -2        | -1      |                   |
| $F_{SMAPCLK}$             | SelectMap clock frequency, write                    | 200  | 200     | 200       | 200     | 200       | 200     | MHz, Max          |
|                           | SelectMap clock frequency, read                     | 120  | 120     | 120       | 120     | 120       | 120     | MHz, Max          |
| $T_{SMAPCLKL}$            | SelectMAP clock Low time                            | 2.5  | 2.5     | 2.5       | 2.5     | 2.5       | 2.5     | ns, Min           |
| $T_{SMAPCLKH}$            | SelectMAP clock High time                           | 2.5  | 2.5     | 2.5       | 2.5     | 2.5       | 2.5     | ns, Min           |
| $T_{SMAPDCLK}/SMAPCLKD$   | SelectMAP data (SMAP_IO[31:0]) setup and hold       | 3.0/0.0  | 3.0/0.0 | 3.0/0.0   | 3.0/0.0 | 4.5/0.0   | 4.5/0.0 | ns, Min           |
| $T_{SMAPCSCLK}/SMAPCLKCS$ | SelectMAP chip select (SMAP_CS_b) setup and hold    | 3.0/0.0  | 3.0/0.0 | 3.0/0.0   | 3.0/0.0 | 4.0/0.0   | 4.0/0.0 | ns, Min           |
| $T_{SMAPRWCLK}/SMAPCLKRW$ | SelectMAP read write (SMAP_RDWR_b) setup and hold   | 3.0/0.0  | 3.0/0.0 | 3.0/0.0   | 3.0/0.0 | 4.0/0.0   | 4.0/0.0 | ns, Min           |
| $T_{SMAPCLKO}$            | SelectMAP clock to data output                      | 13.0   | 13.0    | 13.0      | 13.0    | 13.0      | 13.0    | ns, Max           |
| $C_{SMAPBUSYCS}$          | SelectMAP busy assertion to chip select deassertion | 24   | 24      | 24        | 24      | 24        | 24      | clock cycles, Max |

## PS and PMC Interface Specifications

### PMC Quad-SPI Controller Interface

Table 41: Quad-SPI Interface

| Symbol  | Description <sup>1, 2</sup>             | Min                       | Max  | Units |
|---|---|---------------------------|------|-------|
| <b>Quad-SPI device clock frequency operating at &gt;100 MHz up to 150 MHz. Loopback enabled.<sup>3</sup></b>  |   |                           |      |       |
| F <sub>QSPI_CLK</sub>   | Quad-SPI device clock frequency         | 100                       | 150  | MHz   |
| F <sub>QSPI_REFCLK</sub> <sup>4</sup>   | Quad-SPI reference clock frequency      | 2 × F <sub>QSPI_CLK</sub> |      | MHz   |
| T <sub>QSPIDCK</sub>  | Setup time, all inputs                  | 0.77                      | –    | ns    |
| T <sub>QSPICKD</sub>  | Hold time, all inputs                   | 1.0                       | –    | ns    |
| T <sub>QSPICKO</sub>  | Clock to output delay, all outputs      | 2.9                       | 4.5  | ns    |
| T <sub>QSPICCLK</sub> <sup>5</sup>  | Chip select asserted to next clock edge | 5.0                       | –    | ns    |
| T <sub>QSPICLKCS</sub>  | Clock edge to chip select deasserted    | 5.0                       | –    | ns    |
| T <sub>DCQSPICLK</sub>  | Quad-SPI clock duty cycle               | 45                        | 55   | %     |
| <b>Quad-SPI device clock frequency operating at &gt;37.5 MHz up to 100 MHz. Loopback enabled.<sup>3</sup></b> |   |                           |      |       |
| F <sub>QSPI_CLK</sub>   | Quad-SPI device clock frequency         | 37.5                      | 100  | MHz   |
| F <sub>QSPI_REFCLK</sub> <sup>4</sup>   | Quad-SPI reference clock frequency      | 2 × F <sub>QSPI_CLK</sub> |      | MHz   |
| T <sub>QSPIDCK</sub>  | Setup time, all inputs                  | 2.0                       | –    | ns    |
| T <sub>QSPICKD</sub>  | Hold time, all inputs                   | 0.0                       | –    | ns    |
| T <sub>QSPICKO</sub>  | Clock to output delay, all outputs      | 3.2                       | 7.8  | ns    |
| T <sub>QSPICCLK</sub> <sup>5</sup>  | Chip select asserted to next clock edge | 5.0                       | –    | ns    |
| T <sub>QSPICLKCS</sub>  | Clock edge to chip select deasserted    | 5.0                       | –    | ns    |
| T <sub>DCQSPICLK</sub>  | Quad-SPI clock duty cycle               | 45                        | 55   | %     |
| <b>Quad-SPI device clock frequency operating at ≤37.5 MHz. Loopback disabled.</b>                             |   |                           |      |       |
| F <sub>QSPI_CLK</sub>   | Quad-SPI device clock frequency         |                           | 37.5 | MHz   |
| F <sub>QSPI_REFCLK</sub> <sup>4</sup>   | Quad-SPI reference clock frequency      |                           | 150  | MHz   |
| T <sub>QSPIDCK</sub>  | Setup time, all inputs                  | 19.1                      | –    | ns    |
| T <sub>QSPICKD</sub>  | Hold time, all inputs                   | 0.0                       | –    | ns    |
| T <sub>QSPICKO</sub>  | Clock to output delay, all outputs      | 5.2                       | 21.5 | ns    |
| T <sub>QSPICCLK</sub>   | Chip select asserted to next clock edge | 9.0                       | –    | ns    |
| T <sub>QSPICLKCS</sub> <sup>5</sup>   | Clock edge to chip select deasserted    | 9.0                       | –    | ns    |
| T <sub>DCQSPICLK</sub>  | Quad-SPI clock duty cycle               | 45                        | 55   | %     |

**Notes:**

1. The test conditions are configured for the generic Quad-SPI interface with a 12 mA drive strength, fast slew rate, and load conditions (15 pF/30 pF for a Quad-SPI device clock frequency up to 100 MHz and 15 pF for a Quad-SPI device clock frequency > 100 MHz), tested at 3.3V and 1.8V.
2. 30 pF loads are for QSPI dual-stacked or QSPI dual-parallel modes.
3. When the Quad-SPI device clock frequency is >37.5 MHz, the Quad-SPI loopback clock output (QSPI\_LPBK\_CLK) must be enabled in the control, interface, and processing system (CIPS), and the associated MIO[6] pin must be left unconnected on the board.
4. The Quad-SPI reference clock frequency must be 2x the Quad-SPI device clock frequency when it is >37.5 MHz.
5. T<sub>QSPICCLK</sub> is only valid when two reference clock cycles are programmed between the chip select and clock.

## PMC Octal-SPI Controller Interface

Table 42: Octal-SPI Interface

| Symbol   | Description <sup>1</sup>                | Min                                  | Max              | Units |
|--|---|--------------------------------------|------------------|-------|
| <b>Octal-SPI device clock frequency operating at DDR 50 MHz up to 200 MHz.</b> |   |                                      |                  |       |
| F <sub>OSPI_CLK</sub>  | Octal-SPI device clock frequency        | 50                                   | 200 <sup>1</sup> | MHz   |
| F <sub>OSPI_REFCLK</sub>   | Octal-SPI reference clock frequency     | = F <sub>OSPI_CLK</sub> <sup>2</sup> |                  | MHz   |
| T <sub>OSPI200IVW</sub>  | Input valid data window                 | 0.5                                  | -                | UI    |
| T <sub>OSPICKO</sub>   | Clock to output delay, all outputs      | 0.6                                  | 1.9              | ns    |
| T <sub>OSPICSCLK</sub>   | Chip select asserted to next clock edge | 3.375                                | -                | ns    |
| T <sub>OSPICLKCS</sub>   | Clock edge to chip select deasserted    | 3.375                                | -                | ns    |
| T <sub>OSPIDCCCLK</sub>  | Octal-SPI clock duty cycle              | 45                                   | 55               | %     |
| <b>Octal-SPI device clock frequency operating at SDR 50 MHz to 166 MHz.</b>    |   |                                      |                  |       |
| F <sub>OSPI_CLK</sub>  | Octal-SPI device clock frequency        | 50                                   | 166              | MHz   |
| F <sub>OSPI_REFCLK</sub>   | Octal-SPI reference clock frequency     | = F <sub>OSPI_CLK</sub> <sup>2</sup> |                  | MHz   |
| T <sub>OSPI166IVW</sub>  | Input valid data window                 | 0.4                                  | -                | UI    |
| T <sub>OSPICKO</sub>   | Clock to output delay, all outputs      | 1.8                                  | 3.9              | ns    |
| T <sub>OSPICSCLK</sub>   | Chip select asserted to next clock edge | 3.375                                | -                | ns    |
| T <sub>OSPICLKCS</sub>   | Clock edge to chip select deasserted    | 3.375                                | -                | ns    |
| T <sub>OSPIDCCCLK</sub>  | Octal-SPI clock duty cycle              | 45                                   | 55               | %     |
| <b>Octal-SPI device clock frequency operating at SDR &lt;50 MHz.</b>           |   |                                      |                  |       |
| F <sub>OSPI_CLK</sub>  | Octal-SPI device clock frequency        | -                                    | 50               | MHz   |
| F <sub>OSPI_REFCLK</sub>   | Octal-SPI reference clock frequency     | 4 × F <sub>OSPI_CLK</sub>            | 200              | MHz   |
| T <sub>OSPIDCK</sub>   | Setup time, all inputs                  | 11                                   | -                | ns    |
| T <sub>OSPICKD</sub>   | Hold time, all inputs                   | 1.0                                  | -                | ns    |
| T <sub>OSPICKO</sub>   | Clock to output delay, all outputs      | 2.0                                  | 18               | ns    |
| T <sub>OSPICSCLK</sub>   | Chip select asserted to next clock edge | 3.375                                | -                | ns    |
| T <sub>OSPICLKCS</sub>   | Clock edge to chip select deasserted    | 3.375                                | -                | ns    |
| T <sub>OSPIDCCCLK</sub>  | Octal-SPI clock duty cycle              | 45                                   | 55               | %     |

**Notes:**

- The test conditions are configured for the Octal-SPI interface with a 12 mA drive strength, fast slew rate, and 12 pF load. The maximum Octal-SPI device clock frequency under different load conditions are 166 MHz for a 20 pF load and 100 MHz for a 40 pF load.
- The Octal-SPI reference clock frequency must be equal to F<sub>OSPI\_CLK</sub> when the Octal-SPI device clock frequency is ≥50 MHz.

## PS SPI Controller Interface

Table 43: SPI Controller Interface

| Symbol                      | Description <sup>1</sup>                                       | Min | Max | Units             |
|-----------------------------|--|-----|-----|-------------------|
| <b>SPI Master Interface</b> |  |     |     |                   |
| F <sub>MSPi_CLK</sub>       | SPI master device clock frequency (MIO)                        | -   | 50  | MHz               |
|                             | SPI master device clock frequency (EMIO)                       | -   | 25  | MHz               |
| F <sub>SPI_REFCLK</sub>     | SPI reference clock frequency                                  | -   | 200 | MHz               |
| T <sub>DCMSPiCLK</sub>      | SPI master mode clock duty cycle                               | 45  | 55  | %                 |
| T <sub>MSPiSSCLK</sub>      | Master select asserted to first active clock edge <sup>2</sup> | 1   | -   | SPI_REFCLK cycles |

Table 43: SPI Controller Interface (cont'd)

| Symbol                     | Description <sup>1</sup>                                       | Min  | Max | Units             |
|----------------------------|--|------|-----|-------------------|
| T <sub>MSPISCLKSS</sub>    | Last active clock edge to slave select deasserted <sup>2</sup> | 1    | -   | SPI_REFCLK cycles |
| T <sub>MSPIDCK</sub>       | Input setup time for master in/slave out (MISO)                | 9.9  | -   | ns                |
| T <sub>MSPICKD</sub>       | Input hold time for MISO                                       | 0.0  | -   | ns                |
| T <sub>MSPICKO</sub>       | Master out/slave in (MOSI) and slave select clock-to-out delay | -3.7 | 5.0 | ns                |
| <b>SPI Slave Interface</b> |  |      |     |                   |
| F <sub>SSPI_CLK</sub>      | SPI slave device clock frequency                               | -    | 25  | MHz               |
| F <sub>SPI_REFCLK</sub>    | SPI reference clock frequency                                  | -    | 200 | MHz               |
| T <sub>SSPISSECLK</sub>    | Slave select asserted to first active clock edge               | 1    | -   | SPI_REFCLK cycles |
| T <sub>SSPISCLKSS</sub>    | Last active clock edge to slave select deasserted              | 1    | -   | SPI_REFCLK cycles |
| T <sub>SSPIDCK</sub>       | Input setup time for MISO                                      | 5.0  | -   | ns                |
| T <sub>SSPICKD</sub>       | Input hold time for MISO                                       | 5.0  | -   | ns                |
| T <sub>SSPICKO</sub>       | MOSI clock-to-out delay  | 0.0  | 13  | ns                |

**Notes:**

1. The test conditions are configured to the LVCMOS 3.3V I/O standard with a 12 mA drive strength, fast slew rate, and 15 pF load.
2. The test conditions use the SPI delay register where XSPIPS\_DR\_OFFSET[xspips\_dr\_init\_mask] = 2 and XSPIPS\_DR\_OFFSET[xspips\_dr\_after\_mask] = 2.

## PS USB Controller Interface

Table 44: ULPI Interface

| Symbol               | Description <sup>1</sup>                | Min | Max | Units |
|----------------------|---|-----|-----|-------|
| T <sub>ULPIDCK</sub> | Input setup to ULPI clock, all inputs   | 4.5 | -   | ns    |
| T <sub>ULPICKD</sub> | Input hold to ULPI clock, all inputs    | 0.5 | -   | ns    |
| T <sub>ULPICKO</sub> | ULPI clock to output valid, all outputs | 2.0 | 8.9 | ns    |
| F <sub>ULPICLK</sub> | ULPI clock frequency                    | -   | 60  | MHz   |

**Notes:**

1. The test conditions are configured to the LVCMOS 3.3V I/O standard with a 12 mA drive strength, fast slew rate, and a 15 pF load.

## PS Gigabit Ethernet MAC Controller Interface

Table 45: RGMII Interface

| Symbol                    | Description <sup>1</sup>                                       | Min  | Max  | Units |
|---------------------------|--|------|------|-------|
| F <sub>GEMTXCLK</sub>     | RGMII_TX_CLK transmit clock frequency                          | -    | 125  | MHz   |
| F <sub>GEMRXCLK</sub>     | RGMII_RX_CLK receive clock frequency                           | -    | 125  | MHz   |
| F <sub>GEMREFCLK</sub>    | Gigabit Ethernet MAC (GEM) reference clock frequency           | -    | 125  | MHz   |
| F <sub>GEMTSUREFCLK</sub> | Gigabit Ethernet MAC time-stamp unit reference clock frequency | -    | 250  | MHz   |
| T <sub>DCGEMTXCLK</sub>   | Transmit clock duty cycle                                      | 45   | 55   | %     |
| T <sub>GEMTXCKO</sub>     | TXD output clock to out time                                   | -0.5 | 0.5  | ns    |
| T <sub>GEMRXDCK</sub>     | RXD input setup time   | 0.8  | -    | ns    |
| T <sub>GEMRXCKD</sub>     | RXD input hold time  | 0.8  | -    | ns    |
| T <sub>MDIOCLK</sub>      | MDC output clock period  | 400  | -    | ns    |
| T <sub>MDIOCKL</sub>      | MDC Low time   | 160  | -    | ns    |
| T <sub>MDIOCKH</sub>      | MDC High time  | 160  | -    | ns    |
| T <sub>MDIODCK</sub>      | MDIO input data setup time                                     | 80   | -    | ns    |
| T <sub>MDIOCKD</sub>      | MDIO input data hold time                                      | 0.0  | -    | ns    |
| T <sub>MDIOCKO</sub>      | MDIO output data delay time                                    | -3.0 | 15.0 | ns    |

**Notes:**

- The test conditions are configured to the LVCMOS 3.3V I/O standard with a 12 mA drive strength, fast slew rate, and a 15 pF load.

## PMC SD/SDIO Controller Interface

Table 46: SD/SDIO Interface

| Symbol                                      | Description <sup>1</sup>               | Min  | Max  | Units |
|---|--|------|------|-------|
| F <sub>SD_REFCLK</sub>                      | SD reference clock frequency           | -    | 200  | MHz   |
| F <sub>SDDLL_REFCLK</sub>                   | SD DLL reference clock frequency       | -    | 1200 | MHz   |
| <b>SD/SDIO Interface Default Speed Mode</b> |  |      |      |       |
| F <sub>SDFS_CLK</sub> <sup>2</sup>          | SD standard device clock frequency     | -    | 20   | MHz   |
| F <sub>SDID_CLK</sub>                       | Clock frequency in identification mode | -    | 400  | kHz   |
| T <sub>SDDC_CLK</sub>                       | SD standard device clock duty cycle    | 45   | 55   | %     |
| T <sub>SDCKO</sub>                          | Clock to output delay, all outputs     | -2.0 | 4.5  | ns    |
| <b>SD/SDIO Interface High-speed Mode</b>    |  |      |      |       |
| F <sub>SDHS_CLK</sub>                       | SD high-speed device clock frequency   | 25   | 50   | MHz   |
| T <sub>SDHSDC_CLK</sub>                     | SD high-speed device clock duty cycle  | 45   | 55   | %     |
| T <sub>SDHSCKO</sub>                        | Clock to output delay, all outputs     | 2.2  | 13.8 | ns    |
| T <sub>SDHSDIVW</sub>                       | Input valid data window                | 0.4  | -    | UI    |
| <b>SD/SDIO Interface SDR12 Mode</b>         |  |      |      |       |
| F <sub>SDDSR12_CLK</sub> <sup>2</sup>       | SD SDR12 device clock frequency        | -    | 25   | MHz   |
| T <sub>DCSDSR12_CLK</sub>                   | SD SDR12 device clock duty cycle       | 30   | 70   | %     |
| T <sub>SDDSR12CKO</sub>                     | Clock to output delay, all outputs     | 1.0  | 36.8 | ns    |
| T <sub>SDDSR12DCK</sub>                     | Input setup time, all inputs           | 24.0 | -    | ns    |
| T <sub>SDDSR12CKD</sub>                     | Input hold time, all inputs            | 1.5  | -    | ns    |

Table 46: SD/SDIO Interface (cont'd)

| Symbol   | Description <sup>1</sup>               | Min | Max  | Units |
|--|--|-----|------|-------|
| <b>SD/SDIO Interface SDR25/SDR50 Mode</b>          |  |     |      |       |
| F <sub>S<sub>SD</sub>SDR_CLK</sub>                 | SDR25 device clock frequency           | 25  | 50   | MHz   |
|  | SDR50 device clock frequency           | 25  | 100  | MHz   |
| T <sub>S<sub>SD</sub>SDRDC_CLK</sub>               | SD SDR50/SDR25 device clock duty cycle | 30  | 70   | %     |
| T <sub>S<sub>SD</sub>SDRCKO</sub>                  | Clock to output delay, all outputs     | 1.0 | 6.8  | ns    |
| T <sub>S<sub>DD</sub>DRCKD</sub>                   | Input valid data window                | 0.4 | -    | UI    |
| <b>SD/SDIO Interface SDR104 Mode</b>               |  |     |      |       |
| F <sub>S<sub>SD</sub>SDR104_CLK</sub>              | SDR104 device clock frequency          | 25  | 200  | MHz   |
| T <sub>DC<sub>S<sub>SD</sub>SDR104_CLK</sub></sub> | SD SDR104 device clock duty cycle      | 30  | 70   | %     |
| T <sub>S<sub>SD</sub>SDR104CKO</sub>               | Clock to output delay, all outputs     | 1.0 | 3.2  | ns    |
| T <sub>S<sub>SD</sub>SDR104CKD</sub>               | Input valid data window                | 0.5 | -    | UI    |
| <b>SD/SDIO Interface DDR50 Mode</b>                |  |     |      |       |
| F <sub>S<sub>DD</sub>DR_CLK</sub>                  | SD DDR50 device clock frequency        | 25  | 50   | MHz   |
| T <sub>DC<sub>S<sub>DD</sub>DDR_CLK</sub></sub>    | SD DDR50 device clock duty cycle       | 45  | 55   | %     |
| T <sub>S<sub>DD</sub>DRCKO</sub>                   | Clock to output delay, data            | 1.0 | 6.8  | ns    |
| T <sub>S<sub>DD</sub>DRDCK</sub>                   | Input valid data window                | 0.5 | -    | UI    |
| T <sub>S<sub>DD</sub>DRCKD</sub>                   | Input setup time, command              | 4.7 | -    | ns    |
| T <sub>S<sub>DD</sub>DRIDCLK</sub>                 | Input hold time, command               | 1.5 | -    | ns    |
| T <sub>S<sub>DD</sub>DRCLK</sub>                   | Clock to output delay, command         | 1.0 | 13.8 | ns    |

**Notes:**

- The test condition settings for SD/SDIO modes are: 12 mA drive strength, fast slew rate, and a 15 pF load. The OTAP delay (OTAP\_DLY[5:0]) test condition settings are: SD high-speed mode = 0x04, SD SDR25/50 mode = 0x03, SD SDR104 mode = 0x02, and SD DDR50 mode = 0x03.
- EMIO is supported in SD default speed mode and SDR12 mode.

## PMC eMMC Controller Interface

Table 47: eMMC Controller Interface

| Symbol                                    | Description <sup>1</sup>                          | Min  | Max  | Units |
|---|---|------|------|-------|
| <b>eMMC Interface Standard Mode</b>       |   |      |      |       |
| F <sub>EMMCCLK</sub>                      | eMMC standard device clock frequency <sup>2</sup> | -    | 25   | MHz   |
| T <sub>DC<sub>EMMCCLK</sub></sub>         | eMMC clock duty cycle                             | 45   | 55   | %     |
| T <sub>EMMCCKO</sub>                      | Clock to output delay, all outputs                | -2.0 | 4.5  | ns    |
| <b>eMMC Interface High-speed SDR Mode</b> |   |      |      |       |
| F <sub>EMMCSDRCLK</sub>                   | eMMC high-speed SDR device clock frequency        | 25   | 50   | MHz   |
| T <sub>DC<sub>EMMCSDRCLK</sub></sub>      | eMMC high-speed SDR clock duty cycle              | 45   | 55   | %     |
| T <sub>EMMCSDRCKO</sub>                   | Clock to output delay, all outputs <sup>3</sup>   | 3.2  | 16.8 | ns    |
| T <sub>EMMCSDRDIW</sub>                   | Input valid data window <sup>4</sup>              | 0.4  | -    | UI    |
| <b>eMMC Interface High-speed DDR Mode</b> |   |      |      |       |
| F <sub>EMMCDDRCLK</sub>                   | eMMC high-speed DDR device clock frequency        | 25   | 50   | MHz   |
| T <sub>DC<sub>EMMCDDRCLK</sub></sub>      | eMMC high-speed DDR clock duty cycle              | 45   | 55   | %     |
| T <sub>EMMCDDRCKO1</sub>                  | Data clock to output delay <sup>3</sup>           | 2.7  | 7.3  | ns    |



Table 47: eMMC Controller Interface (cont'd)

| Symbol                           | Description <sup>1</sup>                        | Min  | Max | Units |
|----------------------------------|---|------|-----|-------|
| T <sub>EMMCDDRDIW</sub>          | Input valid data window <sup>4</sup>            | 0.35 | -   | UI    |
| T <sub>EMMCDDRCKO2</sub>         | Command clock to output delay                   | 3.2  | 16  | ns    |
| T <sub>EMMCDDRCK2</sub>          | Command input setup time                        | 3.9  | -   | ns    |
| T <sub>EMMCDDRCKD2</sub>         | Command input hold time                         | 2.5  | -   | ns    |
| <b>eMMC Interface HS200 Mode</b> |   |      |     |       |
| F <sub>EMMCHS200CLK</sub>        | eMMC HS200 device clock frequency               | 25   | 200 | MHz   |
| T <sub>DCEMMCHS200CLK</sub>      | eMMC HS200 clock duty cycle                     | 30   | 70  | %     |
| T <sub>EMMCHS200CKO</sub>        | Clock to output delay, all outputs <sup>3</sup> | 1.0  | 3.4 | ns    |
| T <sub>EMMCHS200DIW</sub>        | Input valid data window <sup>4</sup>            | 0.5  | -   | UI    |

**Notes:**

1. The test condition settings for the eMMC modes are: 12 mA drive strength, fast slew rate, and a 15 pF load. The OTAP delay (OTAP\_DLY[5:0]) test condition settings are: eMMC high-speed SDR mode = 0x05, eMMC high-speed DDR mode = 0x05, and eMMC HS200 mode = 0x02.
2. EMIO is supported in the eMMC standard mode.
3. This specification is achieved using predetermined DLL tuning.
4. This specification is required for capturing input data using DLL tuning.

## PS and PMC I2C Controller Interface

Table 48: I2C Controller Interface

| Symbol                               | Description <sup>1</sup>                  | Min | Max  | Units |
|--------------------------------------|---|-----|------|-------|
| <b>I2C Fast-mode Interface</b>       |   |     |      |       |
| F <sub>I2CF_CLK</sub>                | Serial clock line (SCL) clock frequency   | -   | 400  | kHz   |
| F <sub>I2C_REFCLK</sub> <sup>2</sup> | I2C reference clock frequency             | -   | 100  | MHz   |
| T <sub>I2CFCKL</sub>                 | SCL Low time                              | 1.3 | -    | µs    |
| T <sub>I2CFCKH</sub>                 | SCL High time                             | 0.6 | -    | µs    |
| T <sub>I2CFCKO</sub>                 | Serial data line (SDA) clock-to-out delay | -   | 900  | ns    |
| T <sub>I2CFDCK</sub>                 | SDA input setup time                      | 100 | -    | ns    |
| T <sub>I2CFCKD</sub>                 | SDA input data hold time                  | 0   | -    | ns    |
| <b>I2C Standard-mode Interface</b>   |   |     |      |       |
| F <sub>I2CS_CLK</sub>                | SCL clock frequency                       | -   | 100  | kHz   |
| F <sub>I2C_REFCLK</sub> <sup>2</sup> | I2C reference clock frequency             | -   | 100  | MHz   |
| T <sub>I2CSCKL</sub>                 | SCL Low time                              | 4.7 | -    | µs    |
| T <sub>I2CSCKH</sub>                 | SCL High time                             | 4.0 | -    | µs    |
| T <sub>I2CSCKO</sub>                 | SDA clock-to-out delay                    | -   | 3450 | ns    |
| T <sub>I2CSDCK</sub>                 | SDA input setup time                      | 250 | -    | ns    |
| T <sub>I2CSCKD</sub>                 | SDA input data hold time                  | 0   | -    | ns    |

**Notes:**

1. The test conditions are configured to the LVCMOS 3.3V I/O standard with a 12 mA drive strength, fast slew rate, and a 15 pF load.
2. F<sub>I2C\_REFCLK</sub> specification applies to PMC\_I2C\_REFCLK, LPD\_I2C0\_REFCLK, LPD\_I2C1\_REFCLK, and SYSMON\_I2C\_REFCLK.

## PS CAN FD Controller Interface

Table 49: CAN FD Controller Interface

| Symbol                                  | Description <sup>1</sup>            | Min | Max | Units |
|---|-------------------------------------|-----|-----|-------|
| F <sub>CAN_FD_REFCLK</sub> <sup>2</sup> | CAN FD reference clock frequency 1x | -   | 80  | MHz   |
|   | CAN FD reference clock frequency 2x | -   | 160 | MHz   |
| T <sub>CAN_FD_PWRX</sub>                | Receive pulse width                 | 125 | -   | ns    |
| T <sub>CAN_FD_PWTX</sub>                | Transmit pulse width                | 125 | -   | ns    |

**Notes:**

1. The test conditions are configured to the LVCMOS 3.3V I/O standard with a 12 mA drive strength, fast slew rate, and a 15 pF load.
2. The APB interface (LPD\_LSBUS\_CLK) operating frequency must be greater than or equal to the CAN FD operating frequency (which is the CAN\_FD\_REFCLK frequency divided by the CAN[0|1]\_REF\_CTRL[DIVISOR]).

## PS UART Controller Interface

Table 50: UART Controller Interface

| Symbol                    | Description <sup>1</sup>       | Min | Max  | Units |
|---------------------------|--------------------------------|-----|------|-------|
| F <sub>UART_REF_CLK</sub> | UART reference clock frequency | -   | 100  | MHz   |
| BAUD <sub>TXMAX</sub>     | Transmit baud rate             | -   | 6.25 | Mb/s  |
| BAUD <sub>RXMAX</sub>     | Receive baud rate              | -   | 6.25 | Mb/s  |

**Notes:**

1. The test conditions are configured to the LVCMOS 3.3V I/O standard with a 12 mA drive strength, fast slew rate, and a 15 pF load.

## PS General Purpose I/O Interface

Table 51: General Purpose I/O (GPIO) Interface

| Symbol             | Description <sup>1</sup>        | Min                               | Max | Units |
|--------------------|---------------------------------|-----------------------------------|-----|-------|
| T <sub>GPIOH</sub> | LPD GPIO input High pulse width | $10 \times 1/F_{LPD\_LSBUS\_CLK}$ | -   | μs    |
|                    | PMC GPIO input High pulse width | $10 \times 1/F_{PMC\_LSBUS\_CLK}$ | -   | μs    |
| T <sub>GPIOH</sub> | LPD GPIO input Low pulse width  | $10 \times 1/F_{LPD\_LSBUS\_CLK}$ | -   | μs    |
|                    | PMC GPIO input Low pulse width  | $10 \times 1/F_{PMC\_LSBUS\_CLK}$ | -   | μs    |

**Notes:**

1. The test conditions are configured to the LVCMOS 3.3V I/O standard with a 12 mA drive strength, fast slew rate, and 15 pF load.

## PS Trace Interface

Table 52: Trace Interface

| Symbol                 | Description <sup>1</sup>                 | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CC_PSF</sub> ) |     |      |     |           |     |      |     |           |     |      |                  | Units |
|------------------------|--|---|-----|------|-----|-----------|-----|------|-----|-----------|-----|------|------------------|-------|
|                        |  | 0.88V (H)   |     |      |     | 0.80V (M) |     |      |     | 0.70V (L) |     |      |                  |       |
|                        |  | -3  |     | -2   |     | -2        |     | -1   |     | -2        |     | -1   |                  |       |
|                        |  | Min   | Max | Min  | Max | Min       | Max | Min  | Max | Min       | Max | Min  | Max              |       |
| F <sub>TCECLK</sub>    | Trace clock frequency (MIO)              | -   | 200 | -    | 200 | -         | 200 | -    | 200 | -         | 200 | -    | 167 <sup>2</sup> | MHz   |
|                        | Trace clock frequency (EMIO)             | -   | 400 | -    | 400 | -         | 350 | -    | 350 | -         | 300 | -    | 250 <sup>3</sup> | MHz   |
| F <sub>DBGTCECLK</sub> | Trace debug (DBG_TRACE) clock frequency  | -   | 400 | -    | 400 | -         | 400 | -    | 400 | -         | 400 | -    | 333 <sup>4</sup> | MHz   |
| T <sub>TCECKO</sub>    | Trace clock to output delay, all outputs | -0.5  | 0.5 | -0.5 | 0.5 | -0.5      | 0.5 | -0.5 | 0.5 | -0.5      | 0.5 | -0.5 | 0.5              | ns    |
| T <sub>TCECKO</sub>    | Trace clock duty cycle                   | 45  | 55  | 45   | 55  | 45        | 55  | 45   | 55  | 45        | 55  | 45   | 55               | %     |

**Notes:**

- The test conditions are configured to the LVCMOS 3.3V I/O standard with a 12 mA drive strength, fast slew rate, and a 15 pF load.
- The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum trace clock frequency (MIO) is 200 MHz when V<sub>CC\_PSLP</sub> = 0.88V or V<sub>CC\_PMC</sub> = 0.88V.
- The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum trace clock frequency (EMIO) is 280 MHz when V<sub>CC\_PSF</sub> = 0.88V.
- The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum trace debug clock frequency is 400 MHz when V<sub>CC\_PSF</sub> = 0.88V.

## PS Triple-timer Counter Interface

Table 53: Triple-timer Counter Interface

| Symbol                        | Description   | Min  | Max   | Units |
|-------------------------------|---|--|---|-------|
| F <sub>TTCX_REF_CLK</sub>     | Triple-timer counter input clock frequency (TTCX_REF_CLK) <sup>1</sup>              | -  | See Note 1                                    | MHz   |
| F <sub>TTCX_IO_REF_CLKX</sub> | Triple-timer counter MIO-EMIO input clock frequency (TTCX_IO_REF_CLKX) <sup>2</sup> | -  | 50 <sup>3</sup>                               | MHz   |
| T <sub>TTCICLK</sub>          | Triple-timer counter MIO-EMIO input clock High pulse width                          | 2/F <sub>TTCX_IO_REF_CLKX</sub> <sup>2</sup> | -   | µs    |
|                               | Triple-timer counter MIO-EMIO input clock Low pulse width                           | 2/F <sub>TTCX_IO_REF_CLKX</sub> <sup>2</sup> | -   | µs    |
| F <sub>TTCICLK</sub>          | Triple-timer counter output clock frequency   | -  | F <sub>TTCX_REF_CLK</sub> /2 <sup>1</sup>     | MHz   |
|                               |   |  | F <sub>TTCX_IO_REF_CLKX</sub> /2 <sup>2</sup> | MHz   |
| T <sub>TTCOCLK</sub>          | Triple-timer counter output clock period  | 2/F <sub>TTCX_REF_CLK</sub> <sup>1</sup>     | -   | µs    |
|                               |   | 2/F <sub>TTCX_IO_REF_CLKX</sub> <sup>2</sup> | -   | µs    |

**Notes:**

- TTCX\_REF\_CLK source is used. TTCX\_REF\_CLK source can be the REF\_CLK (F<sub>REFCLK</sub>), LPD\_LSBUS\_CLK (F<sub>LPD\_LSBUS\_CLK</sub>), or the RPU\_REF\_CLK (F<sub>RPU\_MAX</sub>).
- TTCX\_IO\_REF\_CLKX source is used. TTCX\_IO\_REF\_CLKX source can be MIO or EMIO.
- The maximum F<sub>TTCX\_IO\_REF\_CLKX</sub> is the lesser of the specified maximum F<sub>TTCX\_IO\_REF\_CLKX</sub> or F<sub>TTCX\_REF\_CLK</sub>/2.

## PS System Watchdog Timer Interface

Table 54: System Watchdog Timer Interface

| Symbol               | Description                                 | Min | Max | Units |
|----------------------|---|-----|-----|-------|
| F <sub>SWDTCLK</sub> | System watchdog timer input clock frequency | -   | 100 | MHz   |

## PMC System Monitor Specifications

Table 55: PMC System Monitor Specifications

| Parameter <sup>1</sup>   | Symbol     | Conditions <sup>2</sup>  | Min   | Typ   | Max               | Units |
|--|------------|--|-------|-------|-------------------|-------|
| $V_{CCAUX\_SMON} = 1.5V \pm 3\%$ , $V_{REFP} = 1.024V^3$ , $V_{REFN} = 0V$ , $T_j = -40^\circ C$ to $100^\circ C$ , typical values at $T_j = 40^\circ C$ |            |  |       |       |                   |       |
| <b>ADC Accuracy<sup>4</sup></b>  |            |  |       |       |                   |       |
| Resolution   |            |  | 10    | -     | -                 | Bits  |
| Integral nonlinearity  | INL        |  | -1    | -     | 1                 | LSBs  |
| Differential nonlinearity  | DNL        | No missing codes, guaranteed monotonic   | -1    | -     | 1                 | LSBs  |
| Offset error   |            | Calibrated   | -2    | -     | 2                 | LSBs  |
| Gain error   |            | Calibrated   | -0.4  | -     | 0.4               | %     |
| Sample rate  |            |  |       | 0.25  |                   | MS/s  |
| RMS code noise   |            | External 1.024V reference  | -     | -     | 1                 | LSBs  |
|  |            | On-chip reference  | -     | -     | 1                 | LSBs  |
| <b>Analog Inputs</b>   |            |  |       |       |                   |       |
| ADC input ranges<br>( $V_P - V_N$ )  |            | Unipolar operation   | 0     |       | 1                 | V     |
|  |            | Bipolar operation  | -0.5  | -     | 0.5               | V     |
| ADC input common mode ranges   |            | Unipolar common mode range (FS input)  | 0     | -     | 0.25              | V     |
|  |            | Bipolar common mode range (FS input)   | 0.5   | -     | 0.6               | V     |
| Maximum external channel input ranges  |            | Adjacent channels set within these ranges should not corrupt measurements on adjacent channels                             | -0.1  | -     | $V_{CCAUX\_SMON}$ | V     |
| <b>On-Chip Sensors</b>   |            |  |       |       |                   |       |
| Supply sensor error  |            | Measurement range up to $V_{CCAUX\_SMON} \pm 3\%$<br>$T_j = -55^\circ C$ to $125^\circ C$ , internal or external reference | -1    | -     | 1                 | %     |
| <b>System Monitor Reference<sup>5</sup></b>  |            |  |       |       |                   |       |
| External reference   | $V_{REFP}$ | Externally supplied reference voltage  | 0.973 | 1.024 | 1.075             | V     |
| On-chip reference  |            | Tie $V_{REFP}$ to AGND, $T_j = -40^\circ C$ to $125^\circ C$   | 1.019 | 1.024 | 1.029             | V     |

**Notes:**

- For more information, see the *Versal ACAP System Monitor Architecture Manual (AM006)*.
- All the reference voltages required by the ACAP cannot sleep.
- All the accuracy specs are at  $V_{REFP} = 1.024V$  (precisely). Variation in  $V_{REFP}$  will cause a proportional gain error which should be added to see the true accuracy. The temperature range is in Kelvin so the gain error is proportional.
- Gross offset and gain errors are removed by automatic calibration. The specification quotes the net error.
- Any variation in the reference voltage from the nominal  $V_{REFP} = 1.024V$  and  $V_{REFN} = 0V$  will result in a deviation from the ideal transfer function. This also impacts the accuracy of the internal sensor measurements (i.e., temperature and power supply). However, for external ratiometric-type applications allowing the reference to vary by  $\pm 5\%$  is permitted. On-chip reference variation is  $\pm 0.5\%$ .

## Network on Chip Switching Characteristics

Table 56: Network on Chip Switching Characteristics

| Symbol         | Description                                   | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_SOC}$ ) |      |           |     |                        |     | Units |
|----------------|---|--|------|-----------|-----|------------------------|-----|-------|
|                |   | 0.88V (H)  |      | 0.80V (M) |     | 0.80V (L) <sup>1</sup> |     |       |
|                |   | -3   | -2   | -2        | -1  | -2                     | -1  |       |
| $F_{MAX}$      | Network on Chip (NoC) clock maximum frequency | 1080   | 1080 | 1000      | 960 | 1000                   | 960 | MHz   |
| $F_{MAX\_NMU}$ | NoC master unit clock maximum frequency       | 540  | 540  | 500       | 480 | 500                    | 480 | MHz   |

**Notes:**

1. The NoC is powered by the  $V_{CC\_SOC}$  supply that operates at 0.80V in low (L) voltage operation, see [Table 4](#).

## Programmable Logic Performance Characteristics

This section provides the performance characteristics of some common functions and designs implemented in the Versal AI Core devices. These values are subject to the same guidelines as the [AC Switching Characteristics](#) section.

In each of the following performance tables, the I/O bank type is either XPIO or HDIO.

**Table 57: I/O Logic Performance**

| Description | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |     |     |     |           |     |     |     |           |     |     |     | Units |
|-------------|--|-----|-----|-----|-----------|-----|-----|-----|-----------|-----|-----|-----|-------|
|             | 0.88V (H)  |     |     |     | 0.80V (M) |     |     |     | 0.70V (L) |     |     |     |       |
|             | -3   |     | -2  |     | -2        |     | -1  |     | -2        |     | -1  |     |       |
|             | Min  | Max | Min | Max | Min       | Max | Min | Max | Min       | Max | Min | Max |       |
| TX DDR      | 0  | 250 | 0   | 250 | 0         | 250 | 0   | 250 | 0         | 200 | 0   | 200 | Mb/s  |
| TX SDR      | 0  | 125 | 0   | 125 | 0         | 125 | 0   | 125 | 0         | 100 | 0   | 100 | Mb/s  |
| RX DDR      | 0  | 250 | 0   | 250 | 0         | 250 | 0   | 250 | 0         | 200 | 0   | 200 | Mb/s  |
| RX SDR      | 0  | 125 | 0   | 125 | 0         | 125 | 0   | 125 | 0         | 100 | 0   | 100 | Mb/s  |

**Table 58: XPHY I/O Performance**

| Description <sup>1,2</sup> | Data Width | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |      |     |      |           |      |     |      |           |                   |     |                   | Units |
|----------------------------|------------|--|------|-----|------|-----------|------|-----|------|-----------|-------------------|-----|-------------------|-------|
|                            |            | 0.88V (H)  |      |     |      | 0.80V (M) |      |     |      | 0.70V (L) |                   |     |                   |       |
|                            |            | -3   |      | -2  |      | -2        |      | -1  |      | -2        |                   | -1  |                   |       |
|                            |            | Min  | Max  | Min | Max  | Min       | Max  | Min | Max  | Min       | Max               | Min | Max               |       |
| TX DDR                     | 8          | 200  | 1800 | 200 | 1800 | 200       | 1800 | 200 | 1800 | 200       | 1800              | 200 | 1800              | Mb/s  |
|                            | 4          | 200  | 1600 | 200 | 1600 | 200       | 1468 | 200 | 1468 | 200       | 1332 <sup>3</sup> | 200 | 1332 <sup>3</sup> | Mb/s  |
|                            | 2          | 200  | 800  | 200 | 800  | 200       | 734  | 200 | 734  | 200       | 666 <sup>4</sup>  | 200 | 666 <sup>4</sup>  | Mb/s  |
| RX DDR <sup>5</sup>        | 8          | 200  | 1800 | 200 | 1800 | 200       | 1800 | 200 | 1800 | 200       | 1800              | 200 | 1800              | Mb/s  |
|                            | 4          | 200  | 1600 | 200 | 1600 | 200       | 1468 | 200 | 1468 | 200       | 1332 <sup>3</sup> | 200 | 1332 <sup>3</sup> | Mb/s  |
|                            | 2          | 200  | 800  | 200 | 800  | 200       | 734  | 200 | 734  | 200       | 666 <sup>4</sup>  | 200 | 666 <sup>4</sup>  | Mb/s  |

**Notes:**

- XPHY I/O is supported through the Advanced I/O Wizard available with the Vivado Design Suite. The performance values assume a source-synchronous interface. For asynchronous interfaces, see the *Advanced I/O Wizard LogiCORE IP Product Guide (PG320)*.
- Package skews are not included and should be removed through PCB routing.
- For multi-bank interfaces, the performance is specified at 1066.5 Mb/s.
- For multi-bank interfaces, the performance is specified at 533.25 Mb/s.
- SDR specifications are a subset of the DDR specifications.

**Table 59: MIPI D-PHY Performance**

| Description                        | I/O Bank Type | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |      |           |      |           |      | Units |
|------------------------------------|---------------|--|------|-----------|------|-----------|------|-------|
|                                    |               | 0.88V (H)  |      | 0.80V (M) |      | 0.70V (L) |      |       |
|                                    |               | -3   | -2   | -2        | -1   | -2        | -1   |       |
| MIPI D-PHY transmitter or receiver | XP            | 3200   | 3200 | 3200      | 3200 | 3200      | 3200 | Mb/s  |

Table 60: Maximum Physical Interface (PHY) Rate for Soft Memory Interface Controller

| Memory Standard | DRAM Type                               | DIMM Slots | XPIO Bank Performance <sup>1</sup> | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |      |           |      |                   |                   | Units |
|-----------------|---|------------|------------------------------------|--|------|-----------|------|-------------------|-------------------|-------|
|                 |   |            |                                    | 0.88V (H)  |      | 0.80V (M) |      | 0.70V (L)         |                   |       |
|                 |   |            |                                    | -3   | -2   | -2        | -1   | -2                | -1                |       |
| DDR4            | Single rank component                   |            | All                                | 3200   | 3200 | 2933      | 2667 | 2667              | 2133              | Mb/s  |
|                 | 1 rank RDIMM, DIMM <sup>2</sup>         | 1          | All                                | 3200   | 3200 | 2933      | 2667 | 2133              | 2133              | Mb/s  |
|                 | 2 rank RDIMM, LRDIMM, DIMM <sup>2</sup> | 1          | All                                | 2933   | 2933 | 2667      | 2667 | 2133              | 2133              | Mb/s  |
|                 | 4 rank LRDIMM                           | 1          | All                                | 2667   | 2667 | 2400      | 2400 | 2133              | 2133              | Mb/s  |
|                 | 1 rank RDIMM                            | 2          | All                                | 2667   | 2667 | 2400      | 2400 | 2133              | 2133              | Mb/s  |
|                 | 1 rank DIMM <sup>2</sup>                | 2          | All                                | 2400   | 2400 | 2133      | 2133 | 1867              | 1867              | Mb/s  |
|                 | 2 rank LRDIMM                           | 2          | All                                | 2667   | 2667 | 2400      | 2400 | 2133              | 2133              | Mb/s  |
|                 | 2 rank RDIMM                            | 2          | All                                | 2133   | 2133 | 2133      | 2133 | 2133              | 2133              | Mb/s  |
|                 | 2 rank DIMM <sup>2</sup>                | 2          | All                                | 1866   | 1866 | 1866      | 1866 | 1866              | 1866              | Mb/s  |
| RLDRAM3         |   |            | All                                | 1066   | 1066 | 1066      | 1066 | 1066 <sup>4</sup> | 1066 <sup>4</sup> | MHz   |
| QDRIV           | HP                                      |            | All                                | 933  | 933  | 933       | 933  | 933               | 933               | MHz   |
|                 | XP <sup>3</sup>                         |            | All                                | 1066   | 1066 | 1066      | 1066 | 1066              | 1066              | MHz   |

**Notes:**

1. The Versal device package pinout files specify XPIO bank performance (XPIOperf). See ASCII package files information in the *Versal ACAP Packaging and Pinouts Architecture Manual* (AM013).
2. Dual in-line memory module (DIMM) includes SODIMM and UDIMM.
3. The QDRIV XP performance values are for 18-bit interfaces, for 36-bit interfaces the maximum performance is 933 MHz.
4. The RLDRAM3 maximum performance with burst length 2 (BL2) interfaces is 933 MHz in the -2L and -1L speed grades.

# Programmable Logic Switching Characteristics

## Block RAM Switching Characteristics

Table 61: Block RAM Switching Characteristics

| Symbol                               | Description  | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_RAM}$ ) |       |           |       |                        |       | Units   |
|--------------------------------------|--|--|-------|-----------|-------|------------------------|-------|---------|
|                                      |  | 0.88V (H)  |       | 0.80V (M) |       | 0.80V (L) <sup>1</sup> |       |         |
|                                      |  | -3   | -2    | -2        | -1    | -2                     | -1    |         |
| <b>Maximum Frequency</b>             |  |  |       |           |       |                        |       |         |
| $F_{MAX\_WF\_NC}$                    | Block RAM (WRITE_FIRST and NO_CHANGE modes)        | 1000   | 1000  | 850       | 800   | 650                    | 615   | MHz     |
| $F_{MAX\_RF}$                        | Block RAM (READ_FIRST mode)                        | 850  | 850   | 725       | 675   | 550                    | 510   | MHz     |
| <b>Block RAM Clock-to-Out Delays</b> |  |  |       |           |       |                        |       |         |
| $T_{RCKO\_DO}$                       | Clock CLK to DOUT output (without output register) | 0.797  | 0.797 | 0.901     | 0.967 | 1.141                  | 1.233 | ns, Max |
| $T_{RCKO\_DO\_REG}$                  | Clock CLK to DOUT output (with output register)    | 0.234  | 0.234 | 0.262     | 0.280 | 0.333                  | 0.362 | ns, Max |

**Notes:**

- The block RAM is powered by the  $V_{CC\_RAM}$  supply that operates at 0.80V in low (L) voltage operation, see [Table 4](#).

## UltraRAM Switching Characteristics

Table 62: UltraRAM Switching Characteristics

| Symbol                   | Description                                     | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_RAM}$ ) |     |           |     |                        |     | Units |
|--------------------------|---|--|-----|-----------|-----|------------------------|-----|-------|
|                          |   | 0.88V (H)  |     | 0.80V (M) |     | 0.80V (L) <sup>1</sup> |     |       |
|                          |   | -3   | -2  | -2        | -1  | -2                     | -1  |       |
| <b>Maximum Frequency</b> |   |  |     |           |     |                        |     |       |
| $F_{MAX}$                | UltraRAM maximum frequency with output register | 738  | 738 | 664       | 645 | 530                    | 500 | MHz   |

**Notes:**

- The UltraRAM is powered by the  $V_{CC\_RAM}$  supply that operates at 0.80V in low (L) voltage operation, see [Table 4](#).



## Accelerator RAM Switching Characteristics

The *Versal Architecture and Product Data Sheet: Overview (DS950)* lists the Versal AI Core devices that include the accelerator RAM (XRAM).

Table 63: Accelerator RAM Switching Characteristics

| Symbol          | Description                                    | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_PSLP}$ ) |     |           |     |           |                  | Units |
|-----------------|--|---|-----|-----------|-----|-----------|------------------|-------|
|                 |  | 0.88V (H)   |     | 0.80V (M) |     | 0.80V (L) |                  |       |
|                 |  | -3  | -2  | -2        | -1  | -2        | -1               |       |
| $F_{MAX\_XRAM}$ | Maximum accelerator RAM (XRAM) clock frequency | 750   | 725 | 625       | 600 | 500       | 450 <sup>1</sup> | MHz   |
| $F_{PL\_XRAM}$  | Maximum accelerator RAM PL interface frequency | 390   | 375 | 325       | 300 | 270       | 250 <sup>2</sup> | MHz   |

**Notes:**

1. The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum clock frequency is 800 MHz when  $V_{CC\_PSLP} = 0.88V$ .
2. The -1LLI and -1LSI low-power devices support an overdrive voltage where the maximum clock frequency is 350 MHz when  $V_{CC\_PSLP} = 0.88V$ .

## Input/Output Delay Switching Characteristics

Table 64: Input/Output Delay Switching Characteristics

| Symbol  | Description  | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CCINT}$ ) |    |           |    |           |    | Units      |
|---|--|--|----|-----------|----|-----------|----|------------|
|   |  | 0.88V (H)  |    | 0.80V (M) |    | 0.70V (L) |    |            |
|   |  | -3   | -2 | -2        | -1 | -2        | -1 |            |
| $T_{IDELAY\_RESOLUTION}/T_{ODELAY\_RESOLUTION}$           | XPHY IDELAY/ODELAY delay tap resolution  | 1.22 to 4.00   |    |           |    |           |    | ps         |
| $T_{IDELAY\_ERROR}/T_{ODELAY\_ERROR}$                     | XPHY calibrated delay line error (DELAY_VALUE) (REFCLK_FREQUENCY = 500 to 1800 MHz) <sup>1</sup> | -10 to +10   |    |           |    |           |    | Delay Taps |
| $T_{IOL\_IDELAY\_RESOLUTION}/T_{IOL\_ODELAY\_RESOLUTION}$ | IOL IDELAY/ODELAY uncalibrated delay tap resolution for both HD and XP IOL resources             | 60 to 173  |    |           |    |           |    | ps         |

**Notes:**

1. For REFCLK\_FREQUENCY < 500 MHz, BISC calibration of the DELAY\_VALUE\_<0-5> is not guaranteed. Use the  $T_{IDELAY\_RESOLUTION}/T_{ODELAY\_RESOLUTION}$  for delay calculations. Refer to the *Versal ACAP SelectIO Resources Architecture Manual (AM010)*. IDELAY is used for alignment and ALIGN\_DELAY effects the programmed DELAY\_VALUE programming.

## DSP58 Switching Characteristics

Table 65: DSP58 Switching Characteristics

| Symbol                           | Description  | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |      |           |     |           |     | Units |
|----------------------------------|--|--|------|-----------|-----|-----------|-----|-------|
|                                  |  | 0.88V (H)  |      | 0.80V (M) |     | 0.70V (L) |     |       |
|                                  |  | -3   | -2   | -2        | -1  | -2        | -1  |       |
| <b>Fixed Point Arithmetic</b>    |  |  |      |           |     |           |     |       |
| F <sub>MAX_INT_MULT</sub>        | 27 × 24 two's complement multiply                  | 1150   | 1150 | 1070      | 984 | 760       | 680 | MHz   |
| F <sub>MAX_SIMD</sub>            | Single-instruction multiple-data (SIMD) arithmetic | 1150   | 1150 | 1070      | 984 | 760       | 680 | MHz   |
| <b>Complex Arithmetic</b>        |  |  |      |           |     |           |     |       |
| F <sub>MAX_COMPLEX_MULT</sub>    | 18 × 18 two's complement complex multiply          | 984  | 984  | 909       | 850 | 646       | 578 | MHz   |
| <b>Floating Point Arithmetic</b> |  |  |      |           |     |           |     |       |
| F <sub>MAX_FP</sub>              | Floating-point operations                          | 805  | 805  | 750       | 700 | 532       | 476 | MHz   |

## Clock Buffers and Networks

Table 66: Clock Buffers Switching Characteristics (including Multi-clock Buffers)

| Symbol   | Description  | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |      |           |     |           |     | Units |
|--|--|--|------|-----------|-----|-----------|-----|-------|
|  |  | 0.88V (H)  |      | 0.80V (M) |     | 0.70V (L) |     |       |
|  |  | -3   | -2   | -2        | -1  | -2        | -1  |       |
| <b>Global Clock Switching Characteristics (Including BUFGCTRL and MBUFGCTRL)</b>                   |  |  |      |           |     |           |     |       |
| F <sub>MAX</sub>   | Maximum frequency of a global clock tree (BUFG)  | 1150   | 1150 | 1070      | 984 | 800       | 680 | MHz   |
| <b>Global Clock Buffer with Input Divide Capability (BUFGCE_DIV and MBUFGCE_DIV)</b>               |  |  |      |           |     |           |     |       |
| F <sub>MAX</sub>   | Maximum frequency of a global clock buffer with input divide capability                                    | 1150   |      | 1070      | 984 | 800       | 680 | MHz   |
| <b>Global Clock Buffer with Clock Enable (BUFGCE)</b>  |  |  |      |           |     |           |     |       |
| F <sub>MAX</sub>   | Maximum frequency of a global clock buffer with clock enable   | 1150   | 1150 | 1070      | 984 | 800       | 680 | MHz   |
| <b>Global Clock Buffer with for the Processing System (BUFG_PS and MBUFG_PS)</b>                   |  |  |      |           |     |           |     |       |
| F <sub>MAX</sub>   | Maximum frequency of a global clock buffer with clock enable   | 1150   | 1150 | 1070      | 984 | 800       | 680 | MHz   |
| <b>GTY Clock Buffer with Clock Enable and Clock Input Divide Capability (BUFG_GT and MBUFG_GT)</b> |  |  |      |           |     |           |     |       |
| F <sub>MAX</sub>   | Maximum frequency of a serial transceiver clock buffer with clock enable and clock input divide capability | 1150   | 1150 | 1070      | 984 | 1000      | 680 | MHz   |

## MMCM Switching Characteristics

Table 67: MMCM Specification

| Symbol                           | Description   | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CC_RAM</sub> ) |      |           |      |                        |      | Units |
|----------------------------------|---|---|------|-----------|------|------------------------|------|-------|
|                                  |   | 0.88V (H)   |      | 0.80V (M) |      | 0.80V (L) <sup>1</sup> |      |       |
|                                  |   | -3  | -2   | -2        | -1   | -2                     | -1   |       |
| F <sub>INMAX_MMCM</sub>          | Maximum input clock frequency <sup>2</sup>  | 1150  | 1150 | 1070      | 984  | 800                    | 680  | MHz   |
| F <sub>INMIN_MMCM</sub>          | Minimum input clock frequency   | 10  | 10   | 10        | 10   | 10                     | 10   | MHz   |
| F <sub>INJITTER_MMCM</sub>       | Maximum input clock period jitter <sup>3</sup>  | < 20% of clock input period or 1 ns Max   |      |           |      |                        |      |       |
| F <sub>INDUTY_MMCM</sub>         | Input duty cycle range: 10–49 MHz   | 25–75   |      |           |      |                        |      | %     |
|                                  | Input duty cycle range: 50–199 MHz  | 30–70   |      |           |      |                        |      | %     |
|                                  | Input duty cycle range: 200–399 MHz   | 35–65   |      |           |      |                        |      | %     |
|                                  | Input duty cycle range: 400–499 MHz   | 40–60   |      |           |      |                        |      | %     |
|                                  | Input duty cycle range: >500 MHz  | 45–55   |      |           |      |                        |      | %     |
| F <sub>MAX_PCLK_MMCM</sub>       | Maximum dynamic phase shift clock frequency   | 550   | 500  | 500       | 450  | 500                    | 450  | MHz   |
| F <sub>MIN_PCLK_MMCM</sub>       | Minimum dynamic phase shift clock frequency   | 0.01  | 0.01 | 0.01      | 0.01 | 0.01                   | 0.01 | MHz   |
| F <sub>VCOMAX_MMCM</sub>         | Maximum MMCM VCO frequency  | 4320  | 4320 | 4320      | 4320 | 4320                   | 4320 | MHz   |
|                                  | Minimum MMCM VCO frequency  | 2160  | 2160 | 2160      | 2160 | 2160                   | 2160 | MHz   |
| F <sub>BANDWIDTH_MMCM</sub>      | Low MMCM bandwidth at typical <sup>4</sup>  | 1.00  | 1.00 | 1.00      | 1.00 | 1.00                   | 1.00 | MHz   |
|                                  | High MMCM bandwidth at typical <sup>4</sup>   | 4.00  | 4.00 | 4.00      | 4.00 | 4.00                   | 4.00 | MHz   |
| T <sub>STATPHAOFFSET_MMCM</sub>  | Static phase offset of the MMCM outputs <sup>5</sup>                                      | 0.12  | 0.12 | 0.12      | 0.12 | 0.12                   | 0.12 | ns    |
| T <sub>OUTJITTER_MMCM</sub>      | MMCM output jitter  | Note 6  |      |           |      |                        |      |       |
| T <sub>OUTDUTY_MMCM</sub>        | MMCM output clock duty cycle precision <sup>7</sup>                                       | 0.165   | 0.20 | 0.20      | 0.20 | 0.20                   | 0.20 | ns    |
| T <sub>LOCKMAX_MMCM</sub>        | MMCM maximum lock time (non deskew mode)  | 100   | 100  | 100       | 100  | 100                    | 100  | μs    |
| T <sub>LOCKDESKEWMAX_MMCM</sub>  | MMCM maximum lock time in deskew mode   | Note 8  |      |           |      |                        |      |       |
| F <sub>OUTMAX_MMCM</sub>         | MMCM maximum output clock frequency <sup>2</sup>  | 1150  | 1150 | 1070      | 984  | 800                    | 680  | MHz   |
| F <sub>OUTMIN_MMCM</sub>         | MMCM minimum output clock frequency   | 5   | 5    | 5         | 5    | 5                      | 5    | MHz   |
| T <sub>EXTDVAR_MMCM</sub>        | External clock feedback variation   | < 20% of clock input period or 1 ns Max   |      |           |      |                        |      |       |
| T <sub>PWRDWNMINPULSE_MMCM</sub> | Minimum power-down pulse width  | 5.00  | 5.00 | 5.00      | 5.00 | 5.00                   | 5.00 | ns    |
| F <sub>PFDMAX_MMCM</sub>         | Maximum frequency at the phase frequency detector with bandwidth set to High or optimized | 550   | 500  | 500       | 450  | 500                    | 450  | MHz   |
|                                  | Maximum frequency at the phase frequency detector with bandwidth set to Low               | 550   | 500  | 500       | 450  | 500                    | 450  | MHz   |
| F <sub>PFDMIN_MMCM</sub>         | Minimum frequency at the phase frequency detector   | 10  | 10   | 10        | 10   | 10                     | 10   | MHz   |
| T <sub>FBDELAY_MMCM</sub>        | Maximum delay in the feedback path <sup>9</sup>   | 3 ns Max or one clock cycle   |      |           |      |                        |      |       |

Table 67: MMCM Specification (cont'd)

| Symbol                           | Description   | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CC_RAM</sub> ) |    |           |    |                        |    | Units |
|----------------------------------|---|---|----|-----------|----|------------------------|----|-------|
|                                  |   | 0.88V (H)   |    | 0.80V (M) |    | 0.80V (L) <sup>1</sup> |    |       |
|                                  |   | -3  | -2 | -2        | -1 | -2                     | -1 |       |
| T <sub>DESKEWTAPDELAY_MMCM</sub> | Nominal tap-delay of the programmable delay in the PD based deskew scheme | Note 10   |    |           |    |                        |    |       |

**Notes:**

1. The MMCM is powered by the V<sub>CC\_RAM</sub> supply that operates at 0.80V in low (L) voltage operation, see Table 4.
2. The maximum input and output clock frequencies are limited by the global clock buffers. See Table 66.
3. CLKIN jitter also applies to CLKIN\_DESKEW and CLKFB\_DESKEW in digital compensation. CLKFBIN applies only to analog compensation. This parameter is in regards to the functionality of the MMCM. Input jitter above ~1 MHz is reduced by the filtering properties of the MMCM. The magnitude of the reduction is found in the Vivado® timing report.
4. The MMCM does not filter typical spread-spectrum input clocks because they are usually far below the bandwidth filter frequencies.
5. The static offset is measured between any MMCM outputs with identical phase.
6. Values for this parameter are available in the Vivado timing summary as part of the clock uncertainty equation.
7. Includes global clock buffer.
8. The maximum lock time in deskew mode is given by the following formula: Lock time in deskew mode in ms = (0.208 x (VCO\_frequency in MHz) / (CLKIN\_DESKEW\_frequency in MHz)<sup>2</sup>) + 0.1.
9. The parameter only applies to analog compensation.
10. The value for this parameter is included in compensation delay calculations.

## DPLL Switching Characteristics

Table 68: DPLL Specification

| Symbol                           | Description <sup>1</sup>                             | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_RAM}$ ) <sup>2</sup> |      |           |      |                        |      | Units |
|----------------------------------|--|---|------|-----------|------|------------------------|------|-------|
|                                  |  | 0.88V (H)   |      | 0.80V (M) |      | 0.80V (L) <sup>2</sup> |      |       |
|                                  |  | -3  | -2   | -2        | -1   | -2                     | -1   |       |
| F <sub>INMAX_DPLL</sub>          | Maximum input clock frequency <sup>3</sup>           | 1150  | 1150 | 1070      | 984  | 800                    | 680  | MHz   |
| F <sub>INMIN_DPLL</sub>          | Minimum input clock frequency                        | 50  | 50   | 50        | 50   | 50                     | 50   | MHz   |
| F <sub>INJITTER_DPLL</sub>       | Maximum input clock jitter <sup>4</sup>              | < 20% of clock input period or 1 ns Max   |      |           |      |                        |      |       |
| F <sub>INDUTY_DPLL</sub>         | Input duty cycle range: 50–399 MHz                   | 35–65   |      |           |      |                        |      | %     |
|                                  | Input duty cycle range: 400–499 MHz                  | 40–60   |      |           |      |                        |      | %     |
|                                  | Input duty cycle range: >500 MHz                     | 45–55   |      |           |      |                        |      | %     |
| F <sub>PSCLKMAX_DPLL</sub>       | Maximum dynamic phase shift clock frequency          | 550   | 500  | 500       | 450  | 500                    | 450  | MHz   |
| F <sub>PSCLKMIN_DPLL</sub>       | Minimum dynamic phase shift clock frequency          | 0.01  | 0.01 | 0.01      | 0.01 | 0.01                   | 0.01 | MHz   |
| F <sub>DCOMAX_DPLL</sub>         | Maximum DPLL DCO frequency                           | 4000  | 4000 | 4000      | 4000 | 4000                   | 4000 | MHz   |
| F <sub>DCOMIN_DPLL</sub>         | Minimum DPLL DCO frequency                           | 2000  | 2000 | 2000      | 2000 | 2000                   | 2000 | MHz   |
| F <sub>BANDWIDTH_DPLL</sub>      | DPLL bandwidth at typical <sup>5</sup>               | 1.00  | 1.00 | 1.00      | 1.00 | 1.00                   | 1.00 | MHz   |
| T <sub>STATPHAOFFSET_DPLL</sub>  | Static phase offset of the DPLL outputs <sup>6</sup> | 0.12  | 0.12 | 0.12      | 0.12 | 0.12                   | 0.12 | ns    |
| T <sub>OUTJITTER_DPLL</sub>      | DPLL output jitter                                   | Note 7  |      |           |      |                        |      |       |
| T <sub>OUTDUTY_DPLL</sub>        | DPLL output clock duty cycle precision <sup>8</sup>  | 0.165   | 0.20 | 0.20      | 0.20 | 0.20                   | 0.20 | ns    |
| T <sub>LOCKMAX_DPLL</sub>        | DPLL maximum lock time (non-deskew mode)             | Note 9  |      |           |      |                        |      |       |
| T <sub>LOCKDESKEWMAX_DPLL</sub>  | DPLL maximum lock time in deskew mode <sup>10</sup>  | Note 11   |      |           |      |                        |      |       |
| F <sub>OUTMAX_DPLL</sub>         | DPLL maximum output clock frequency <sup>3</sup>     | 1150  | 1150 | 1070      | 984  | 800                    | 680  | MHz   |
| F <sub>OUTMIN_DPLL</sub>         | DPLL minimum output clock frequency                  | 5   | 5    | 5         | 5    | 5                      | 5    | MHz   |
| T <sub>PWRDWNMINPULSE_DPLL</sub> | Minimum power-down pulse width                       | 5.00  | 5.00 | 5.00      | 5.00 | 5.00                   | 5.00 | ns    |
| F <sub>TDCMAX_DPLL</sub>         | Maximum frequency at the time to digital converter   | 200   | 200  | 200       | 200  | 200                    | 200  | MHz   |
| F <sub>TDCMIN_DPLL</sub>         | Minimum frequency at the time to digital converter   | 50  | 50   | 50        | 50   | 50                     | 50   | MHz   |

Table 68: DPLL Specification (cont'd)

| Symbol                           | Description <sup>1</sup>  | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CC_RAM</sub> ) <sup>2</sup> |    |           |    |                        |    | Units |
|----------------------------------|---|--|----|-----------|----|------------------------|----|-------|
|                                  |   | 0.88V (H)  |    | 0.80V (M) |    | 0.80V (L) <sup>2</sup> |    |       |
|                                  |   | -3   | -2 | -2        | -1 | -2                     | -1 |       |
| T <sub>DESKEWTAPDELAY_DPLL</sub> | Nominal tap-delay of the programmable delay in the PD based deskew scheme <sup>10</sup> | Note 12  |    |           |    |                        |    |       |

**Notes:**

- In the VC1902 and VC1802 devices, the DPLLs (DPLL\_X3Y7 and DPLL\_X12Y7 sites) at the HDIO banks are not supported. Thus, DPLL ZHOLD mode for HDIO is not supported in these devices.
- The DPLLs are powered by the V<sub>CC\_RAM</sub> supply, except for the DPLLs at HDIO banks are powered by the V<sub>CCINT</sub> supply. The V<sub>CC\_RAM</sub> supply operates at 0.80V in low (L) voltage operation, see Table 4.
- The maximum input and output clock frequencies are limited by the global clock buffers. See Table 66.
- CLKIN jitter also applies to CLKIN\_DESKEW and CLKFB\_DESKEW in digital compensation. CLKFBIN applies only to analog compensation. This parameter is in regards to the functionality of the DPLL. Input jitter above ~1 MHz is reduced by the filtering properties of the DPLL. The magnitude of the reduction is found in the Vivado® timing report.
- The DPLL does not filter typical spread-spectrum input clocks because they are usually far below the bandwidth filter frequencies.
- The static offset is measured between any DPLL outputs with identical phase.
- Values for this parameter are available in the Vivado timing summary as part of the clock uncertainty equation.
- Includes global clock buffer.
- The maximum lock time in non-deskew mode is given by the given formula: Lock time in non-deskew mode in ms = 153.6 × DIVCLK\_DIVIDE / (CLKIN\_FREQUENCY in MHz).
- In the VC1902 and VC1802 devices, the DPLL deskew functions are not supported.
- The maximum lock time in deskew mode is given by the following formula: Lock time in deskew mode in ms = (0.208 × (VCO\_frequency in MHz) / (CLKIN\_DESKEW\_frequency in MHz)<sup>2</sup>) + (maximum lock time in non-deskew mode in ms from Note 9).
- The value for this parameter is included in compensation delay calculations.

## XPLL Switching Characteristics

Table 69: XPLL Specification

| Symbol                     | Description  | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC_{IO}}$ ) |        |           |        |                        |        | Units |
|----------------------------|--|--|--------|-----------|--------|------------------------|--------|-------|
|                            |  | 0.88V (H)  |        | 0.80V (M) |        | 0.80V (L) <sup>1</sup> |        |       |
|                            |  | -3   | -2     | -2        | -1     | -2                     | -1     |       |
| $F_{INMAX\_XPLL}$          | Maximum input clock frequency <sup>2</sup>   | 1150   | 1150   | 1070      | 984    | 800                    | 680    | MHz   |
| $F_{INMIN\_XPLL}$          | Minimum input clock frequency  | 100  | 100    | 100       | 100    | 100                    | 100    | MHz   |
| $F_{INJITTER\_XPLL}$       | Maximum input clock jitter <sup>3</sup>  | < 20% of clock input period or 1 ns Max  |        |           |        |                        |        |       |
| $F_{INDUTY\_XPLL}$         | Allowable input duty cycle: 100–399 MHz  | 35–65  |        |           |        |                        |        | %     |
|                            | Allowable input duty cycle: 400–499 MHz  | 40–60  |        |           |        |                        |        | %     |
|                            | Allowable input duty cycle: >500 MHz   | 45–55  |        |           |        |                        |        | %     |
| $F_{PSCLKMAX\_XPLL}$       | Maximum dynamic phase shift clock frequency  | 300  | 300    | 300       | 300    | 300                    | 300    | MHz   |
| $F_{PSCLKMIN\_XPLL}$       | Minimum dynamic phase shift clock frequency  | 0.01   | 0.01   | 0.01      | 0.01   | 0.01                   | 0.01   | MHz   |
| $F_{VCOMAX\_XPLL}$         | Maximum XPLL VCO frequency   | 4320   | 4320   | 4320      | 4320   | 4320                   | 4320   | MHz   |
| $F_{VCOMIN\_XPLL}$         | Minimum XPLL VCO frequency   | 2160   | 2160   | 2160      | 2160   | 2160                   | 2160   | MHz   |
| $F_{BANDWIDTH\_XPLL}$      | XPLL bandwidth at typical <sup>4</sup>   | 14.00  | 14.00  | 14.00     | 14.00  | 14.00                  | 14.00  | MHz   |
| $T_{STATPHAOFFSET\_XPLL}$  | Static phase offset of the XPLL outputs <sup>5</sup>                                   | 0.12   | 0.12   | 0.12      | 0.12   | 0.12                   | 0.12   | ns    |
| $T_{OUTJITTER\_XPLL}$      | XPLL output jitter   | Note 6   |        |           |        |                        |        |       |
| $T_{OUTDUTY\_XPLL}$        | XPLL CLKOUT0, CLKOUT1, CLKOUT2, CLKOUT3 duty-cycle precision <sup>7</sup>              | 0.125  | 0.15   | 0.15      | 0.15   | 0.15                   | 0.15   | ns    |
| $T_{LOCKMAX\_XPLL}$        | XPLL maximum lock time (in non-deskew mode)  | 100  | 100    | 100       | 100    | 100                    | 100    | μs    |
| $T_{LOCKDESKEWMAX\_XPLL}$  | XPLL maximum lock time in deskew mode  | Note 8   |        |           |        |                        |        |       |
| $F_{OUTMAX\_XPLL}$         | XPLL maximum output frequency at CLKOUT0, CLKOUT1, CLKOUT2, CLKOUT3 <sup>2,9</sup>     | 1150   | 1150   | 1070      | 984    | 800                    | 680    | MHz   |
|                            | XPLL maximum output frequency at CLKOUTPHY   | 4266   | 4266   | 3933      | 3733   | 3933                   | 3733   | MHz   |
| $F_{OUTMIN\_XPLL}$         | XPLL minimum output frequency at CLKOUT0, CLKOUT1, CLKOUT2, CLKOUT3                    | 16.875   | 16.875 | 16.875    | 16.875 | 16.875                 | 16.875 | MHz   |
|                            | XPLL minimum output frequency at CLKOUTPHY   | 200  | 200    | 200       | 200    | 200                    | 200    | MHz   |
| $T_{PWRDWNMINPULSE\_XPLL}$ | Minimum power-down pulse width   | 5.00   | 5.00   | 5.00      | 5.00   | 5.00                   | 5.00   | ns    |
| $F_{PFDMAX\_XPLL}$         | Maximum frequency at the phase frequency detector with bandwidth set to High optimized | 667.5  | 667.5  | 667.5     | 667.5  | 667.5                  | 667.5  | MHz   |
| $F_{PFDMIN\_XPLL}$         | Minimum frequency at the phase frequency detector                                      | 100  | 100    | 100       | 100    | 100                    | 100    | MHz   |

Table 69: XPLL Specification (cont'd)

| Symbol                            | Description   | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CC_IO</sub> ) |    |           |    |                        |    | Units |
|-----------------------------------|---|--|----|-----------|----|------------------------|----|-------|
|                                   |   | 0.88V (H)  |    | 0.80V (M) |    | 0.80V (L) <sup>1</sup> |    |       |
|                                   |   | -3   | -2 | -2        | -1 | -2                     | -1 |       |
| T <sub>DESKEWTAPEDELAY_XPLL</sub> | Nominal tap-delay of the programmable delay in the PD based deskew scheme | Note 10  |    |           |    |                        |    |       |

**Notes:**

1. The XPLL is powered by the V<sub>CC\_IO</sub> supply that operates at 0.80V in low (L) voltage operation, see Table 4.
2. The maximum input clock frequency and output clock frequency at CLKOUT0, CLKOUT1, CLKOUT2, and CLKOUT3 are limited by the global clock buffers. See Table 66.
3. CLKIN jitter also applies to CLKIN\_DESKEW and CLKFB\_DESKEW in digital compensation. CLKFBIN applies only to analog compensation. This parameter is in regards to the functionality of the XPLL. Input jitter above ~1 MHz is reduced by the filtering properties of the XPLL. The magnitude of the reduction is found in the Vivado® timing report.
4. The XPLL does not filter typical spread-spectrum input clocks because they are usually far below the loop filter frequencies.
5. The static offset is measured between any XPLL outputs with identical phase.
6. Values for this parameter are available in the Vivado timing summary as part of the clock uncertainty equation.
7. Includes global clock buffer.
8. The maximum lock time in deskew mode is given by the following formula: Lock time in deskew mode in μs = (208 x (VCO\_frequency in MHz) / (CLKIN\_DESKEW\_frequency in MHz)<sup>2</sup> + 100).
9. XPLL CLKOUTs F<sub>MAX</sub> is increased in the -1L/-2L speed grade when it directly drives the memory controller at a 1/4 x DDR bit rate. Refer to the DDR bit rate in Table 73.
10. The value for this parameter is included in compensation delay calculations.



## Device Pin-to-Pin Output Parameter Guidelines

The pin-to-pin numbers in the following tables are based on the clock root placement in the center of the device. The actual pin-to-pin values will vary if the root placement selected is different. Consult the Vivado Design Suite timing report for the actual pin-to-pin values.

Table 70: Global Clock Input to Output Delay With MMCM (Internal Mode)

| Symbol   | Description <sup>1, 2</sup>                       | Device    | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CCINT}$ ) |      |           |      |           |      | Units |
|--|---|-----------|--|------|-----------|------|-----------|------|-------|
|  |   |           | 0.88V (H)  |      | 0.80V (M) |      | 0.70V (L) |      |       |
|  |   |           | -3   | -2   | -2        | -1   | -2        | -1   |       |
| <b>SSTL15 Global Clock Input to Output Delay using Output Flip-Flop, Fast Slew Rate, with MMCM</b> |   |           |  |      |           |      |           |      |       |
| T <sub>ICKOFFMMCM</sub>  | Global clock input and output flip-flop with MMCM | XCVC1352  | N/A  |      |           |      |           |      | ns    |
|  |   | XQVC1352  | N/A  |      |           |      |           |      | ns    |
|  |   | XCVC1502  | N/A  | 7.19 | 7.84      | 8.34 | 8.54      | 9.17 | ns    |
|  |   | XCVC1702  | N/A  | 7.19 | 7.84      | 8.34 | 8.54      | 9.17 | ns    |
|  |   | XQVC1702  | N/A  |      |           |      |           |      | ns    |
|  |   | XCVC1802  | N/A  | 7.33 | 8.05      | 8.54 | 8.71      | 9.35 | ns    |
|  |   | XCVC1902  | N/A  | 7.33 | 8.05      | 8.54 | 8.71      | 9.35 | ns    |
|  |   | XQVC1902  | N/A  | N/A  | 8.05      | 8.54 | N/A       | 9.35 | ns    |
|  |   | XQRVC1902 | N/A  | N/A  | N/A       | 8.89 | N/A       | N/A  | ns    |
|  |   | XCVC2602  |  | N/A  |           |      |           |      | ns    |
| XCVC2602   |   | N/A       |  |      |           |      | ns        |      |       |

**Notes:**

1. This table lists representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible I/O and CLB flip-flops are clocked by the global clock net.
2. MMCM output jitter is already included in the timing calculation.

## Device Pin-to-Pin Input Parameter Guidelines

The pin-to-pin numbers in the following tables are based on the clock root placement in the center of the device. The actual pin-to-pin values will vary if the root placement selected is different. Consult the Vivado Design Suite timing report for the actual pin-to-pin values.

**Table 71: Global Clock Input Setup and Hold With MMCM (Internal Mode)**

| Symbol   | Description   | Device   | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |     |           |       |           |       | Units |    |
|--|---|----------|--|-----|-----------|-------|-----------|-------|-------|----|
|  |   |          | 0.88V (H)  |     | 0.80V (M) |       | 0.70V (L) |       |       |    |
|  |   |          | -3   | -2  | -2        | -1    | -2        | -1    |       |    |
| <b>Input Setup and Hold Time Relative to Global Clock Input Signal using SSTL15 Standard.</b> <sup>1, 2, 3</sup> |   |          |  |     |           |       |           |       |       |    |
| T <sub>SUMMCM_VC1352</sub>   | Global clock input and input flip-flop (or latch) with MMCM | Setup    | XCVC1352   | N/A |           |       |           |       |       | ns |
| T <sub>HMMCM_VC1352</sub>  |   | Hold     |  | N/A |           |       |           |       |       | ns |
| T <sub>SUMMCM_XQ_VC1352</sub>  |   | Setup    | XQVC1352   | N/A |           |       |           |       |       | ns |
| T <sub>HMMCM_XQ_VC1352</sub>   |   | Hold     |  | N/A |           |       |           |       |       | ns |
| T <sub>SUMMCM_VC1502</sub>   |   | Setup    | XCVC1502   | N/A | -1.07     | -1.12 | -1.12     | -1.09 | -1.09 | ns |
| T <sub>HMMCM_VC1502</sub>  |   | Hold     |  | N/A | 3.90      | 4.28  | 4.43      | 4.33  | 4.51  | ns |
| T <sub>SUMMCM_VC1702</sub>   |   | Setup    | XCVC1702   | N/A | -1.04     | -1.09 | -1.09     | -1.06 | -1.06 | ns |
| T <sub>HMMCM_VC1702</sub>  |   | Hold     |  | N/A | 3.86      | 4.22  | 4.38      | 4.27  | 4.45  | ns |
| T <sub>SUMMCM_XQ_VC1702</sub>  |   | Setup    | XQVC1702   | N/A |           |       |           |       |       | ns |
| T <sub>HMMCM_XQ_VC1702</sub>   |   | Hold     |  | N/A |           |       |           |       |       | ns |
| T <sub>SUMMCM_VC1802</sub>   |   | Setup    | XCVC1802   | N/A | -0.88     | -0.95 | -0.95     | -0.91 | -0.91 | ns |
| T <sub>HMMCM_VC1802</sub>  |   | Hold     |  | N/A | 4.16      | 4.80  | 4.98      | 4.81  | 5.01  | ns |
| T <sub>SUMMCM_VC1902</sub>   |   | Setup    | XCVC1902   | N/A | -0.88     | -0.95 | -0.95     | -0.91 | -0.91 | ns |
| T <sub>HMMCM_VC1902</sub>  |   | Hold     |  | N/A | 4.16      | 4.80  | 5.06      | 4.81  | 5.01  | ns |
| T <sub>SUMMCM_XQ_VC1902</sub>  |   | Setup    | XQVC1902   | N/A | N/A       | -0.95 | -0.95     | -0.91 | -0.91 | ns |
| T <sub>HMMCM_XQ_VC1902</sub>   |   | Hold     |  | N/A | N/A       | 4.80  | 5.06      | 5.01  | 5.01  | ns |
| T <sub>SUMMCM_XQR_VC1902</sub>   |   | Setup    | XQRVC1902  | N/A | N/A       | N/A   | -1.01     | N/A   | N/A   | ns |
| T <sub>HMMCM_XQR_VC1902</sub>  |   | Hold     |  | N/A | N/A       | N/A   | 5.06      | N/A   | N/A   | ns |
| T <sub>SUMMCM_VC2602</sub>   |   | Setup    | XCVC2602   |     | N/A       |       |           |       |       | ns |
| T <sub>HMMCM_VC2602</sub>  |   | Hold     |  |     | N/A       |       |           |       |       | ns |
| T <sub>SUMMCM_VC2802</sub>   | Setup   | XCVC2802 |  | N/A |           |       |           |       | ns    |    |
| T <sub>HMMCM_VC2802</sub>  | Hold  |          |  | N/A |           |       |           |       | ns    |    |

**Notes:**

1. Setup and hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the global clock input signal using the slowest process, slowest temperature, and slowest voltage. Hold time is measured relative to the global clock input signal using the fastest process, fastest temperature, and fastest voltage.
2. This table lists representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible I/O and CLB flip-flops are clocked by the global clock net.
3. Use IBIS to determine any duty-cycle distortion incurred using various standards.

## Package Parameter Guidelines

The parameters in this section provide the necessary values for calculating timing budgets for clock transmitter and receiver data-valid windows.

*Table 72: Package Skew*

| Symbol   | Description                  | Device    | Package  | Value | Units |
|----------|------------------------------|-----------|----------|-------|-------|
| PKGSKEW  | Package Skew <sup>1, 2</sup> | XCVC1352  | NBVA1024 |       | ps    |
|          |                              |           | NSVE1369 |       | ps    |
|          |                              | XQVC1352  | NBVA1024 |       | ps    |
|          |                              |           | NSVE1369 |       | ps    |
|          |                              | XCVC1502  | NSVG1369 | 143   | ps    |
|          |                              |           | VSVA1596 | 95    | ps    |
|          |                              |           | VSVA2197 | 117   | ps    |
|          |                              | XCVC1702  | NSVG1369 | 143   | ps    |
|          |                              |           | VSVA1596 | 95    | ps    |
|          |                              |           | VSVA2197 | 136   | ps    |
|          |                              | XQVC1702  | NSVG1369 |       | ps    |
|          |                              |           | VSVA1596 |       | ps    |
|          |                              |           | VSVA2197 |       | ps    |
|          |                              | XCVC1802  | VIVA1596 | 66    | ps    |
|          |                              |           | VSVD1760 | 211   | ps    |
|          |                              |           | VSVA2197 | 111   | ps    |
|          |                              | XCVC1902  | VIVA1596 | 66    | ps    |
|          |                              |           | VSVD1760 | 211   | ps    |
|          |                              |           | VSVA2197 | 111   | ps    |
|          |                              | XQVC1902  | VIRA1596 | 66    | ps    |
|          |                              |           | VSRD1760 | 211   | ps    |
|          |                              |           | VSRA2197 | 111   | ps    |
|          |                              | XQRVC1902 | VSRA2197 | 111   | ps    |
|          |                              | XCVC2602  | NSVH1369 |       | ps    |
| VFVH1760 |                              |           | ps       |       |       |
| XCVC2802 | NSVH1369                     |           | ps       |       |       |
|          | VFVH1760                     |           | ps       |       |       |

**Notes:**

1. These values represent the worst-case skew between any two SelectIO resources in the package: shortest delay to longest delay from die pad to ball.
2. Package delay information is available for these device/package combinations. This information can be used to deskew the package.

## Memory Interface Controller

The following table provides the maximum data rates for applicable memory standards using the Versal AI Core device memory PHY. Refer to *Versal ACAP Programmable Network on Chip and Integrated Memory Controller LogiCORE IP Product Guide (PG313)* for the complete list of memory interface standards supported and detailed specifications. The final performance of the memory interface is determined through a complete design implemented in the Vivado Design Suite, following guidelines in the *Versal ACAP PCB Design User Guide (UG863)*, electrical analysis, and characterization of the system.

**Table 73: Maximum Physical Interface (PHY) Rate for Integrated Memory Interface Controller**

| Memory Standard                | DRAM Type                                      | DIMM Slots | XPIO Bank Performance <sup>1</sup> | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_SOC}$ ) |      |           |      |                        |      | Units |
|--------------------------------|--|------------|------------------------------------|--|------|-----------|------|------------------------|------|-------|
|                                |  |            |                                    | 0.88V (H)  |      | 0.80V (M) |      | 0.80V (L) <sup>2</sup> |      |       |
|                                |  |            |                                    | -3   | -2   | -2        | -1   | -2                     | -1   |       |
| DDR4                           | Single rank component <sup>3</sup>             |            | All                                | 3200   | 3200 | 3200      | 3200 | 3200                   | 3200 | Mb/s  |
|                                | 1 rank DIMM <sup>4</sup> , LRDIMM <sup>5</sup> | 1          | All                                | 3200   | 3200 | 3200      | 3200 | 3200                   | 3200 | Mb/s  |
|                                | 2 rank DIMM <sup>4</sup>                       | 1          | All                                | 2933   | 2933 | 2933      | 2933 | 2933                   | 2933 | Mb/s  |
|                                | 1 rank RDIMM, 2 rank LRDIMM                    | 2          | All                                | 2667   | 2667 | 2667      | 2667 | 2667                   | 2667 | Mb/s  |
|                                | 2 rank RDIMM                                   | 2          | All                                | 2133   | 2133 | 2133      | 2133 | 2133                   | 2133 | Mb/s  |
| LPDDR4<br>LPDDR4X <sup>7</sup> | Single rank component <sup>6</sup>             |            | High, Medium                       | 4266   | 4266 | 3933      | 3733 | 3933                   | 3733 | Mb/s  |
|                                | Dual rank component                            |            | High, Medium                       | 3733   | 3733 | 3733      | 3733 | 3733                   | 3733 | Mb/s  |
|                                | Single rank component                          |            | All                                | 3200   | 3200 | 3200      | 3200 | 3200                   | 3200 | Mb/s  |
|                                | Dual rank component                            |            | All                                | 2933   | 2933 | 2933      | 2933 | 2933                   | 2933 | Mb/s  |

**Notes:**

1. The Versal ACAP package pinout files specify XPIO bank performance (XPIOperf). See the ASCII package files information in the *Versal ACAP Packaging and Pinouts Architecture Manual (AM013)*.
2. The integrated DDRMC is powered by the  $V_{CC\_SOC}$  supply that operates at 0.80V in low (L) voltage operation, see [Table 4](#).
3. For DDR4 DDP deep components, the maximum data rate is 2933 Mb/s for five or less DDP devices across all speed grades and temperature grades. For six or more DDP deep devices, the maximum data rate is 2133 Mb/s across all speed grades and temperature grades. For DDR4 DDP wide components, use single rank component data rates.
4. Dual in-line memory module (DIMM) includes RDIMM, SODIMM, and UDIMM.
5. Includes 1 and 2 rank LRDIMM.
6. The LPDDR4/4X pin efficient component interface is limited to 3733 Mb/s. See *Versal ACAP Programmable Network on Chip and Integrated Memory Controller LogiCORE IP Product Guide (PG313)* for pin efficient component interfaces.
7. For LPDDR4/4X, use the Vivado tool to determine the maximum performance by package and I/O bank combination.

## AI Engine Switching Characteristics

Table 74: AI Engine Switching Characteristics

| Symbol            | Description                                     | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CCINT}$ ) |      |           |      |           |      | Units |
|-------------------|---|--|------|-----------|------|-----------|------|-------|
|                   |   | 0.88V (H)  |      | 0.80V (M) |      | 0.70V (L) |      |       |
|                   |   | -3   | -2   | -2        | -1   | -2        | -1   |       |
| $F_{MAX}$         | AI Engine array clock maximum frequency         | 1300   | 1300 | 1250      | 1150 | 1050      | 1000 | MHz   |
| $F_{MAX\_AI\_PL}$ | AI Engine array to programmable logic interface | 650  | 650  | 625       | 575  | 525       | 500  | MHz   |

**Table 75: AI Engine – PL Interface Performance**

| Connection Type   | Device | Rows | Columns | Interface Tiles Connected to PL <sup>1</sup> | Total Bandwidth <sup>2,3</sup> as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |        |           |        |           |        | Units |
|---|--------|------|---------|--|---|--------|-----------|--------|-----------|--------|-------|
|   |        |      |         |  | 0.88V (H)   |        | 0.80V (M) |        | 0.70V (L) |        |       |
|   |        |      |         |  | -3  | -2     | -2        | -1     | -2        | -1     |       |
| PL to AI Engine array interface                           | VC1352 | 4    | 32      | 21   | 873.6   | 873.6  | 840.0     | 772.8  | 705.6     | 672.0  | GB/s  |
|   | VC1502 | 8    | 31      | 21   | 873.6   | 873.6  | 840.0     | 772.8  | 705.6     | 672.0  | GB/s  |
|   | VC1702 | 10   | 32      | 21   | 873.6   | 873.6  | 840.0     | 772.8  | 705.6     | 672.0  | GB/s  |
|   | VC1802 | 6    | 50      | 39   | 1622.4  | 1622.4 | 1560.0    | 1435.2 | 1310.4    | 1248.0 | GB/s  |
|   | VC1902 | 8    | 50      | 39   | 1622.4  | 1622.4 | 1560.0    | 1435.2 | 1310.4    | 1248.0 | GB/s  |
|   | VC2602 | 4    | 38      | 28   | 1164.8  | 1164.8 | 1120.0    | 1030.4 | 940.8     | 896.0  | GB/s  |
|   | VC2802 | 8    | 38      | 28   | 1164.8  | 1164.8 | 1120.0    | 1030.4 | 940.8     | 896.0  | GB/s  |
| AI Engine array interface to AI Engine array <sup>4</sup> | VC1352 | 4    | 32      | 21   | 696.8   | 696.8  | 670.0     | 616.4  | 562.8     | 536.0  | GB/s  |
|   | VC1502 | 8    | 31      | 21   | 696.8   | 696.8  | 670.0     | 616.4  | 562.8     | 536.0  | GB/s  |
|   | VC1702 | 10   | 32      | 21   | 696.8   | 696.8  | 670.0     | 616.4  | 562.8     | 536.0  | GB/s  |
|   | VC1802 | 6    | 50      | 39   | 1258.4  | 1258.4 | 1210.0    | 1113.2 | 1016.4    | 968.0  | GB/s  |
|   | VC1902 | 8    | 50      | 39   | 1258.4  | 1258.4 | 1210.0    | 1113.2 | 1016.4    | 968.0  | GB/s  |
|   | VC2602 | 4    | 38      | 28   | 915.2   | 915.2  | 880.0     | 809.6  | 739.2     | 704.0  | GB/s  |
|   | VC2802 | 8    | 38      | 28   | 915.2   | 915.2  | 880.0     | 809.6  | 739.2     | 704.0  | GB/s  |
| AI Engine array to AI Engine array interface <sup>4</sup> | VC1352 | 4    | 32      | 21   | 478.4   | 478.4  | 460.0     | 423.2  | 386.4     | 368.0  | GB/s  |
|   | VC1502 | 8    | 31      | 21   | 478.4   | 478.4  | 460.0     | 423.2  | 386.4     | 368.0  | GB/s  |
|   | VC1702 | 10   | 32      | 21   | 478.4   | 478.4  | 460.0     | 423.2  | 386.4     | 368.0  | GB/s  |
|   | VC1802 | 6    | 50      | 39   | 852.8   | 852.8  | 820.0     | 754.4  | 688.8     | 656.0  | GB/s  |
|   | VC1902 | 8    | 50      | 39   | 852.8   | 852.8  | 820.0     | 754.4  | 688.8     | 656.0  | GB/s  |
|   | VC2602 | 4    | 38      | 28   | 624.0   | 624.0  | 600.0     | 552.0  | 504.0     | 480.0  | GB/s  |
|   | VC2802 | 8    | 38      | 28   | 624.0   | 624.0  | 600.0     | 552.0  | 504.0     | 480.0  | GB/s  |
| AI Engine array interface to PL                           | VC1352 | 4    | 32      | 21   | 655.2   | 655.2  | 630.0     | 579.6  | 529.2     | 504.0  | GB/s  |
|   | VC1502 | 8    | 31      | 21   | 655.2   | 655.2  | 630.0     | 579.6  | 529.2     | 504.0  | GB/s  |
|   | VC1702 | 10   | 32      | 21   | 655.2   | 655.2  | 630.0     | 579.6  | 529.2     | 504.0  | GB/s  |
|   | VC1802 | 6    | 50      | 39   | 1216.8  | 1216.8 | 1170.0    | 1076.4 | 982.8     | 936.0  | GB/s  |
|   | VC1902 | 8    | 50      | 39   | 1216.8  | 1216.8 | 1170.0    | 1076.4 | 982.8     | 936.0  | GB/s  |
|   | VC2602 | 4    | 38      | 28   | 873.6   | 873.6  | 840.0     | 772.8  | 705.6     | 672.0  | GB/s  |
|   | VC2802 | 8    | 38      | 28   | 873.6   | 873.6  | 840.0     | 772.8  | 705.6     | 672.0  | GB/s  |

**Notes:**

1. Not all of the AI Engine interface tiles are connected to the PL.
2. Assumes all PL AXI4-Stream interfaces run at maximum frequency.
3. AI Engine array interface tiles have interfaces to both the PL and NoC. Routing to these interfaces share the same streaming interconnect resources inside the AI Engine array.
4. Total bandwidth includes horizontal interface usage, See the *Versal ACAP AI Engine Architecture Manual (AM009)* for more information.

For further information on the AI Engine array interface to the PL interface, see the *AI Engine Array Interface Topology* figure and *AI Engine to PL Interface Bandwidth Performance* table in the *Versal ACAP AI Engine Architecture Manual (AM009)*.

## GTY and GTYP Transceiver Specifications

The *Versal Architecture and Product Data Sheet: Overview (DS950)* lists the Versal AI Core devices that include the GTY and GTYP transceivers.

## GTY and GTYP Transceiver DC Input and Output Levels

Table 76 summarizes the DC specifications of the GTY and GTYP transceivers in Versal AI Core devices. Consult the *Versal ACAP GTY and GTYP Transceivers Architecture Manual (AM002)* for further details.

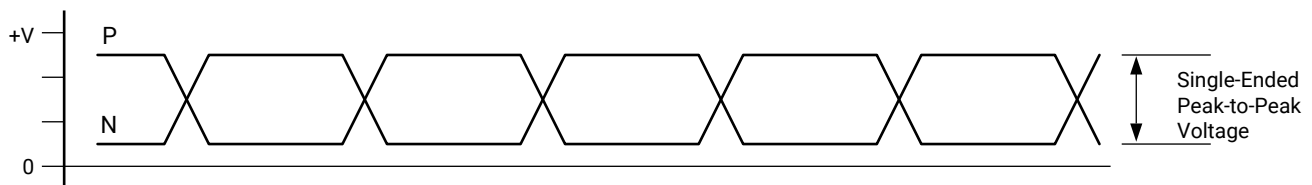
Table 76: GTY and GTYP Transceiver DC Specifications

| Symbol               | DC Parameter   | Conditions  | Min  | Typ                       | Max                   | Units |
|----------------------|--|---|--|---------------------------|-----------------------|-------|
| DV <sub>PPIN</sub>   | Differential peak-to-peak input voltage (external AC coupled)              | >10.3125 Gb/s   | 150  | -                         | 1250                  | mV    |
|                      |  | 6.6 Gb/s to 10.3125 Gb/s  | 150  | -                         | 1250                  | mV    |
|                      |  | ≤ 6.6 Gb/s  | 150  | -                         | 2000                  | mV    |
| V <sub>IN</sub>      | Single-ended input voltage. Voltage measured at the pin referenced to GND. | DC coupled V <sub>GTY_AVTT</sub> = 1.2V                           | -200   | -                         | V <sub>GTY_AVTT</sub> | mV    |
| V <sub>CMIN</sub>    | Common mode input voltage  | DC coupled V <sub>GTY_AVTT</sub> = 1.2V                           | -  | 2/3 V <sub>GTY_AVTT</sub> | -                     | mV    |
| DV <sub>PPOUT</sub>  | Differential peak-to-peak output voltage <sup>1</sup>                      | Transmitter output swing is set to 11111                          | 800  | -                         | -                     | mV    |
| V <sub>CMOUTDC</sub> | Common mode output voltage: DC coupled (equation based)                    | When remote RX is terminated to GND                               | $V_{GTY\_AVTT}/2 - D_{VPPOUT}/4$   |                           |                       | mV    |
|                      |  | When remote RX termination is floating                            | $V_{GTY\_AVTT} - D_{VPPOUT}/2$   |                           |                       | mV    |
|                      |  | When remote RX is terminated to V <sub>RX_TERM</sub> <sup>2</sup> | $V_{GTY\_AVTT} - \frac{D_{VPPOUT}}{4} - \left( \frac{V_{GTY\_AVTT} - V_{RX\_TERM}}{2} \right)$ |                           |                       | mV    |
| V <sub>CMOUTAC</sub> | Common mode output voltage: AC coupled                                     | Equation based  | $V_{GTY\_AVTT} - D_{VPPOUT}/2$   |                           |                       | mV    |
| R <sub>IN</sub>      | Differential input resistance  |   | -  | 100                       | -                     | Ω     |
| R <sub>OUT</sub>     | Differential output resistance   |   | -  | 100                       | -                     | Ω     |
| T <sub>OSKEW</sub>   | Transmitter output pair (TXP and TXN) intra-pair skew                      |   | -  | -                         | 10                    | ps    |
| C <sub>EXT</sub>     | Recommended external AC coupling capacitor <sup>3</sup>                    |   | -  | 100                       | -                     | nF    |

**Notes:**

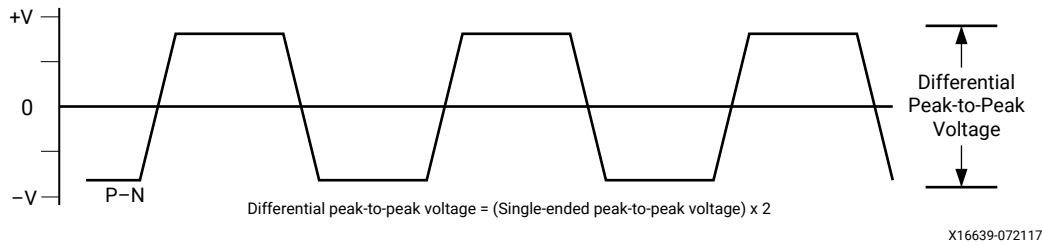
- The output swing and pre-emphasis levels are programmable using the GTY and GTYP transceiver attributes discussed in the *Versal ACAP GTY and GTYP Transceivers Architecture Manual (AM002)* and can result in values lower than reported in this table.
- V<sub>RX\_TERM</sub> is the remote RX termination voltage.
- Other values can be used as appropriate to conform to specific protocols and standards.

Figure 1: Single-Ended Peak-to-Peak Voltage



X16653-072117

Figure 2: Differential Peak-to-Peak Voltage



The following tables summarize the DC specifications of the clock input/output levels of the GTY and GTYP transceivers in Versal AI Core devices. Consult the *Versal ACAP GTY and GTYP Transceivers Architecture Manual (AM002)* for further details.

Table 77: GTY and GTYP Transceiver Clock DC Input Level Specification

| Symbol      | DC Parameter                            | Min | Typ | Max  | Units    |
|-------------|---|-----|-----|------|----------|
| $V_{IDIFF}$ | Differential peak-to-peak input voltage | 250 | -   | 2000 | mV       |
| $R_{IN}$    | Differential input resistance           | -   | 100 | -    | $\Omega$ |
| $C_{EXT}$   | Required external AC coupling capacitor | -   | 10  | -    | nF       |

Table 78: GTY and GTYP Transceiver Clock Output Level Specification

| Symbol      | Description   | Conditions                               | Min  | Typ | Max | Units |
|-------------|---|--|------|-----|-----|-------|
| $V_{OL}$    | Output Low voltage for P and N                              | $R_T = 100\Omega$ across P and N signals | -100 | -   | 100 | mV    |
| $V_{OH}$    | Output High voltage for P and N                             | $R_T = 100\Omega$ across P and N signals | 250  | -   | 450 | mV    |
| $V_{DDOUT}$ | Differential output voltage (P-N), P = High (N-P), N = High | $R_T = 100\Omega$ across P and N signals | 300  | -   | 430 | mV    |
| $V_{CMOUT}$ | Common mode voltage   | $R_T = 100\Omega$ across P and N signals | 100  | -   | 250 | mV    |

## GTY and GTYP Transceiver Switching Characteristics

Consult the *Versal ACAP GTY and GTYP Transceivers Architecture Manual (AM002)* for further information.



## GTY and GTYP Transceiver Performance

Table 79: GTY Transceiver Performance

| Symbol                  | Description                            | Subrate Divider | Output Divider | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |             |            |            |            |            |            |            |            |            |            | Units      |        |      |
|-------------------------|--|-----------------|----------------|--|-------------|------------|------------|------------|------------|------------|------------|------------|------------|------------|------------|--------|------|
|                         |  |                 |                | 0.88V (H)  |             |            |            | 0.80V (M)  |            |            |            | 0.70V (L)  |            |            |            |        |      |
|                         |  |                 |                | -3   | -2          | -2         | -1         | -2         | -1         | -2         | -1         |            |            |            |            |        |      |
| F <sub>GTYMAX</sub>     | GTY maximum line rate                  |                 |                | 32.75 (LPM)  |             | 28.21      |            | 28.21      |            | 26.5625    |            | 28.21      |            | 25.78125   |            | Gb/s   |      |
|                         |  |                 |                | 30.5 (DFE)   |             |            |            |            |            |            |            |            |            |            |            |        |      |
| F <sub>GTYMIN</sub>     | GTY minimum line rate                  |                 |                | 1.2  |             | 1.2        |            | 1.2        |            | 1.2        |            | 1.2        |            | 1.2        |            | Gb/s   |      |
|                         |  |                 |                | <b>Min</b>   | <b>Max</b>  | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> |        |      |
| F <sub>GTYRRANGE</sub>  | RINGPLL line rate range <sup>1,2</sup> | 1               | 1              | 8  | 12.5        | 8          | 12.5       | 8          | 12.5       | 8          | 12.5       | 8          | 12.5       | 8          | 12.5       | Gb/s   |      |
|                         |  |                 |                | 2  | 4           | 8          | 4          | 8          | 4          | 8          | 4          | 8          | 4          | 8          | 4          | 8      | Gb/s |
|                         |  |                 |                | 4  | 2           | 4          | 2          | 4          | 2          | 4          | 2          | 4          | 2          | 4          | 2          | 4      | Gb/s |
|                         |  |                 |                | 8  | 1.2         | 2          | 1.2        | 2          | 1.2        | 2          | 1.2        | 2          | 1.2        | 2          | 1.2        | 2      | Gb/s |
|                         |  |                 |                | <b>Min</b>   | <b>Max</b>  | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> |        |      |
| F <sub>GTYLRange</sub>  | LCPLL line rate range <sup>3</sup>     | 1               | 1              | 16   | 32.75 (LPM) | 16         | 28.21      | 16         | 28.21      | 16         | 26.5625    | 16         | 28.21      | 16         | 25.78125   | Gb/s   |      |
|                         |  |                 |                | 30.5 (DFE)   |             |            |            |            |            |            |            |            |            |            |            |        |      |
|                         |  | 2               | 8              | 16.375   | 8           | 16.375     | 8          | 16.375     | 8          | 16.375     | 8          | 16.375     | 8          | 16.375     | 8          | 16.375 | Gb/s |
|                         |  | 1               | 2              | 8  | 16.375      | 8          | 14.105     | 8          | 14.105     | 8          | 13.28125   | 8          | 14.105     | 8          | 12.891     | Gb/s   |      |
|                         |  | 2               | 4              | 4  | 8.1875      | 4          | 8.1875     | 4          | 8.1875     | 4          | 8.1875     | 4          | 8.1875     | 4          | 8.1875     | Gb/s   |      |
|                         |  | 1               | 4              | 4  | 8.1875      | 4          | 7.0525     | 4          | 7.0525     | 4          | 6.640625   | 4          | 7.0525     | 4          | 6.4453125  | Gb/s   |      |
|                         |  | 2               | 2              | 2  | 4.09375     | 2          | 4.09375    | 2          | 4.09375    | 2          | 4.09375    | 2          | 4.0938     | 2          | 4.09375    | Gb/s   |      |
|                         |  | 1               | 8              | 2  | 4.09375     | 2          | 3.52625    | 2          | 3.52625    | 2          | 3.3203125  | 2          | 3.5263     | 2          | 3.2226563  | Gb/s   |      |
| 2                       | 1.2                                    | 1.2             | 2.046875       | 1.2  | 2.046875    | 1.2        | 2.046875   | 1.2        | 1.66015625 | 1.2        | 1.7631     | 1.2        | 2.046875   | Gb/s       |            |        |      |
|                         |  |                 |                | <b>Min</b>   | <b>Max</b>  | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> |        |      |
| F <sub>RPLLRange</sub>  | RINGPLL frequency range                |                 |                | 4  | 8           | 4          | 8          | 4          | 8          | 4          | 8          | 4          | 8          | 4          | 8          | GHz    |      |
| F <sub>LCPLLRange</sub> | LCPLL frequency range                  |                 |                | 8  | 16.375      | 8          | 16.375     | 8          | 16.375     | 8          | 16.375     | 8          | 16.375     | 8          | 16.375     | GHz    |      |

**Notes:**

1. The values listed are the rounded results of the calculated equation  $(2 \times \text{RINGPLL\_Frequency}) / \text{Subrate\_Divider}$ .
2. The highest supported line rate when using the RPLL to drive the datapath is 12.5 Gb/s.
3. The values listed are the rounded results of the calculated equation  $(2 \times \text{LCPLL\_Frequency}) / (\text{Output\_Divider} \times \text{Subrate\_Divider})$ .

Table 80: GTYP Transceiver Performance

| Symbol                   | Description                            | Subrate Divider | Output Divider | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |             |             |             |            |            |            |            |            |            |            |            | Units    |        |          |      |
|--------------------------|--|-----------------|----------------|--|-------------|-------------|-------------|------------|------------|------------|------------|------------|------------|------------|------------|----------|--------|----------|------|
|                          |  |                 |                | 0.88V (H)  |             |             |             | 0.80V (M)  |            |            |            | 0.70V (L)  |            |            |            |          |        |          |      |
|                          |  |                 |                | -3   |             | -2          |             | -2         |            | -1         |            | -2         |            | -1         |            |          |        |          |      |
| F <sub>GTYPMAX</sub>     | GTYP maximum line rate                 |                 |                | 32.75 (LPM)  |             | 32.75 (LPM) |             | 28.21      |            | 26.5625    |            | 28.21      |            | 25.78125   |            | Gb/s     |        |          |      |
|                          |  |                 |                | 32 (DFE)   |             | 32 (DFE)    |             |            |            |            |            |            |            |            |            |          |        |          |      |
| F <sub>GTYPMIN</sub>     | GTYP minimum line rate                 |                 |                | 1.2  |             | 1.2         |             | 1.2        |            | 1.2        |            | 1.2        |            | 1.2        |            | Gb/s     |        |          |      |
|                          |  |                 |                | <b>Min</b>   | <b>Max</b>  | <b>Min</b>  | <b>Max</b>  | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> |          |        |          |      |
| F <sub>GTYPRRANGE</sub>  | RINGPLL line rate range <sup>1,2</sup> |                 | 1              | 8  | 12.5        | 8           | 12.5        | 8          | 12.5       | 8          | 12.5       | 8          | 12.5       | 8          | 12.5       | Gb/s     |        |          |      |
|                          |  |                 |                | 4  | 8           | 4           | 8           | 4          | 8          | 4          | 8          | 4          | 8          | 4          | 8          | Gb/s     |        |          |      |
|                          |  |                 |                | 2  | 4           | 2           | 4           | 2          | 4          | 2          | 4          | 2          | 4          | 2          | 4          | Gb/s     |        |          |      |
|                          |  |                 |                | 1.2  | 2           | 1.2         | 2           | 1.2        | 2          | 1.2        | 2          | 1.2        | 2          | 1.2        | 2          | Gb/s     |        |          |      |
|                          |  |                 |                | <b>Min</b>   | <b>Max</b>  | <b>Min</b>  | <b>Max</b>  | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> |          |        |          |      |
| F <sub>GTYPPLRANGE</sub> | LCPLL line rate range <sup>3</sup>     | 1               | 1              | 16   | 32.75 (LPM) | 16          | 32.75 (LPM) | 16         | 28.21      | 16         | 26.5625    | 16         | 28.21      | 16         | 25.78125   | Gb/s     |        |          |      |
|                          |  |                 |                | 32 (DFE)   | 32 (DFE)    |             |             |            |            |            |            |            |            |            |            |          |        |          |      |
|                          |  |                 | 2              | 8  | 16.375      | 8           | 16.375      | 8          | 16.375     | 8          | 16.375     | 8          | 16.375     | 8          | 16.375     | 8        | 16.375 | Gb/s     |      |
|                          |  |                 |                | 4  | 8.1875      | 4           | 8.1875      | 4          | 8.1875     | 4          | 8.1875     | 4          | 8.1875     | 4          | 8.1875     | 4        | 8.1875 | Gb/s     |      |
|                          |  |                 | 4              | 1  | 4           | 8.1875      | 4           | 8.1875     | 4          | 8.1875     | 4          | 8.1875     | 4          | 8.1875     | 4          | 8.1875   | 4      | 8.1875   | Gb/s |
|                          |  |                 |                | 2  | 2           | 4.09375     | 2           | 4.09375    | 2          | 4.09375    | 2          | 4.09375    | 2          | 4.09375    | 2          | 4.09375  | 2      | 4.09375  | Gb/s |
|                          |  |                 | 8              | 1  | 2           | 4.09375     | 2           | 4.09375    | 2          | 4.09375    | 2          | 4.09375    | 2          | 4.09375    | 2          | 4.09375  | 2      | 4.09375  | Gb/s |
|                          |  |                 |                | 2  | 1.2         | 2.046875    | 1.2         | 2.046875   | 1.2        | 2.046875   | 1.2        | 2.046875   | 1.2        | 2.046875   | 1.2        | 2.046875 | 1.2    | 2.046875 | Gb/s |
|                          |  |                 |                | <b>Min</b>   | <b>Max</b>  | <b>Min</b>  | <b>Max</b>  | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> | <b>Min</b> | <b>Max</b> |          |        |          |      |
| F <sub>RPLLRANGE</sub>   | RINGPLL frequency range                |                 |                | 4  | 8           | 4           | 8           | 4          | 8          | 4          | 8          | 4          | 8          | 4          | 8          | GHz      |        |          |      |
| F <sub>LCPLLRANGE</sub>  | LCPLL frequency range                  |                 |                | 8  | 16.375      | 8           | 16.375      | 8          | 16.375     | 8          | 16.375     | 8          | 16.375     | 8          | 16.375     | GHz      |        |          |      |

**Notes:**

1. The values listed are the rounded results of the calculated equation  $(2 \times \text{RINGPLL\_Frequency}) / \text{Subrate\_Divider}$ .
2. The highest supported line rate when using the RPLL to drive the datapath is 12.5 Gb/s.
3. The values listed are the rounded results of the calculated equation  $(2 \times \text{LCPLL\_Frequency}) / (\text{Output\_Divider} \times \text{Subrate\_Divider})$ .

## ***GTY and GTYP Transceiver Configuration Interface Port Switching Characteristics***

**Table 81: GTY and GTYP Transceiver Configuration Interface Port (APB3) Switching Characteristics**

| Symbol              | Description         | All Speed Grades |     | Units |
|---------------------|---------------------|------------------|-----|-------|
|                     |                     | Min              | Max |       |
| F <sub>GTYPB3</sub> | GTYPB3CLK frequency | 100              | 300 | MHz   |

## ***GTY and GTYP Transceiver Reference Clock Switching Characteristics***

**Table 82: GTY and GTYP Transceiver Reference Clock Switching Characteristics**

| Symbol                  | Description                     | Conditions           | All Speed Grades |     |     | Units |
|-------------------------|---------------------------------|----------------------|------------------|-----|-----|-------|
|                         |                                 |                      | Min              | Typ | Max |       |
| F <sub>GTYPREFCLK</sub> | Reference clock frequency range |                      | 60               | -   | 820 | MHz   |
| T <sub>RCLK</sub>       | Reference clock rise time       | 20% - 80%            | -                | 200 | -   | ps    |
| T <sub>FCLK</sub>       | Reference clock fall time       | 80% - 20%            | -                | 200 | -   | ps    |
| T <sub>DREF</sub>       | Reference clock duty cycle      | Transceiver PLL only | 40               | 50  | 60  | %     |

## GTY and GTYP Transceiver Reference Clock Oscillator Selection Phase Noise Mask

Table 83: GTY and GTYP Transceiver Reference Clock Oscillator Selection Phase Noise Mask

| Symbol                         | Description <sup>1, 2</sup>  | Offset Frequency | Min | Typ | Max  | Units  |
|--------------------------------|--|------------------|-----|-----|------|--------|
| RINGPLL <sub>REFCLK</sub> MASK | RINGPLL reference clock select phase noise mask at GTY_REFCLK frequency = 156.25 MHz | 10 kHz           | -   | -   | -112 | dBc/Hz |
|                                |  | 100 kHz          | -   | -   | -128 |        |
|                                |  | 1 MHz            | -   | -   | -145 |        |
|                                | RINGPLL reference clock select phase noise mask at GTY_REFCLK frequency = 312.5 MHz  | 10 kHz           | -   | -   | -103 | dBc/Hz |
|                                |  | 100 kHz          | -   | -   | -123 |        |
|                                |  | 1 MHz            | -   | -   | -143 |        |
|                                | RINGPLL reference clock select phase noise mask at GTY_REFCLK frequency = 625 MHz    | 10 kHz           | -   | -   | -98  | dBc/Hz |
|                                |  | 100 kHz          | -   | -   | -117 |        |
|                                |  | 1 MHz            | -   | -   | -140 |        |
| LCPLL <sub>REFCLK</sub> MASK   | LCPLL reference clock select phase noise mask at GTY_REFCLK frequency = 156.25 MHz   | 10 kHz           | -   | -   | -112 | dBc/Hz |
|                                |  | 100 kHz          | -   | -   | -128 |        |
|                                |  | 1 MHz            | -   | -   | -145 |        |
|                                |  | 50 MHz           | -   | -   | -145 |        |
|                                | LCPLL reference clock select phase noise mask at GTY_REFCLK frequency = 312.5 MHz    | 10 kHz           | -   | -   | -103 | dBc/Hz |
|                                |  | 100 kHz          | -   | -   | -123 |        |
|                                |  | 1 MHz            | -   | -   | -143 |        |
|                                |  | 50 MHz           | -   | -   | -145 |        |
|                                | LCPLL reference clock select phase noise mask at GTY_REFCLK frequency = 625 MHz      | 10 kHz           | -   | -   | -98  | dBc/Hz |
|                                |  | 100 kHz          | -   | -   | -117 |        |
|                                |  | 1 MHz            | -   | -   | -140 |        |
|                                |  | 50 MHz           | -   | -   | -144 |        |

**Notes:**

- For reference clock frequencies not in this table, use the phase-noise mask for the nearest reference clock frequency.
- This reference clock phase-noise mask is superseded by any reference clock phase-noise mask that is specified in a supported protocol, e.g., PCIe.

## ***GTY and GTYP Transceiver PLL/Lock Time Adaptation***

*Table 84: GTY and GTYP Transceiver PLL/Lock Time Adaptation*

| Symbol             | Description  | Conditions  | All Speed Grades |        |                       | Units |
|--------------------|--|---|------------------|--------|-----------------------|-------|
|                    |  |   | Min              | Typ    | Max                   |       |
| T <sub>LOCK</sub>  | Initial PLL lock   | Reference clock frequency ≥ 150 MHz   | -                | -      | 3                     | ms    |
|                    |  | Reference clock frequency < 150 MHz   | -                | -      | 5.7                   | ms    |
| T <sub>DLOCK</sub> | Clock recovery phase acquisition and adaptation time for decision feedback equalizer (DFE)             | After the PLL is locked to the reference clock, this is the time it takes to lock the clock data recovery (CDR) to the data present at the input. | -                | 50,000 | 37 x 10 <sup>6</sup>  | UI    |
|                    | Clock recovery phase acquisition and adaptation time for low-power mode (LPM) when the DFE is disabled |   | -                | 50,000 | 2.3 x 10 <sup>6</sup> | UI    |

## GTY and GTYP Transceiver User Clock Switching Characteristics

Table 85: GTY Transceiver User Clock Switching Characteristics

| Symbol                    | Description <sup>1</sup>                           | Data Width Conditions (Bit) |                    | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CCINT}$ ) |          |           |         |           |         | Units |
|---------------------------|--|-----------------------------|--------------------|--|----------|-----------|---------|-----------|---------|-------|
|                           |  |                             |                    | 0.88V (H)  |          | 0.80V (M) |         | 0.70V (L) |         |       |
|                           |  | Internal Logic              | Interconnect Logic | -3   | -2       | -2        | -1      | -2        | -1      |       |
| F <sub>TXOUTPMA</sub>     | TXOUTCLK maximum frequency sourced from OUTCLKPMA  |                             |                    | 664.063  | 664.063  | 664.063   | 664.063 | 664.063   | 644.531 | MHz   |
| F <sub>RXOUTPMA</sub>     | RXOUTCLK maximum frequency sourced from OUTCLKPMA  |                             |                    | 664.063  | 664.063  | 664.063   | 664.063 | 664.063   | 644.531 | MHz   |
| F <sub>TXOUTPROGDIV</sub> | TXOUTCLK maximum frequency sourced from OUTPROGDIV |                             |                    | 1024.000   | 1024.000 | 1024.000  | 664.063 | 664.063   | 644.531 | MHz   |
| F <sub>RXOUTPROGDIV</sub> | RXOUTCLK maximum frequency sourced from OUTPROGDIV |                             |                    | 1024.000   | 1024.000 | 1024.000  | 664.063 | 664.063   | 644.531 | MHz   |
| F <sub>TXIN</sub>         | TXUSRCLK maximum frequency                         | 16                          | 16                 | 511.719  | 440.781  | 440.781   | 415.040 | 402.832   | 402.832 | MHz   |
|                           |  |                             | 32                 | 255.859  | 220.391  | 220.391   | 207.520 | 201.416   | 201.416 | MHz   |
|                           |  | 32                          | 32                 | 511.719  | 440.781  | 440.781   | 415.040 | 402.832   | 402.832 | MHz   |
|                           |  |                             | 64                 | 255.859  | 220.391  | 220.391   | 207.520 | 201.416   | 201.416 | MHz   |
|                           |  | 64                          | 64                 | 511.719 (LPM)  | 440.781  | 440.781   | 415.039 | 402.832   | 402.832 | MHz   |
|                           |  |                             |                    | 476.563 (DFE)  |          |           |         |           |         |       |
|                           |  |                             | 128                | 255.859 (LPM)  | 220.391  | 220.391   | 207.520 | 201.416   | 201.416 | MHz   |
|                           |  |                             |                    | 238.281 (DFE)  |          |           |         |           |         |       |
|                           |  | 20                          | 20                 | 409.375  | 352.625  | 352.625   | 332.032 | 352.625   | 322.266 | MHz   |
|                           |  |                             | 40                 | 204.688  | 176.313  | 176.313   | 166.016 | 176.313   | 161.133 | MHz   |
|                           |  | 40                          | 40                 | 664.063  | 664.063  | 664.063   | 664.063 | 664.063   | 644.531 | MHz   |
|                           |  |                             | 80                 | 204.688  | 176.313  | 176.313   | 166.016 | 176.313   | 161.133 | MHz   |
|                           |  | 80                          | 80                 | 409.375 (LPM)  | 352.625  | 352.625   | 332.032 | 352.625   | 322.266 | MHz   |
|                           |  |                             |                    | 381.250 (DFE)  |          |           |         |           |         |       |
|                           |  |                             | 160                | 204.688 (LPM)  | 176.313  | 176.313   | 166.016 | 176.313   | 161.133 | MHz   |
|                           |  |                             |                    | 190.625 (DFE)  |          |           |         |           |         |       |

Table 85: GTY Transceiver User Clock Switching Characteristics (cont'd)

| Symbol            | Description <sup>1</sup>   | Data Width Conditions (Bit) |                    | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |         |           |         |           |         | Units |
|-------------------|----------------------------|-----------------------------|--------------------|--|---------|-----------|---------|-----------|---------|-------|
|                   |                            |                             |                    | 0.88V (H)  |         | 0.80V (M) |         | 0.70V (L) |         |       |
|                   |                            | Internal Logic              | Interconnect Logic | -3   | -2      | -2        | -1      | -2        | -1      |       |
| F <sub>RXIN</sub> | RXUSRCLK maximum frequency | 16                          | 16                 | 511.719  | 440.781 | 440.781   | 415.040 | 402.832   | 402.832 | MHz   |
|                   |                            |                             | 32                 | 255.859  | 220.391 | 220.391   | 207.520 | 201.416   | 201.416 | MHz   |
|                   |                            | 32                          | 32                 | 511.719  | 440.781 | 440.781   | 415.040 | 402.832   | 402.832 | MHz   |
|                   |                            |                             | 64                 | 255.859  | 220.391 | 220.391   | 207.520 | 201.416   | 201.416 | MHz   |
|                   |                            | 64                          | 64                 | 511.719 (LPM)  | 440.781 | 440.781   | 415.039 | 402.832   | 402.832 | MHz   |
|                   |                            |                             |                    | 476.563 (DFE)  |         |           |         |           |         |       |
|                   |                            |                             | 128                | 255.859 (LPM)  | 220.391 | 220.391   | 207.520 | 201.416   | 201.416 | MHz   |
|                   |                            |                             |                    | 238.281 (DFE)  |         |           |         |           |         |       |
|                   |                            | 20                          | 20                 | 409.375  | 352.625 | 352.625   | 332.032 | 352.625   | 322.266 | MHz   |
|                   |                            |                             | 40                 | 204.688  | 176.313 | 176.313   | 166.016 | 176.313   | 161.133 | MHz   |
|                   |                            | 40                          | 40                 | 664.063  | 664.063 | 664.063   | 664.063 | 664.063   | 644.531 | MHz   |
|                   |                            |                             | 80                 | 204.688  | 176.313 | 176.313   | 166.016 | 176.313   | 161.133 | MHz   |
|                   |                            | 80                          | 80                 | 409.375 (LPM)  | 352.625 | 352.625   | 332.031 | 352.625   | 322.266 | MHz   |
|                   |                            |                             |                    | 381.250 (DFE)  |         |           |         |           |         |       |
|                   |                            |                             | 160                | 204.688 (LPM)  | 176.313 | 176.313   | 166.016 | 176.313   | 161.133 | MHz   |
|                   |                            | 190.625 (DFE)               |                    |  |         |           |         |           |         |       |

**Notes:**

1. Clocking must be implemented as described in the *Versal ACAP GTY and GTYP Transceivers Architecture Manual (AM002)*.

Table 86: GTYP Transceiver User Clock Switching Characteristics

| Symbol                    | Description <sup>1</sup>                           | Data Width Conditions (Bit) |                    | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |           |         |           |         | Units |
|---------------------------|--|-----------------------------|--------------------|--|-----------|---------|-----------|---------|-------|
|                           |  |                             |                    | 0.88V (H)  | 0.80V (M) |         | 0.70V (L) |         |       |
|                           |  | Internal Logic              | Interconnect Logic | -3   | -2        | -1      | -2        | -1      |       |
| F <sub>TXOUTPMA</sub>     | TXOUTCLK maximum frequency sourced from OUTCLKPMA  |                             |                    | 664.063  | 664.063   | 664.063 | 664.063   | 644.531 | MHz   |
| F <sub>RXOUTPMA</sub>     | RXOUTCLK maximum frequency sourced from OUTCLKPMA  |                             |                    | 664.063  | 664.063   | 664.063 | 664.063   | 644.531 | MHz   |
| F <sub>TXOUTPROGDIV</sub> | TXOUTCLK maximum frequency sourced from OUTPROGDIV |                             |                    | 1024.000   | 1024.000  | 1000    | 664.063   | 644.531 | MHz   |
| F <sub>RXOUTPROGDIV</sub> | RXOUTCLK maximum frequency sourced from OUTPROGDIV |                             |                    | 1024.000   | 1024.000  | 1000    | 664.063   | 644.531 | MHz   |

Table 86: GTYP Transceiver User Clock Switching Characteristics (cont'd)

| Symbol            | Description <sup>1</sup>   | Data Width Conditions (Bit) |                    | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |           |         |           |         | Units |
|-------------------|----------------------------|-----------------------------|--------------------|--|-----------|---------|-----------|---------|-------|
|                   |                            |                             |                    | 0.88V (H)  | 0.80V (M) |         | 0.70V (L) |         |       |
|                   |                            | Internal Logic              | Interconnect Logic | -3   | -2        | -1      | -2        | -1      |       |
| F <sub>TXIN</sub> | TXUSRCLK maximum frequency | 16                          | 16                 | 511.719  | 440.781   | 415.039 | 402.832   | 402.832 | MHz   |
|                   |                            |                             | 32                 | 255.859  | 220.391   | 207.520 | 201.416   | 201.416 | MHz   |
|                   |                            | 32                          | 32                 | 511.719  | 440.781   | 415.039 | 402.832   | 402.832 | MHz   |
|                   |                            |                             | 64                 | 255.859  | 220.391   | 207.520 | 201.416   | 201.416 | MHz   |
|                   |                            | 64                          | 64                 | 511.719 (LPM)  | 500       | 415.039 | 402.832   | 402.832 | MHz   |
|                   |                            |                             |                    | 500 (DFE)  |           |         |           |         |       |
|                   |                            |                             | 128                | 255.859 (LPM)  | 250       | 207.520 | 201.416   | 201.416 | MHz   |
|                   |                            |                             |                    | 250 (DFE)  |           |         |           |         |       |
|                   |                            | 20                          | 20                 | 409.375  | 352.625   | 332.032 | 352.625   | 322.266 | MHz   |
|                   |                            |                             | 40                 | 204.688  | 176.313   | 166.016 | 176.313   | 161.133 | MHz   |
|                   |                            | 40                          | 40                 | 664.063  | 664.063   | 664.063 | 664.063   | 644.531 | MHz   |
|                   |                            |                             | 80                 | 204.688  | 176.313   | 166.016 | 176.313   | 161.133 | MHz   |
|                   |                            | 80                          | 80                 | 409.375 (LPM)  | 400       | 332.031 | 352.625   | 322.266 | MHz   |
|                   |                            |                             |                    | 400 (DFE)  |           |         |           |         |       |
|                   |                            |                             | 160                | 204.688 (LPM)  | 200       | 166.016 | 176.313   | 161.133 | MHz   |
|                   |                            | 200 (DFE)                   |                    |  |           |         |           |         |       |



**Table 86: GTYP Transceiver User Clock Switching Characteristics (cont'd)**

| Symbol            | Description <sup>1</sup>   | Data Width Conditions (Bit) |                    | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |           |         |           |         | Units |
|-------------------|----------------------------|-----------------------------|--------------------|--|-----------|---------|-----------|---------|-------|
|                   |                            |                             |                    | 0.88V (H)  | 0.80V (M) |         | 0.70V (L) |         |       |
|                   |                            | Internal Logic              | Interconnect Logic | -3   | -2        | -1      | -2        | -1      |       |
| F <sub>RXIN</sub> | RXUSRCLK maximum frequency | 16                          | 16                 | 511.719  | 440.781   | 415.039 | 402.832   | 402.832 | MHz   |
|                   |                            |                             | 32                 | 255.859  | 220.391   | 207.520 | 201.416   | 201.416 | MHz   |
|                   |                            | 32                          | 32                 | 511.719  | 440.781   | 415.039 | 402.832   | 402.832 | MHz   |
|                   |                            |                             | 64                 | 255.859  | 220.391   | 207.520 | 201.416   | 201.416 | MHz   |
|                   |                            | 64                          | 64                 | 511.719 (LPM)  | 500       | 415.039 | 402.832   | 402.832 | MHz   |
|                   |                            |                             |                    | 500 (DFE)  |           |         |           |         |       |
|                   |                            |                             | 128                | 255.859 (LPM)  | 250       | 207.520 | 201.416   | 201.416 | MHz   |
|                   |                            |                             |                    | 250 (DFE)  |           |         |           |         |       |
|                   |                            | 20                          | 20                 | 409.375  | 352.625   | 332.032 | 352.625   | 322.266 | MHz   |
|                   |                            |                             | 40                 | 204.688  | 176.313   | 166.016 | 176.313   | 161.133 | MHz   |
|                   |                            | 40                          | 40                 | 664.063  | 664.063   | 664.063 | 664.063   | 644.531 | MHz   |
|                   |                            |                             | 80                 | 204.688  | 176.313   | 166.016 | 176.313   | 161.133 | MHz   |
|                   |                            | 80                          | 80                 | 409.375 (LPM)  | 400       | 332.031 | 352.625   | 322.266 | MHz   |
|                   |                            |                             |                    | 400 (DFE)  |           |         |           |         |       |
| 160               | 204.688 (LPM)              |                             | 200                | 166.016  | 176.313   | 161.133 | MHz       |         |       |
| 200 (DFE)         |                            |                             |                    |  |           |         |           |         |       |

**Notes:**

1. Clocking must be implemented as described in the *Versal ACAP GTY and GTYP Transceivers Architecture Manual (AM002)*.

**GTY and GTYP Transceiver Transmitter and Receiver Switching Characteristics**

**Table 87: GTY and GTYP Transceiver Transmitter Switching Characteristics**

| Symbol               | Description                         | Condition   | Min | Typ | Max                 | Units |
|----------------------|-------------------------------------|-------------|-----|-----|---------------------|-------|
| F <sub>GTYTX</sub>   | Serial data rate range              |             | 1.2 | -   | F <sub>GTYMAX</sub> | Gb/s  |
| T <sub>RTX</sub>     | TX rise time                        | 20%–80%     | -   | 21  | -                   | ps    |
| T <sub>FTX</sub>     | TX fall time                        | 80%–20%     | -   | 21  | -                   | ps    |
| T <sub>LLSKEW</sub>  | TX lane-to-lane skew <sup>1</sup>   |             | -   | -   | 500.00              | ps    |
| T <sub>J32.75</sub>  | Total jitter <sup>2,4</sup>         | 32.75 Gb/s  | -   | -   | 0.35                | UI    |
| D <sub>J32.75</sub>  | Deterministic jitter <sup>2,4</sup> |             | -   | -   | 0.19                | UI    |
| T <sub>J28.21</sub>  | Total jitter <sup>2,4</sup>         | 28.21 Gb/s  | -   | -   | 0.28                | UI    |
| D <sub>J28.21</sub>  | Deterministic jitter <sup>2,4</sup> |             | -   | -   | 0.17                | UI    |
| T <sub>J16.375</sub> | Total jitter <sup>2,4</sup>         | 16.375 Gb/s | -   | -   | 0.28                | UI    |
| D <sub>J16.375</sub> | Deterministic jitter <sup>2,4</sup> |             | -   | -   | 0.17                | UI    |
| T <sub>J15.0</sub>   | Total jitter <sup>2,4</sup>         | 15.0 Gb/s   | -   | -   | 0.28                | UI    |
| D <sub>J15.0</sub>   | Deterministic jitter <sup>2,4</sup> |             | -   | -   | 0.17                | UI    |

Table 87: GTY and GTYP Transceiver Transmitter Switching Characteristics (cont'd)

| Symbol                      | Description                          | Condition    | Min | Typ | Max  | Units |
|-----------------------------|--------------------------------------|--------------|-----|-----|------|-------|
| T <sub>J14.1</sub>          | Total jitter <sup>2, 4</sup>         | 14.1 Gb/s    | -   | -   | 0.28 | UI    |
| D <sub>J14.1</sub>          | Deterministic jitter <sup>2, 4</sup> |              | -   | -   | 0.17 | UI    |
| T <sub>J14.1</sub>          | Total jitter <sup>2, 4</sup>         | 14.025 Gb/s  | -   | -   | 0.28 | UI    |
| D <sub>J14.1</sub>          | Deterministic jitter <sup>2, 4</sup> |              | -   | -   | 0.17 | UI    |
| T <sub>J13.1</sub>          | Total jitter <sup>2, 4</sup>         | 13.1 Gb/s    | -   | -   | 0.28 | UI    |
| D <sub>J13.1</sub>          | Deterministic jitter <sup>2, 4</sup> |              | -   | -   | 0.17 | UI    |
| T <sub>J12.5_LCPLL</sub>    | Total jitter <sup>2, 4</sup>         | 12.5 Gb/s    | -   | -   | 0.28 | UI    |
| D <sub>J12.5_LCPLL</sub>    | Deterministic jitter <sup>2, 4</sup> |              | -   | -   | 0.17 | UI    |
| T <sub>J12.5_RPLL</sub>     | Total jitter <sup>3, 4</sup>         | 12.5 Gb/s    | -   | -   | 0.33 | UI    |
| D <sub>J12.5_RPLL</sub>     | Deterministic jitter <sup>3, 4</sup> |              | -   | -   | 0.17 | UI    |
| T <sub>J11.3_LCPLL</sub>    | Total jitter <sup>2, 4</sup>         | 11.3 Gb/s    | -   | -   | 0.28 | UI    |
| D <sub>J11.3_LCPLL</sub>    | Deterministic jitter <sup>2, 4</sup> |              | -   | -   | 0.17 | UI    |
| T <sub>J10.3125_LCPLL</sub> | Total jitter <sup>2, 4</sup>         | 10.3125 Gb/s | -   | -   | 0.28 | UI    |
| D <sub>J10.3125_LCPLL</sub> | Deterministic jitter <sup>2, 4</sup> |              | -   | -   | 0.17 | UI    |
| T <sub>J10.3125_RPLL</sub>  | Total jitter <sup>3, 4</sup>         | 10.3125 Gb/s | -   | -   | 0.33 | UI    |
| D <sub>J10.3125_RPLL</sub>  | Deterministic jitter <sup>3, 4</sup> |              | -   | -   | 0.17 | UI    |
| T <sub>J9.953_LCPLL</sub>   | Total jitter <sup>2, 4</sup>         | 9.953 Gb/s   | -   | -   | 0.28 | UI    |
| D <sub>J9.953_LCPLL</sub>   | Deterministic jitter <sup>2, 4</sup> |              | -   | -   | 0.17 | UI    |
| T <sub>J9.953_RPLL</sub>    | Total jitter <sup>3, 4</sup>         | 9.953 Gb/s   | -   | -   | 0.33 | UI    |
| D <sub>J9.953_RPLL</sub>    | Deterministic jitter <sup>3, 4</sup> |              | -   | -   | 0.17 | UI    |
| T <sub>J8.0</sub>           | Total jitter <sup>3, 4</sup>         | 8.0 Gb/s     | -   | -   | 0.32 | UI    |
| D <sub>J8.0</sub>           | Deterministic jitter <sup>3, 4</sup> |              | -   | -   | 0.17 | UI    |
| T <sub>J6.6</sub>           | Total jitter <sup>3, 4</sup>         | 6.6 Gb/s     | -   | -   | 0.30 | UI    |
| D <sub>J6.6</sub>           | Deterministic jitter <sup>3, 4</sup> |              | -   | -   | 0.15 | UI    |
| T <sub>J5.0</sub>           | Total jitter <sup>3, 4</sup>         | 5.0 Gb/s     | -   | -   | 0.30 | UI    |
| D <sub>J5.0</sub>           | Deterministic jitter <sup>3, 4</sup> |              | -   | -   | 0.15 | UI    |
| T <sub>J4.25</sub>          | Total jitter <sup>3, 4</sup>         | 4.25 Gb/s    | -   | -   | 0.30 | UI    |
| D <sub>J4.25</sub>          | Deterministic jitter <sup>3, 4</sup> |              | -   | -   | 0.15 | UI    |
| T <sub>J3.20</sub>          | Total jitter <sup>3, 4</sup>         | 3.20 Gb/s    | -   | -   | 0.20 | UI    |
| D <sub>J3.20</sub>          | Deterministic jitter <sup>3, 4</sup> |              | -   | -   | 0.10 | UI    |
| T <sub>J2.5</sub>           | Total jitter <sup>3, 4</sup>         | 2.5 Gb/s     | -   | -   | 0.20 | UI    |
| D <sub>J2.5</sub>           | Deterministic jitter <sup>3, 4</sup> |              | -   | -   | 0.10 | UI    |
| T <sub>J1.25</sub>          | Total jitter <sup>3, 4</sup>         | 1.25 Gb/s    | -   | -   | 0.15 | UI    |
| D <sub>J1.25</sub>          | Deterministic jitter <sup>3, 4</sup> |              | -   | -   | 0.06 | UI    |

**Notes:**

- Using same REFCLK input with TX phase alignment enabled for up to four consecutive transmitters (one fully populated GTY or GTYP Quad) at maximum line rate.
- Using LCPLL\_FBDIV = 40, 20-bit internal data width. These values are NOT intended for protocol specific compliance determinations.
- Using RPLL\_FBDIV = 10, 20-bit internal data width. These values are NOT intended for protocol specific compliance determinations.
- All jitter values are based on a bit-error ratio of 10<sup>-12</sup>.

Table 88: GTY and GTYP Transceiver Receiver Switching Characteristics

| Symbol                                 | Description                            | Condition                             | Min   | Typ | Max                 | Units |
|--|--|---------------------------------------|-------|-----|---------------------|-------|
| F <sub>GTYRX</sub>                     | Serial data rate                       |                                       | 1.2   | -   | F <sub>GTYMAX</sub> | Gb/s  |
| R <sub>XSSST</sub>                     | Receiver spread-spectrum tracking      | Modulated at 33 kHz                   | -5000 | -   | 0                   | ppm   |
| R <sub>XRLL</sub>                      | Run length (CID)                       |                                       | -     | -   | 256                 | UI    |
| R <sub>XPPMTOL</sub>                   | Data/REFCLK PPM offset tolerance       | Bit rates ≤ 6.6 Gb/s                  | -1250 | -   | 1250                | ppm   |
|  |  | Bit rates > 6.6 Gb/s and ≤ 8.0 Gb/s   | -700  | -   | 700                 | ppm   |
|  |  | Bit rates > 8.0 Gb/s and ≤ 16.3 Gb/s  | -600  | -   | 600                 | ppm   |
|  |  | Bit rates > 16.3 Gb/s and ≤ 24.0 Gb/s | -350  | -   | 350                 | ppm   |
|  |  | Bit rates > 24.0 Gb/s                 | -200  | -   | 200                 | ppm   |
| <b>SJ Jitter Tolerance<sup>1</sup></b> |  |                                       |       |     |                     |       |
| J <sub>T_SJ32.75</sub>                 | Sinusoidal jitter (LCPLL) <sup>2</sup> | 32.75 Gb/s                            | 0.25  | -   | -                   | UI    |
| J <sub>T_SJ28.21</sub>                 | Sinusoidal jitter (LCPLL) <sup>2</sup> | 28.21 Gb/s                            | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ16.375</sub>                | Sinusoidal jitter (LCPLL) <sup>2</sup> | 16.375 Gb/s                           | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ15.0</sub>                  | Sinusoidal jitter (LCPLL) <sup>2</sup> | 15.0 Gb/s                             | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ14.1</sub>                  | Sinusoidal jitter (LCPLL) <sup>2</sup> | 14.1 Gb/s                             | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ13.1</sub>                  | Sinusoidal jitter (LCPLL) <sup>2</sup> | 13.1 Gb/s                             | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ12.5</sub>                  | Sinusoidal jitter (LCPLL) <sup>2</sup> | 12.5 Gb/s                             | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ11.3</sub>                  | Sinusoidal jitter (LCPLL) <sup>2</sup> | 11.3 Gb/s                             | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ10.32_LCPLL</sub>           | Sinusoidal jitter (LCPLL) <sup>2</sup> | 10.32 Gb/s                            | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ10.32_RPLL</sub>            | Sinusoidal jitter (RPLL) <sup>2</sup>  | 10.32 Gb/s                            | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ9.953_LCPLL</sub>           | Sinusoidal jitter (LCPLL) <sup>2</sup> | 9.953 Gb/s                            | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ9.953_RPLL</sub>            | Sinusoidal jitter (RPLL) <sup>2</sup>  | 9.953 Gb/s                            | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ8.0</sub>                   | Sinusoidal jitter (RPLL) <sup>2</sup>  | 8.0 Gb/s                              | 0.42  | -   | -                   | UI    |
| J <sub>T_SJ6.6</sub>                   | Sinusoidal jitter (RPLL) <sup>2</sup>  | 6.6 Gb/s                              | 0.42  | -   | -                   | UI    |
| J <sub>T_SJ5.0</sub>                   | Sinusoidal jitter (RPLL) <sup>2</sup>  | 5.0 Gb/s                              | 0.42  | -   | -                   | UI    |
| J <sub>T_SJ4.25</sub>                  | Sinusoidal jitter (RPLL) <sup>2</sup>  | 4.25 Gb/s                             | 0.44  | -   | -                   | UI    |
| J <sub>T_SJ3.2</sub>                   | Sinusoidal jitter (RPLL) <sup>2</sup>  | 3.2 Gb/s                              | 0.45  | -   | -                   | UI    |
| J <sub>T_SJ2.5</sub>                   | Sinusoidal jitter (RPLL) <sup>2</sup>  | 2.5 Gb/s                              | 0.30  | -   | -                   | UI    |
| J <sub>T_SJ1.25</sub>                  | Sinusoidal jitter (RPLL) <sup>2</sup>  | 1.25 Gb/s                             | 0.30  | -   | -                   | UI    |

**Notes:**

1. All jitter values are based on a bit error ratio of 10<sup>-12</sup>.
2. The frequency of the injected sinusoidal jitter is 10 MHz.

## GTY and GTYP Transceiver Electrical Compliance

The *Versal ACAP GTY and GTYP Transceivers Architecture Manual (AM002)* contains recommended use modes that ensure compliance for the protocols listed in the following table. The transceiver wizard provides the recommended settings for those use cases and for protocol specific characteristics.

Table 89: GTY and GTYP Transceiver Protocol List

| Protocol                      | Specification                                    | Serial Rate (Gb/s) | Electrical Compliance  |
|-------------------------------|--|--------------------|------------------------|
| CAUI-4                        | IEEE 802.3-2012                                  | 25.78125           | Compliant              |
| 28 Gb/s backplane             | CEI-25G-LR                                       | 25–28.05           | Compliant              |
| Interlaken                    | OIF-CEI-6G, OIF-CEI-11GSR, OIF-CEI-28G-MR        | 4.25–25.78125      | Compliant              |
| 100GBASE-KR4                  | IEEE 802.3bj-2014, CEI-25G-LR                    | 25.78125           | Compliant <sup>1</sup> |
| 100GBASE-CR4                  | IEEE 802.3bj-2014, CEI-25G-LR                    | 25.78125           | Compliant <sup>1</sup> |
| 50GBASE-KR4                   | IEEE 802.3by-2014, CEI-25G-LR                    | 25.78125           | Compliant <sup>1</sup> |
| 50GBASE-CR4                   | IEEE 802.3by-2014, CEI-25G-LR                    | 25.78125           | Compliant <sup>1</sup> |
| 25GBASE-KR4                   | IEEE 802.3by-2014, CEI-25G-LR                    | 25.78125           | Compliant <sup>1</sup> |
| 25GBASE-CR4                   | IEEE 802.3by-2014, CEI-25G-LR                    | 25.78125           | Compliant <sup>1</sup> |
| OTU4 (OTL4.4) CFP2            | OIF-CEI-28G-VSR                                  | 27.952493–32.75    | Compliant              |
| OTU4 (OTL4.4) CFP             | OIF-CEI-11G-MR                                   | 11.18–13.1         | Compliant              |
| CAUI-10                       | IEEE 802.3-2012                                  | 10.3125            | Compliant              |
| nPPI                          | IEEE 802.3-2012                                  | 10.3125            | Compliant              |
| 10GBASE-KR <sup>2</sup>       | IEEE 802.3-2012                                  | 10.3125            | Compliant              |
| SFP+                          | SFF-8431 (SR and LR)                             | 9.95328–11.10      | Compliant              |
| XFP                           | INF-8077i, revision 4.5                          | 10.3125            | Compliant              |
| RXAUI                         | CEI-6G-SR  | 6.25               | Compliant              |
| XAUI                          | IEEE 802.3-2012                                  | 3.125              | Compliant              |
| 1000BASE-X                    | IEEE 802.3-2012                                  | 1.25               | Compliant              |
| 5.0G Ethernet                 | IEEE 802.3bx (PAR)                               | 5                  | Compliant              |
| 2.5G Ethernet                 | IEEE 802.3bx (PAR)                               | 2.5                | Compliant              |
| HiGig, HiGig+, HiGig2         | IEEE 802.3-2012                                  | 3.74, 6.6          | Compliant              |
| QSGMII                        | QSGMII v1.2 (Cisco System, ENG-46158)            | 5                  | Compliant              |
| OTU2                          | ITU G.8251                                       | 10.709225          | Compliant              |
| OTU4 (OTL4.10)                | OIF-CEI-11G-SR                                   | 11.180997          | Compliant              |
| OC-3/12/48/192                | GR-253-CORE                                      | 0.1555–9.956       | Compliant              |
| PCIe Gen1, 2, 3               | PCI Express base 3.0                             | 2.5, 5.0, and 8.0  | Compliant              |
| SDI <sup>3</sup>              | SMPTE 424M-2006                                  | 0.27–2.97          | Compliant              |
| UHD-SDI <sup>3</sup>          | SMPTE ST-2081 6G, SMPTE ST-2082 12G              | 6 and 12           | Compliant              |
| Hybrid memory cube (HMC)      | HMC-15G-SR                                       | 10, 12.5, and 15.0 | Compliant              |
| MoSys bandwidth engine        | CEI-11-SR and CEI-11-SR (overclocked)            | 10.3125, 15.5      | Compliant              |
| CPRI                          | CPRI_v_6_1_2014-07-01                            | 0.6144–12.165      | Compliant              |
| Passive optical network (PON) | 10G-EPON, 1G-EPON, NG-PON2, XG-PON, and 2.5G-PON | 0.155–10.3125      | Compliant              |
| JESD204a/b                    | OIF-CEI-6G, OIF-CEI-11G                          | 3.125–12.5         | Compliant              |
| Serial RapidIO                | RapidIO specification 3.1                        | 1.25–10.3125       | Compliant              |
| DisplayPort                   | DP 1.2B CTS                                      | 1.62–5.4           | Compliant <sup>3</sup> |
| Fibre channel                 | FC-PI-4  | 1.0625–14.025      | Compliant              |
| SATA Gen1, 2, 3               | Serial ATA revision 3.0 specification            | 1.5, 3.0, and 6.0  | Compliant              |
| SAS Gen1, 2, 3                | T10/BSR INCITS 519                               | 3.0, 6.0, and 12.0 | Compliant              |
| SFI-5                         | OIF-SFI5-01.0                                    | 0.625 - 12.5       | Compliant              |

Table 89: GTY and GTYP Transceiver Protocol List (cont'd)

| Protocol | Specification      | Serial Rate (Gb/s) | Electrical Compliance |
|----------|--------------------|--------------------|-----------------------|
| Aurora   | CEI-6G, CEI-11G-LR | All rates          | Compliant             |

**Notes:**

1. 25 dB loss at Nyquist without FEC.
2. The transition time of the transmitter is faster than the IEEE Std 802.3-2012 specification.
3. This protocol requires external circuitry to achieve compliance.

## Integrated Block for MRMAC

More information and documentation on solutions using the multirate Ethernet MAC (MRMAC) can be found at *Versal Devices Integrated 100G Multirate Ethernet MAC (MRMAC) LogiCORE IP Product Guide (PG314)*. The *Versal Architecture and Product Data Sheet: Overview (DS950)* lists how many blocks are in each Versal AI Core device.

Table 90: Maximum Performance for MRMAC Designs

| Symbol                                      | Description <sup>1</sup>                         | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |         |           |         |           |         | Units |
|---|--|--|---------|-----------|---------|-----------|---------|-------|
|   |  | 0.88V (H)  |         | 0.80V (M) |         | 0.70V (L) |         |       |
|   |  | -3   | -2      | -2        | -1      | -2        | -1      |       |
| F <sub>RX_CORE_CLK</sub>                    | Receive core clock                               | 725.000  | 705.250 | 705.250   | 664.063 | 705.250   | 644.531 | MHz   |
| F <sub>TX_CORE_CLK</sub>                    | Transmit core clock                              | 725.000  | 705.250 | 705.250   | 664.063 | 705.250   | 644.531 | MHz   |
| F <sub>RX_AXIS_CLK</sub>                    | Receive AXI4-Stream interface clock              | 431.762  | 420.000 | 420.000   | 420.000 | 420.000   | 322.266 | MHz   |
| F <sub>TX_AXIS_CLK</sub>                    | Transmit AXI4-Stream interface clock             | 431.762  | 420.000 | 420.000   | 420.000 | 420.000   | 322.266 | MHz   |
| F <sub>RX_SERDES_CLK</sub>                  | Serializer/deserializer clock                    | 725.000  | 664.063 | 664.063   | 664.063 | 664.063   | 644.531 | MHz   |
| F <sub>RX_ALT_SERDES_CLK</sub> <sup>2</sup> | Receive alternate serializer/deserializer clock  | 362.500  | 352.625 | 352.625   | 332.031 | 352.625   | 322.266 | MHz   |
| F <sub>TX_ALT_SERDES_CLK</sub> <sup>2</sup> | Transmit alternate serializer/deserializer clock | 362.500  | 352.625 | 352.625   | 332.031 | 352.625   | 322.266 | MHz   |
| F <sub>RX_TS_CLK</sub>                      | Receive timestamp clock                          | 350.000  | 350.000 | 350.000   | 350.000 | 350.000   | 350.000 | MHz   |
| F <sub>TX_TS_CLK</sub>                      | Transmit timestamp clock                         | 350.000  | 350.000 | 350.000   | 350.000 | 350.000   | 350.000 | MHz   |
| F <sub>RX_FLEXIF_CLK</sub>                  | Receive flex interface clock                     | 431.762  | 420.000 | 420.000   | 420.000 | 420.000   | 322.266 | MHz   |
| F <sub>TX_FLEXIF_CLK</sub>                  | Transmit flex interface clock                    | 431.762  | 420.000 | 420.000   | 420.000 | 420.000   | 322.266 | MHz   |
| F <sub>APB3_CLK</sub>                       | AMBA® advance peripheral bus (APB3) clock        | 300.000  | 300.000 | 300.000   | 300.000 | 300.000   | 300.000 | MHz   |

**Notes:**

1. Overclocking is only supported in 100 GbE (with F<sub>RX\_CORE\_CLK</sub> and F<sub>TX\_CORE\_CLK</sub> running at 706 MHz, and the F<sub>RX\_SERDES\_CLK</sub> running at 353 MHz) by faster speed grade devices (-3H, -2M, -2L).
2. The ALT\_SERDES\_CLKs run at half the speed of the primary SERDES\_CLK. See *Versal Devices Integrated 100G Multirate Ethernet MAC (MRMAC) LogiCORE IP Product Guide (PG314)* for more information.

## Programmable Logic Integrated Block for PCIe

More information and documentation on solutions for PCI Express® designs can be found at [PCI Express](#). The *Versal Architecture and Product Data Sheet: Overview (DS950)* lists how many blocks are in each Versal device.

**Table 91: Maximum Performance for Programmable Logic Integrated Block for PCIe Rev. 4.0**

| Symbol               | Description <sup>1</sup>     | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |     |           |     |           |     | Units |
|----------------------|------------------------------|--|-----|-----------|-----|-----------|-----|-------|
|                      |                              | 0.88V (H)  |     | 0.80V (M) |     | 0.70V (L) |     |       |
|                      |                              | -3   | -2  | -2        | -1  | -2        | -1  |       |
| F <sub>PIPECLK</sub> | Pipe clock maximum frequency | 500  | 500 | 500       | 500 | 500       | 500 | MHz   |
| F <sub>CORECLK</sub> | Core clock maximum frequency | 500  | 500 | 500       | 500 | 500       | 500 | MHz   |
| F <sub>APBCLK</sub>  | APB clock maximum frequency  | 250  | 250 | 250       | 250 | 250       | 250 | MHz   |

**Notes:**

1. PCI Express Gen4 operation is supported for x1, x2, x4, and x8 widths.

**Table 92: Maximum Performance for Programmable Logic Integrated Block for PCIe Rev. 5.0**

| Symbol               | Description <sup>1, 2, 3</sup> | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |     |           |     |           |     | Units |
|----------------------|--------------------------------|--|-----|-----------|-----|-----------|-----|-------|
|                      |                                | 0.88V (H)  |     | 0.80V (M) |     | 0.70V (L) |     |       |
|                      |                                | -3   | -2  | -2        | -1  | -2        | -1  |       |
| F <sub>PIPECLK</sub> | Pipe clock maximum frequency   | 500  | 500 | 500       | 500 | 500       | 500 | MHz   |
| F <sub>CORECLK</sub> | Core clock maximum frequency   | 500  | 500 | 500       | 500 | 500       | 500 | MHz   |
| F <sub>APBCLK</sub>  | APB clock maximum frequency    | 250  | 250 | 250       | 250 | 250       | 250 | MHz   |

**Notes:**

1. PCI Express Gen5 operation is supported for x1, x2, and x4 widths.
2. PCI Express Gen5 operation is supported in -3H, -2H, and -2M speed grades.
3. PCI Express Gen4 operation is supported for x1, x2, x4, and x8 widths.

## Integrated Blocks for PCIe with DMA and Cache Coherent Interconnect (CPM)

More information and documentation on solutions for PCI Express® designs can be found at [PCI Express](#). The *Versal Architecture and Product Data Sheet: Overview (DS950)* lists how many blocks are in each Versal device.

**Table 93: Maximum Performance for Streaming Mode Interface of Integrated Block for PCIe Rev. 4.0 with DMA and CCIX Rev. 1.0 (CPM4)**

| Symbol   | Description   | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |         |           |         |           |     | Units |
|--|---|--|---------|-----------|---------|-----------|-----|-------|
|  |   | 0.88V (H)  |         | 0.80V (M) |         | 0.70V (L) |     |       |
|  |   | -3   | -2      | -2        | -1      | -2        | -1  |       |
| <b>PCIe Up To Gen3x16 With One Link With 512-bit Interface</b> |   |  |         |           |         |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>                                   | CPM user clock maximum frequency  | 250  | 250     | 250       | 250     | 250       | 250 | MHz   |
| <b>PCIe Up To Gen4x8 With Two Links With 512-bit Interface</b> |   |  |         |           |         |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>                                   | CPM user clock maximum frequency  | 250  | 250     | 250       | 250     | 250       | 250 | MHz   |
| <b>CCIX Up To Gen3x16 With One Link With 512-bit Interface</b> |   |  |         |           |         |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>                                   | CPM user clock maximum frequency  | 250  | 250     | 250       | 250     | 250       | 250 | MHz   |
| F <sub>CPM_CHICLK_MAX</sub>                                    | CPM AMBA® coherent hub interface (CHI) clock maximum frequency <sup>1</sup> | 390  | 390     | 390       | 312     | 312       | 250 | MHz   |
| <b>CCIX Up To Gen4x8 With Two Links With 512-bit Interface</b> |   |  |         |           |         |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>                                   | CPM user clock maximum frequency  | 250  | 250     | 250       | 250     | 250       | 250 | MHz   |
| F <sub>CPM_CHICLK_MAX</sub>                                    | CPM CHI clock maximum frequency <sup>1</sup>                                | 390  | 390     | 390       | 312     | 312       | 250 | MHz   |
| <b>CCIX Up To 20 Gb/s x8 With Two Links</b>                    |   |  |         |           |         |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>                                   | CPM user clock maximum frequency  | 156.125  | 156.125 | 156.125   | 156.125 | 156.125   | N/A | MHz   |
| F <sub>CPM_CHICLK_MAX</sub>                                    | CPM CHI clock maximum frequency <sup>1</sup>                                | 390  | 390     | 390       | 312     | 312       | N/A | MHz   |
| <b>CCIX Up To 25 Gb/s x8 With Two Links</b>                    |   |  |         |           |         |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>                                   | CPM user clock maximum frequency  | 195.312  | 195.312 | 195.312   | N/A     | N/A       | N/A | MHz   |
| F <sub>CPM_CHICLK_MAX</sub>                                    | CPM CHI clock maximum frequency <sup>1</sup>                                | 390  | 390     | 390       | N/A     | N/A       | N/A | MHz   |

**Notes:**

1. The CHI clock domain is for the CHI interface that connects the coherent hub to the programmable logic.

**Table 94: Maximum Performance for DMA Streaming Mode Interface of Integrated Block for PCIe Rev. 4.0 with DMA and CCIX Rev. 1.0 (CPM4)**

| Symbol   | Description                      | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |     |           |     |           |     | Units |
|--|----------------------------------|--|-----|-----------|-----|-----------|-----|-------|
|  |                                  | 0.88V (H)  |     | 0.80V (M) |     | 0.70V (L) |     |       |
|  |                                  | -3   | -2  | -2        | -1  | -2        | -1  |       |
| <b>PCIe Up To Gen3x16 With One Link With 512-bit Interface</b> |                                  |  |     |           |     |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>                                   | CPM user clock maximum frequency | 250  | 250 | 250       | 250 | 250       | 250 | MHz   |
| <b>PCIe Up To Gen4x8 With One Link With 512-bit Interface</b>  |                                  |  |     |           |     |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>                                   | CPM user clock maximum frequency | 250  | 250 | 250       | 250 | 250       | 250 | MHz   |

**Table 95: Maximum Performance for DMA Memory-Mapped AXI4 Mode Interface of Integrated Block for PCIe Rev. 4.0 with DMA and CCIX Rev. 1.0 (CPM4)**

| Symbol                                 | Description <sup>1</sup>         | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |     |           |     |           |     | Units |
|--|----------------------------------|--|-----|-----------|-----|-----------|-----|-------|
|  |                                  | 0.88V (H)  |     | 0.80V (M) |     | 0.70V (L) |     |       |
|  |                                  | -3   | -2  | -2        | -1  | -2        | -1  |       |
| <b>PCIe® Gen4x16 With One Link</b>     |                                  |  |     |           |     |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>           | CPM user clock maximum frequency | 500  | 500 | N/A       | N/A | N/A       | N/A | MHz   |
| <b>PCIe Up To Gen4x8 With One Link</b> |                                  |  |     |           |     |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>           | CPM user clock maximum frequency | 250  | 250 | 250       | 250 | 250       | 250 | MHz   |

**Notes:**

1. All clock frequencies shown are for informational purposes only. The CPM user clock is actually internal to the CPM block and cannot be set by the PL because the DMA is operating through hard memory-mapped AXI4 interfaces to the NoC.

**Table 96: Maximum Performance for Streaming Mode Interface of Integrated Block for PCIe Rev. 5.0 with DMA and CCIX Rev. 1.1 (CPM5)**

| Symbol  | Description                                  | Mode      | Speed Grade and V <sub>CCINT_CPM5</sub> <sup>1</sup> Operating Voltage |         |           |         |           | Units |
|---|--|-----------|--|---------|-----------|---------|-----------|-------|
|   |  |           | 0.88V (H)  |         | 0.80V (M) |         | 0.70V (L) |       |
|   |  |           | -3   | -2      | -1        | -2      | -1        |       |
| <b>PCIe Up To Gen3x16 With One Link With 512-bit Interface</b>  |  |           |  |         |           |         |           |       |
| F <sub>CPM_USERCLK_MAX</sub>                                    | CPM user clock maximum frequency             | Standard  | 250  | 250     | 250       | 250     | 250       | MHz   |
|   |  | Overdrive | N/A  | 250     | N/A       | 250     | 250       | MHz   |
| <b>PCIe Up To Gen4x8 With Two Links With 512-bit Interface</b>  |  |           |  |         |           |         |           |       |
| F <sub>CPM_USERCLK_MAX</sub>                                    | CPM user clock maximum frequency             | Standard  | 250  | 250     | 250       | 250     | 250       | MHz   |
|   |  | Overdrive | N/A  | 250     | N/A       | 250     | 250       | MHz   |
| <b>PCIe Up To Gen4x16 With One Link With 1024-bit Interface</b> |  |           |  |         |           |         |           |       |
| F <sub>CPM_USERCLK_MAX</sub>                                    | CPM user clock maximum frequency             | Standard  | 250  | N/A     | N/A       | N/A     | N/A       | MHz   |
|   |  | Overdrive | N/A  | 250     | N/A       | 250     | N/A       | MHz   |
| <b>Up to Gen5x8 With Two Links Up To 1024-bit Interface</b>     |  |           |  |         |           |         |           |       |
| F <sub>CPM_USERCLK_MAX</sub>                                    | CPM user clock maximum frequency             | Standard  | 250  | N/A     | N/A       | N/A     | N/A       | MHz   |
|   |  | Overdrive | N/A  | 250     | N/A       | 250     | N/A       | MHz   |
| <b>CCIX Up To Gen3x16 With 512-bit Interface</b>                |  |           |  |         |           |         |           |       |
| F <sub>CPM_USERCLK_MAX</sub>                                    | CPM user clock maximum frequency             | Standard  | 250  | 250     | 250       | 250     | 250       | MHz   |
|   |  | Overdrive | N/A  | 250     | N/A       | 250     | 250       | MHz   |
| F <sub>CPM_CHICLK_MAX</sub>                                     | CPM CHI clock maximum frequency <sup>2</sup> | Standard  | 390  | 390     | 312       | 312     | 250       | MHz   |
|   |  | Overdrive | N/A  | 390     | N/A       | 312     | 312       | MHz   |
| <b>CCIX Up To Gen4x8 With One Link With 512-bit Interface</b>   |  |           |  |         |           |         |           |       |
| F <sub>CPM_USERCLK_MAX</sub>                                    | CPM user clock maximum frequency             | Standard  | 250  | 250     | 250       | 250     | 250       | MHz   |
|   |  | Overdrive | N/A  | 250     | N/A       | 250     | 250       | MHz   |
| F <sub>CPM_CHICLK_MAX</sub>                                     | CPM CHI clock maximum frequency <sup>2</sup> | Standard  | 390  | 390     | 312       | 312     | 250       | MHz   |
|   |  | Overdrive | N/A  | 390     | N/A       | 312     | 312       | MHz   |
| <b>CCIX Up To 20 Gb/s x8 With Two Links</b>                     |  |           |  |         |           |         |           |       |
| F <sub>CPM_USERCLK_MAX</sub>                                    | CPM user clock maximum frequency             | Standard  | 156.125  | 156.125 | 156.125   | 156.125 | N/A       | MHz   |
|   |  | Overdrive | N/A  | 156.125 | N/A       | 156.125 | N/A       | MHz   |



**Table 96: Maximum Performance for Streaming Mode Interface of Integrated Block for PCIe Rev. 5.0 with DMA and CCIX Rev. 1.1 (CPM5) (cont'd)**

| Symbol                                      | Description                                  | Mode      | Speed Grade and V <sub>CCINT_CPM5</sub> <sup>1</sup> Operating Voltage |           |     |           |     | Units |
|---|--|-----------|--|-----------|-----|-----------|-----|-------|
|   |  |           | 0.88V (H)  | 0.80V (M) |     | 0.70V (L) |     |       |
|   |  |           | -3   | -2        | -1  | -2        | -1  |       |
| F <sub>CPM_CHICLK_MAX</sub>                 | CPM CHI clock maximum frequency <sup>2</sup> | Standard  | 390  | 390       | 312 | 312       | N/A | MHz   |
|   |  | Overdrive | N/A  | 390       | N/A | 312       | N/A | MHz   |
| <b>CCIX Up To 25 Gb/s x8 With Two Links</b> |  |           |  |           |     |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>                | CPM user clock maximum frequency             | Standard  | 195.312  | 195.312   | N/A | N/A       | N/A | MHz   |
|   |  | Overdrive | N/A  | 195.312   | N/A | N/A       | N/A | MHz   |
| F <sub>CPM_CHICLK_MAX</sub>                 | CPM CHI clock maximum frequency <sup>2</sup> | Standard  | 390  | 390       | N/A | N/A       | N/A | MHz   |
|   |  | Overdrive | N/A  | 390       | N/A | N/A       | N/A | MHz   |
| <b>CCIX Up To Gen4x16 With One Link</b>     |  |           |  |           |     |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>                | CPM user clock maximum frequency             | Standard  | 250  | N/A       | N/A | N/A       | N/A | MHz   |
|   |  | Overdrive | N/A  | 250       | N/A | 250       | N/A | MHz   |
| F <sub>CPM_CHICLK_MAX</sub>                 | CPM CHI clock maximum frequency <sup>2</sup> | Standard  | 390  | N/A       | N/A | N/A       | N/A | MHz   |
|   |  | Overdrive | N/A  | 390       | N/A | 312       | N/A | MHz   |
| <b>CCIX Up To Gen5x8 With Two Links</b>     |  |           |  |           |     |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>                | CPM user clock maximum frequency             | Standard  | 250  | N/A       | N/A | N/A       | N/A | MHz   |
|   |  | Overdrive | N/A  | 250       | N/A | 250       | N/A | MHz   |
| F <sub>CPM_CHICLK_MAX</sub>                 | CPM CHI clock maximum frequency <sup>2</sup> | Standard  | 390  | N/A       | N/A | N/A       | N/A | MHz   |
|   |  | Overdrive | N/A  | 390       | N/A | 312       | N/A | MHz   |

**Notes:**

1. See the [Available Speed Grades and Operating Voltages](#) for further information on the dual-voltage operation CPM5 supplies in overdrive mode (0.88V) or standard drive mode (0.70V/0.80V).
2. The CHI clock domain is for the CHI interface that connects the coherent hub to the programmable logic.

**Table 97: Maximum Performance for DMA Streaming Mode Interface of Integrated Block for PCIe Rev. 5.0 with DMA and CCIX Rev. 1.1 (CPM5)**

| Symbol  | Description                                  | Mode      | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |           |     |           |     | Units |
|---|--|-----------|--|-----------|-----|-----------|-----|-------|
|   |  |           | 0.88V (H)  | 0.80V (M) |     | 0.70V (L) |     |       |
|   |  |           | -3   | -2        | -1  | -2        | -1  |       |
| <b>PCIe® Up To Gen3x16 With One DMA instance With 512-bit Interface</b> |  |           |  |           |     |           |     |       |
| F <sub>CPM_DMACLK_MAX</sub>   | CPM DMA to PL user clock maximum frequency   | Standard  | 433  | 400       | 300 | 250       | 250 | MHz   |
|   |  | Overdrive | N/A  | 433       | N/A | 433       | 433 | MHz   |
| <b>PCIe Up To Gen4x8 With Two DMA Instances With 512-bit Interface</b>  |  |           |  |           |     |           |     |       |
| F <sub>CPM_DMACLK_MAX</sub>   | CPM DMA to PL (user) clock maximum frequency | Standard  | 433  | 400       | 300 | 250       | 250 | MHz   |
|   |  | Overdrive | N/A  | 433       | N/A | 433       | 433 | MHz   |
| <b>PCIe Up To Gen4x16 With One DMA Instance</b>                         |  |           |  |           |     |           |     |       |
| F <sub>CPM_DMACLK_MAX</sub>   | CPM DMA to PL (user) clock maximum frequency | Standard  | 433  | N/A       | N/A | N/A       | N/A | MHz   |
|   |  | Overdrive | N/A  | 433       | N/A | 433       | N/A | MHz   |

**Table 97: Maximum Performance for DMA Streaming Mode Interface of Integrated Block for PCIe Rev. 5.0 with DMA and CCIX Rev. 1.1 (CPM5) (cont'd)**

| Symbol  | Description                                  | Mode      | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |           |     |           |     | Units |
|---|--|-----------|--|-----------|-----|-----------|-----|-------|
|   |  |           | 0.88V (H)  | 0.80V (M) |     | 0.70V (L) |     |       |
|   |  |           | -3   | -2        | -1  | -2        | -1  |       |
| <b>CPM5 Configuration With Two Gen5x8 DMA Instances</b> |  |           |  |           |     |           |     |       |
| F <sub>CPM_DMACLK_MAX</sub>                             | CPM DMA to PL (user) clock maximum frequency | Standard  | 433  | N/A       | N/A | N/A       | N/A | MHz   |
|   |  | Overdrive | N/A  | 433       | N/A | 433       | N/A | MHz   |

**Table 98: Maximum Performance for DMA Memory-Mapped AXI4 Mode Interface of Integrated Block for PCIe Rev. 5.0 with DMA and CCIX Rev. 1.1 (CPM5)**

| Symbol  | Description                      | Mode      | Performance as a Function of Speed Grade and Operating Voltage (V <sub>CCINT</sub> ) |           |     |           |     | Units |
|---|----------------------------------|-----------|--|-----------|-----|-----------|-----|-------|
|   |                                  |           | 0.88V (H)  | 0.80V (M) |     | 0.70V (L) |     |       |
|   |                                  |           | -3   | -2        | -1  | -2        | -1  |       |
| <b>PCIe® Up To Gen3x16 With One DMA Instance With 512-bit Interface</b> |                                  |           |  |           |     |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>  | CPM user clock maximum frequency | Standard  | 250  | 250       | 250 | 250       | 250 | MHz   |
|   |                                  | Overdrive | N/A  | 250       | N/A | 250       | 250 | MHz   |
| <b>PCIe Up To Gen4x8 With Two DMA Instances With 512-bit Interface</b>  |                                  |           |  |           |     |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>  | CPM user clock maximum frequency | Standard  | 250  | 250       | 250 | 250       | 250 | MHz   |
|   |                                  | Overdrive | N/A  | 250       | N/A | 250       | 250 | MHz   |
| <b>PCIe® Up To Gen4x16 With One DMA Instance</b>                        |                                  |           |  |           |     |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>  | CPM user clock maximum frequency | Standard  | 250  | N/A       | N/A | N/A       | N/A | MHz   |
|   |                                  | Overdrive | N/A  | 250       | N/A | 250       | N/A | MHz   |
| <b>CPM5 Configuration With Two Gen5x8 Instances</b>                     |                                  |           |  |           |     |           |     |       |
| F <sub>CPM_USERCLK_MAX</sub>  | CPM user clock maximum frequency | Standard  | 250  | N/A       | N/A | N/A       | N/A | MHz   |
|   |                                  | Overdrive | N/A  | 250       | N/A | 250       | N/A | MHz   |

## Video Decoder Engines Performance

The *Versal Architecture and Product Data Sheet: Overview (DS950)* lists the Versal AI Core device devices that include the video decoder unit (VDU) and how many video decoder engines (VDE) are in each device.

Table 99: VDE Performance

| Symbol           | Description   | Performance as a Function of Speed Grade and Operating Voltage ( $V_{CC\_SOC}$ ) |           |    |           |    | Units |
|------------------|---|--|-----------|----|-----------|----|-------|
|                  |   | 0.88V (H)  | 0.80V (M) |    | 0.70V (L) |    |       |
|                  |   | -3   | -2        | -1 | -2        | -1 |       |
| F <sub>MAX</sub> | Video decoder engine maximum frequency (H.264/5 10-bit 4:2:2, UHD 3840 x 2160)      |  |           |    |           |    | MHz   |
|                  | Video decoder engine maximum frequency (H.264/5 10-bit 4:2:2, DCI 4k (4096 x 2160)) |  |           |    |           |    | MHz   |

# Revision History

The following table shows the revision history for this document.

| Section  | Revision Summary   |
|--|--|
| <b>5/03/2022 Version 1.4</b>   |  |
| General updates  | Added XQ devices: XQVC1352, XQVC1702, XQVC1902, and XQRVC1902.   |
| <a href="#">Absolute Maximum Ratings</a>   | Updated the GT Transceivers $V_{IN}$ specification by adding unpowered and powered values for $V_{IN,DC}$ and $V_{IN,AC}$ . Removed duplicate $I_{DCIN-FLOAT}$ rating and note. Removed note 9.  |
| <a href="#">Available Speed Grades and Operating Voltages</a>  | Added the -1MSM speed grade for XQ devices (-1MM-m-S device code).   |
| <a href="#">Power Supply Requirements</a>  | Updated description.   |
| <a href="#">AC Switching Characteristics</a>   | Updated the <a href="#">Table 20: Speed Specification Version by Device</a> including production release of some of the devices/speed grade/operating voltages using the Vivado Design Suite 2022.1 v2.06 in <a href="#">Speed Grade Designations</a> and <a href="#">Production Silicon and Software Status</a> . |
| <a href="#">Clocks and Reset</a>   | Added note 2 to <a href="#">Table 26: Reference Clock Requirements</a> .   |
| <a href="#">PMC Octal-SPI Controller Interface</a>   | Added values to <a href="#">Table 42: Octal-SPI Interface</a> and updated note 1.  |
| <a href="#">PMC SD/SDIO Controller Interface</a>   | Added values to <a href="#">Table 46: SD/SDIO Interface</a> and updated note 1.  |
| <a href="#">PMC eMMC Controller Interface</a>  | Added values and notes 3 and 4 to <a href="#">Table 47: eMMC Controller Interface</a> and updated note 1.  |
| <a href="#">Memory Interface Controller</a>  | Added note 7 to <a href="#">Table 73: Maximum Physical Interface (PHY) Rate for Integrated Memory Interface Controller</a>   |
| <a href="#">GTY and GTYP Transceiver Performance</a>   | Added the -2H column. Some XC devices offer a -2HSI device and others offer a -3SE device. See the <i>Speed and Temperature Grade</i> table in the <i>Versal Architecture and Product Data Sheet: Overview (DS950)</i> .   |
| <a href="#">Programmable Logic Integrated Block for PCIe</a>   | Updated <a href="#">Table 92: Maximum Performance for Programmable Logic Integrated Block for PCIe Rev. 5.0</a> .  |
| <b>1/06/2022 Version 1.3</b>   |  |
| <a href="#">Summary</a> and General Updates  | Added the XCVC2602 and XCVC2802 devices.<br>Added the PCIe 5.0 and CPM5 specifications where applicable. They are available in the XCVC2602 and XCVC2802 devices.  |
| <a href="#">Absolute Maximum Ratings</a>   | Revised the maximum $V_{CCO}$ from 3.465V to 3.63V for certain HDIO and PSIO banks.<br>Added $V_{REF}$ specifications.<br>Removed $T_{SOL}$ guidelines. See <i>Versal ACAP Packaging and Pinouts Architecture Manual (AM013)</i> for appropriate specifications by package type.                                   |
| <a href="#">DC Characteristics Over Recommended Operating Conditions</a>                             | Updated the HDIO, PSIO, and XPIO <a href="#">maximum capacitance</a> and added Note 2.   |
| <a href="#">Available Speed Grades and Operating Voltages</a>  | Added the <i>Vivado Design Tools Device Code</i> column.   |
| <a href="#">AC Switching Characteristics</a>   | Updated to Vivado Design Suite 2021.2.1 v2.05 for the XCVC1802 and XCVC1902.<br>Added the <i>Evaluation Product Specification</i> description.   |
| <a href="#">Speed Grade Designations</a>   | Revised the available speed specifications by device.  |
| <a href="#">Production Silicon and Software Status</a>   | Revised the production released version of the XCVC1802 and XCVC1902 to Vivado Design Suite 2021.2.1 v2.05 and added Note 3  |
| <a href="#">PS USB Controller Interface</a>  | Revised $T_{ULPICKD}$ input hold time from 0 to 0.5 ns (500 ps).   |
| <a href="#">Table 60: Maximum Physical Interface (PHY) Rate for Soft Memory Interface Controller</a> | Added Note 4 limiting the RDRAM3 maximum performance for -2L and -1L speed grades.   |

| Section   | Revision Summary  |
|---|---|
| Device Pin-to-Pin Output Parameter Guidelines                                   | Revised the XCVC1802 and XCVC1902 speed specification values for Vivado Design Suite 2021.2.1 v2.05.  |
| Device Pin-to-Pin Input Parameter Guidelines                                    | Revised the XCVC1802 and XCVC1902 speed specification values for Vivado Design Suite 2021.2.1 v2.05.  |
| GTY and GTYP Transceiver Configuration Interface Port Switching Characteristics | Reduced the maximum GTYAPB3CLK frequency in <a href="#">Table 81: GTY and GTYP Transceiver Configuration Interface Port (APB3) Switching Characteristics</a> .  |
| GTY and GTYP Transceiver User Clock Switching Characteristics                   | Updated values in <a href="#">Table 86: GTYP Transceiver User Clock Switching Characteristics</a> .   |
| <b>7/01/2021 Version 1.2</b>  |   |
| Recommended Operating Conditions  | Added Note 9.   |
| AC Switching Characteristics  | Updated the speed file versions to Vivado Design Suite 2021.1 v2.01.  |
| Speed Grade Designations  | Moved the XCVC1802 and XCVC1902 to production for the following speed grades: <ul style="list-style-type: none"> <li>-2MSE, -2MLE, -2MSI, -2MLI (<math>V_{CCINT} = 0.80V</math>)</li> <li>-1MSE, -1MLE, -1MSI, -1MLI (<math>V_{CCINT} = 0.80V</math>)</li> </ul>  |
| Production Silicon and Software Status  | Updated the software status for the following speed grades to Vivado Design Suite 2021.1 v2.01. <ul style="list-style-type: none"> <li>-2MSE, -2MLE, -2MSI, -2MLI (<math>V_{CCINT} = 0.80V</math>)</li> <li>-1MSE, -1MLE, -1MSI, -1MLI (<math>V_{CCINT} = 0.80V</math>)</li> </ul>  |
| Processing System Performance Characteristics                                   | In <a href="#">Table 25: PS-PL Interface Performance</a> , updated $F_{RPUMAX}$ for the -3/-2 (0.88V (H)) speed grades.<br>Added $F_{PLATB\_CLK}$ to <a href="#">Table 25: PS-PL Interface Performance</a> .  |
| PS CAN FD Controller Interface  | Added Note 2.   |
| PS Trace Interface  | Updated Note 2 and added Note 4.  |
| Programmable Logic Performance Characteristics                                  | Updated <a href="#">Table 59: MIPI D-PHY Performance</a> for -2/-1 (0.80V (M) and 0.70V (L)) speed grades.<br>In <a href="#">Table 60: Maximum Physical Interface (PHY) Rate for Soft Memory Interface Controller</a> : <ul style="list-style-type: none"> <li>Removed Note 4: Maximum performance for interfaces using more than one bank.</li> <li>Added Note 1.</li> <li>Revised the -1 performance values for DRAM type DDR4 single rank component.</li> <li>Revised the -1M performance value for DRAM type 1 rank RDIMM, DIMM.</li> </ul> |
| Device Pin-to-Pin Output Parameter Guidelines                                   | Updated the $T_{ICKOFMMCM}$ values to the speed specifications in Vivado Design Suite 2021.1.   |
| Device Pin-to-Pin Input Parameter Guidelines                                    | Updated the setup and hold values to the speed specifications in Vivado Design Suite 2021.1.  |
| Memory Interface Controller   | Added Note 1 to <a href="#">Table 73: Maximum Physical Interface (PHY) Rate for Integrated Memory Interface Controller</a> , and updated Note 5.  |
| GTY and GTYP Transceiver User Clock Switching Characteristics                   | Updated values in <a href="#">Table 86: GTYP Transceiver User Clock Switching Characteristics</a> .   |
| <b>4/14/2021 Version 1.1</b>  |   |
| General   | Added GTYP transceiver specifications.  |
| Summary   | Added $V_{CC\_PMC}$ overdrive support.  |
| <a href="#">Table 1: Absolute Maximum Ratings—Power, Voltages, and Current</a>  | Updated the notes.  |
| <a href="#">Table 3: Recommended Operating Conditions</a>                       | Revised maximum $V_{CCBATT}$ , added minimum CFU reference clock frequency to $F_{CFU\_REFCLK}$ , added overdrive conditions to $V_{CC\_PMC}$ , added Notes 2, 3, 4, 8, 12, and updated Note 15.  |
| <a href="#">Available Speed Grades and Operating Voltages</a>                   | Updated table with standard and overdrive modes. Added note 4.  |

| Section   | Revision Summary  |
|---|---|
| Table 5: DC Characteristics Over Recommended Operating Conditions   | Added table.  |
| V <sub>IN</sub> Maximum Allowed AC Voltage Overshoot and Undershoot   | Added note 3 to Table 7: V <sub>IN</sub> Maximum Allowed AC Voltage Overshoot and Undershoot for XPIO Banks.  |
| Table 11: DC Input Levels for Single-ended POD10, POD12, LVSTL06_12, and LVSTL_11 I/O Standards                                   | Updated V <sub>IL</sub> maximum and V <sub>IH</sub> minimum for LVSTL06_12 and LVSTL_11.  |
| Table 16: DC Output Levels for Single-ended and Differential POD10, POD12, LVSTL06_12, and LVSTL_11 I/O Standards                 | Removed LVSTL_11 (V <sub>OH</sub> = 33). Added Note 2.  |
| Table 17: Definitions for DC Output Levels for Single-ended and Differential POD10, POD12, LVSTL06_12, and LVSTL_11 I/O Standards | Removed LVSTL_11 (V <sub>OH</sub> = 33).  |
| LVDS DC Specifications (LVDS15)   | Added V <sub>ICM_AC</sub> and Note 5.   |
| AC Switching Characteristics  | Updated the speed file versions and the definitions for engineering sample, pre-production, and production product specification.   |
| Speed Grade Designations  | Moved the XCVC1802 and XCVC1902 to production for the following speed grades: <ul style="list-style-type: none"> <li>-2LSE, -2LLE (V<sub>CCINT</sub> = 0.70V)</li> <li>-1LSE, -1LLE, -1LSI, -1LLI (V<sub>CCINT</sub> = 0.70V)</li> </ul>  |
| Production Silicon and Software Status  | The XCVC1802 and XCVC1902 is production released using Vivado Design Suite 2020.3 v2.00.  |
| Device Identification   | Updated the IDCODE for the XCVC1802 and XCVC1902, and added notes to explain the table fields.  |
| Processing System Performance Characteristics   | Updated Table 24: Processor Performance.<br>Updated descriptions, added F <sub>PSFCIDMA_CLK</sub> and Note 3 to Table 25: PS-PL Interface Performance.  |
| Clocks and Reset  | Added T <sub>MODEPOR</sub> , and T <sub>PORMODE</sub> to Table 28: Power-on Reset Assertion Timing Requirements.<br>Added F <sub>FPD_LSBUS_CLK</sub> and Note 1 to Table 29: PS FPD Clocks Switching Characteristics.<br>Added F <sub>RPLL_TO_XPD_CLK</sub> , F <sub>LPD_LSBUS_CLK</sub> , F <sub>TS_REFCLK</sub> , F <sub>PSM_REFCLK</sub> , F <sub>DBG_LPD_CLK</sub> , F <sub>USB_REFCLK</sub> , F <sub>DBG_TS_CLK</sub> , and Notes 1, 3, 4, and 6 to Table 30: PS LPD Clocks Switching Characteristics.<br>In Table 31: PMC IRO Clock Switching Characteristics, updated the IRO tolerance range.<br>In Table 32: PMC Clocks Switching Characteristics, added F <sub>EFUSE_REFCLK</sub> , F <sub>SMON_REFCLK</sub> , F <sub>NPI_REFCLK</sub> , F <sub>PPLL_TO_XPD_CLK</sub> , F <sub>NPLL_TO_XPD_CLK</sub> , F <sub>LSBUS_REFCLK</sub> , F <sub>AXI_TO_REFCLK</sub> , F <sub>USB_SREFCLK</sub> , and F <sub>HSMO_REFCLK</sub> . Revised the -3 specifications for F <sub>PLO_REFCLK</sub> , F <sub>P1_REFCLK</sub> , F <sub>P2_REFCLK</sub> , and F <sub>P3_REFCLK</sub> . Updated the Notes 1 and 5.<br>Added Note 1 to Table 33: PMC PLL Switching Characteristics. |
| PMC JTAG and SelectMAP  | Extensive updates to Table 39: JTAG/Boundary-Scan Port Switching Characteristics and Table 40: SelectMap Interface Switching Characteristics.   |
| PMC Quad-SPI Controller Interface   | Extensive changes to the table. Updated Note 1 and added Note 2 and 5.  |
| PMC Octal-SPI Controller Interface  | Removed load condition column. Updated Note 1.  |
| PS USB Controller Interface   | Added T <sub>ULPIDCK</sub> , T <sub>ULPICKD</sub> , and T <sub>ULPICKO</sub> .  |
| PS Gigabit Ethernet MAC Controller Interface  | Added F <sub>GEMTSUREFCLK</sub> .   |
| PS General Purpose I/O Interface  | Removed load condition column.  |
| PS Trace Interface  | Updated F <sub>TCECLK</sub> and Note 3.   |
| PS Triple-timer Counter Interface   | Extensive additions and edits to both the table and notes.  |
| Network on Chip Switching Characteristics   | Updated the performance values in the table.  |

| Section   | Revision Summary  |
|---|---|
| Programmable Logic Performance Characteristics                              | Updated values in <a href="#">Table 57: I/O Logic Performance</a> . Updated values in <a href="#">Table 58: XPHY I/O Performance</a> and added Notes 3 and 4. Updated the values in <a href="#">Table 59: MIPI D-PHY Performance</a> . Updated the values in <a href="#">Table 60: Maximum Physical Interface (PHY) Rate for Soft Memory Interface Controller</a> and added Note 4: Maximum performance for interfaces using more than one bank. Removed the <i>LVDS Native-Mode 100BASE-X Support</i> table. |
| Block RAM Switching Characteristics   | Updated $T_{RCKO\_DO}$ and $T_{RCKO\_DO\_REG}$ .  |
| Input/Output Delay Switching Characteristics                                | Added $T_{IOL\_DELAY\_RESOLUTION}$ .  |
| MMCM Switching Characteristics  | Extensive updates to table and notes including removal of $T_{DESKEWMISMATCH\_MMCM}$ .  |
| DPLL Switching Characteristics  | Extensive updates to table and notes including removal of $T_{DESKEWMISMATCH\_DPLL}$ .  |
| XPLL Switching Characteristics  | Extensive updates to table and notes including removal of $T_{DESKEWMISMATCH\_XPLL}$ .  |
| Device Pin-to-Pin Output Parameter Guidelines                               | Updated the XCVC1802 and XCVC1902 parameters in Vivado Design Suite 2020.3 v2.00.   |
| Device Pin-to-Pin Input Parameter Guidelines                                | Updated the XCVC1802 and XCVC1902 parameters in Vivado Design Suite 2020.3 v2.00.   |
| Package Parameter Guidelines  | Updated the XCVC1802 and XCVC1902 package skew in Vivado Design Suite 2020.3 v2.00.   |
| Memory Interface Controller   | Added Notes 2 and 3. Updated 6.   |
| GTY and GTYP Transceiver DC Input and Output Levels                         | Revised $V_{IN}$ in <a href="#">Table 76: GTY and GTYP Transceiver DC Specifications</a> . Updated the specifications in <a href="#">Table 78: GTY and GTYP Transceiver Clock Output Level Specification</a> .  |
| GTY and GTYP Transceiver Performance  | Updated the $F_{GTYLRANGE}$ values.   |
| GTY and GTYP Transceiver PLL/Lock Time Adaptation                           | Added conditions to $T_{LOCK}$ .  |
| GTY and GTYP Transceiver Transmitter and Receiver Switching Characteristics | Removed legacy content and updated the applicable symbols, conditions, and values in both the <a href="#">Transmitter</a> and <a href="#">Receiver</a> tables.  |
| GTY and GTYP Transceiver Electrical Compliance                              | Added the table.  |
| PMC Quad-SPI Controller Interface   | Added additional load information to the table.   |
| Integrated Block for MRMAC  | Changed title and added specifications.   |
| Programmable Logic Integrated Block for PCIe                                | Added <a href="#">Table 91: Maximum Performance for Programmable Logic Integrated Block for PCIe Rev. 4.0</a> .   |
| <b>7/16/2020 Version 1.0</b>  |   |
| Initial release.  | N/A   |

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